SIEMENS



SITRANS LR250 (mA/HART)

Operating Instructions

Edition

08/2014

Safety Guidelines

Warning notices must be observed to ensure personal safety as well as that of others, and to protect the product and the connected equipment. These warning notices are accompanied by a clarification of the level of caution to be observed.

Qualified Personnel

This device/system may only be set up and operated in conjunction with this manual. Qualified personnel are only authorized to install and operate this equipment in accordance with established safety practices and standards.

Unit Repair and Excluded Liability:

- The user is responsible for all changes and repairs made to the device by the user or the user's agent.
- All new components are to be provided by Siemens Milltronics Process Instruments.
- Restrict repair to faulty components only.
- Do not reuse faulty components.

Warning: Cardboard shipping package provides limited humidity and moisture protection. This product can only function properly and safely if it is correctly transported, stored, installed, set up, operated, and maintained.

This product is intended for use in industrial areas. Operation of this equipment in a residential area may cause interference to several frequency based communications.

Note: Always use product in accordance with specifications.

Copyright Siemens AG 2013. All Rights Reserved	Disclaimer of Liability
This document is available in bound version and in electronic version. We encourage users to purchase authorized bound manuals, or to view electronic versions as designed and authored by Siemens Milltronics Process Instruments. Siemens Milltronics Process Instruments will not be responsible for the contents of partial or whole reproductions of either bound or electronic versions.	While we have verified the contents of this manual for agreement with the instrumentation described, variations remain possible. Thus we cannot guarantee full agreement. The contents of this manual are regularly reviewed and corrections are included in subsequent editions. We welcome all suggestions for improvement.
	Technical data subject to change.

MILLTRONICS® is a registered trademark of Siemens Milltronics Process Instruments.

Contact SMPI Technical Publications at the following address:

Technical Publications
Siemens AG
Siemens Milltronics Process Instruments
1954 Technology Drive, P.O. Box 4225
Peterborough, Ontario, Canada, K9J 7B1
Email: techpubs.smpi@siemens.com

European Authorized Representative

Siemens AG Industry Sector 76181 Karlsruhe Deutschland

- For a selection of Siemens Milltronics level measurement manuals, go to:
 www.siemens.com/processautomation. Under Process Instrumentation, select Level Measurement and then go to the manual archive listed under the product family.
- For a selection of Siemens Milltronics weighing manuals, go to:
 www.siemens.com/processautomation. Under Weighing Technology, select Continuous Weighing Systems and then go to the manual
 archive listed under the product family.

	Introduction	1
SIEMENS	Safety information	2
	Description	3
SITRANS	Installing/mounting	4
Radar Transmitters	Connecting	5
SITRANS LR250 (mA/HART)	Commissioning	6
Operating Instructions	Remote operation	7
	Parameter reference	8
	Service and maintenance	9
	Diagnosing and troubleshooting	10
	Technical data	11
	Dimension drawings	12
	Appendix A: Technical reference	Α
	Appendix B: HART communications	В
	Appendix C: Certificates and support	С
	List of abbreviations	13
	LCD menu structure	14

Legal information

Warning notice system

This manual contains notices you have to observe in order to ensure your personal safety, as well as to prevent damage to property. The notices referring to your personal safety are highlighted in the manual by a safety alert symbol, notices referring only to property damage have no safety alert symbol. These notices shown below are graded according to the degree of danger.

A DANGER

indicates that death or severe personal injury will result if proper precautions are not taken.

AWARNING

indicates that death or severe personal injury may result if proper precautions are not taken.

ACAUTION

indicates that minor personal injury can result if proper precautions are not taken.

NOTICE

indicates that property damage can result if proper precautions are not taken.

If more than one degree of danger is present, the warning notice representing the highest degree of danger will be used. A notice warning of injury to persons with a safety alert symbol may also include a warning relating to property damage.

Qualified Personnel

The product/system described in this documentation may be operated only by **personnel qualified** for the specific task in accordance with the relevant documentation, in particular its warning notices and safety instructions. Qualified personnel are those who, based on their training and experience, are capable of identifying risks and avoiding potential hazards when working with these products/systems.

Proper use of Siemens products

Note the following:

▲ WARNING

Siemens products may only be used for the applications described in the catalog and in the relevant technical documentation. If products and components from other manufacturers are used, these must be recommended or approved by Siemens. Proper transport, storage, installation, assembly, commissioning, operation and maintenance are required to ensure that the products operate safely and without any problems. The permissible ambient conditions must be complied with. The information in the relevant documentation must be observed.

Trademarks

All names identified by ® are registered trademarks of Siemens AG. The remaining trademarks in this publication may be trademarks whose use by third parties for their own purposes could violate the rights of the owner.

Disclaimer of Liability

We have reviewed the contents of this publication to ensure consistency with the hardware and software described. Since variance cannot be precluded entirely, we cannot guarantee full consistency. However, the information in this publication is reviewed regularly and any necessary corrections are included in subsequent editions.

Table of contents

1	Introduc	ction	9
	1.1	LR250 mA/HART manual usage	9
	1.2	Purpose of this documentation	9
	1.3	Document history	9
	1.4	Firmware revision history	10
	1.5	Designated use	11
	1.6	Checking the consignment	11
	1.7	Transportation and storage	12
	1.8	Notes on warranty	12
2	Safety in	nformation	13
	2.1 2.1.1 2.1.2 2.1.3 2.1.4 2.1.5	Preconditions for safe use Safety marking symbols Laws and directives FCC Conformity Conformity with European directives CE Electromagnetic Compatibility (EMC) Conformity	13 13 14 15
	2.2	Improper device modifications	16
	2.3	Requirements for special applications	17
	2.4	Use in hazardous areas	17
3	Descrip	tion	19
	3.1	SITRANS LR250 overview	19
	3.2	Programming	20
	3.3	Applications	20
	3.4	Approvals and certificates	20
4	Installing	g/mounting	21
	4.1 4.1.1 4.1.1.1	Basic safety information Pressure applications Pressure Equipment Directive, PED, 97/23/EC	22
	4.2	Installation location requirements	24
	4.3 4.3.1	Proper mounting Nozzle design	

	4.3.2	Nozzle location	
	4.3.3	Orientation in a vessel with obstructions	
	4.3.4 4.3.5	Mounting on a Stillpipe or Bypass Pipe Device orientation	
	4.4 4.4.1	Installation instructions	
	4.4.1 4.4.2	Flanged versions	
	4.4.3	Hygienic versions	
	4.5	Disassembly	
5	Connect	ting	39
	5.1	Basic safety information	39
	5.2	Connecting SITRANS LR250	40
	5.3	Wiring setups for hazardous area installations	43
	5.3.1	Intrinsically safe wiring	43
	5.3.2	Non-sparking wiring	
	5.3.3	Non-incendive wiring (US/Canada only)	
	5.3.4	Flameproof wiring	
	5.3.5 5.3.6	Increased safety wiring Explosion-proof wiring (US/Canada only)	
	5.4	Instructions specific to hazardous area installations	
	5.4.1	(Reference European ATEX Directive 94/9/EC, Annex II, 1/0/6)	
6	Commis	ssioning	51
	6.1	Basic safety information	51
	6.2	Operating via the handheld programmer	51
	6.2.1	Power up	
	6.2.2	Handheld programmer functions	
	6.2.2.1	The LCD display	
	6.2.2.2 6.2.3	Handheld programmer (Part No. 7ML1930-1BK)	
	6.2.3.1	Programming Quick Start Wizard via the handheld programmer	
	6.2.3.1	Auto False Echo Suppression	65
	6.2.3.3	Requesting an Echo Profile	
	6.3	Application examples	
	6.3.1	Liquid resin in storage vessel, level measurement	
	6.3.2	Horizontal vessel with volume measurement	
	6.3.3	Application with stillpipe	
7	Remote	operation	75
	7.1	Operating via SIMATIC PDM	
	7.1.1	Functions in SIMATIC PDM	
	7.1.1.1	PDM function overview	
	7.1.1.2	Features of SIMATIC PDM Rev. 6.0, SP4 or higher	76

7.1.1.3	Features of SIMATIC PDM Rev. 5.2, SP1	
7.1.1.4	SIMATIC PDM Version	
7.1.2	Initial setup	
7.1.2.1	Deactivating buffers	
7.1.3	Updating the Electronic Device Description (EDD)	
7.1.3.1	Configuring a new device	
7.1.4	Quick Start Wizard via SIMATIC PDM	
7.1.5	Changing parameter settings using SIMATIC PDM	
7.1.6	Parameters accessed via pull-down menus	
7.1.6.1	Echo profile utilities	
7.1.6.2	Echo profile	86
7.1.6.3	View saved echo profiles	
7.1.6.4	TVT Shaper	
7.1.6.5	Auto false echo suppression	
7.1.6.6	Echo setup	
7.1.6.7	Maintenance	
7.1.6.8	Select analog output	
7.1.6.9	Self test	
	Loop test	
	Configuration flag reset	
	Master reset	
	Wear	
	HART Communication	
	Process variables	
	Trend	
	Device status	
	Update	
7.1.6.19	Security	99
7.2	Operating via AMS Device Manager	100
7.2.1	Functions in AMS Device Manager	100
7.2.1.1	AMS function overview	100
7.2.1.2	Features of AMS Device Manager	101
7.2.1.3	Electronic Device Description (EDD)	101
7.2.1.4	Configuring a new device	101
7.2.1.5	Startup	102
7.2.1.6	Pull-down menu access	103
7.2.1.7	Device configuration	104
7.2.1.8	Quick Start Wizard via AMS Device Manager	104
7.2.2	Maintenance and diagnostics	112
7.2.3	Communication	113
7.2.4	Security	113
7.2.5	Device Diagnostics	114
7.2.5.1	Process variables	115
7.2.5.2	Password protection	115
7.2.5.3	User Manager utility	116
7.2.6	AMS menu structure	117
7 2	Operating via EDT (Field Device Tool)	121

	7.3.1	Device Type Manager (DTM)	
	7.3.2 7.3.3	SITRANS DTMThe device EDD	
	7.3.3 7.3.4	Configuring a new device via FDT	
8		eter reference	
	8.1	Alphabetical parameter list	172
9	Service	e and maintenance	177
	9.1	Basic safety information	177
	9.2	Cleaning	177
	9.3 9.3.1 9.3.2	Maintenance and repair work Unit repair and excluded liabilityPart replacement	178
	9.4	Disposal	181
10	Diagno	sing and troubleshooting	183
	10.1	Communication troubleshooting	183
	10.2	Device status icons	184
	10.3	General fault codes	186
	10.4	Operation troubleshooting	190
11	Technical data		
	11.1	Power	193
	11.2	Performance	193
	11.3	Interface	195
	11.4	Mechanical	196
	11.5	Environmental	199
	11.6	Process	199
	11.7	Approvals	200
	11.8	Programmer (infrared keypad)	202
12	Dimens	sion drawings	203
	12.1	Threaded horn antenna	203
	12.2	Threaded horn antenna with extension	206
	12.3	Flanged horn antenna	208
	12.4	Flanged horn antenna with extension	210
	12.5	Flanged encapsulated antenna (2"/DN50/50A sizes only)	212
	12 6	Flanged encapsulated antenna (3"/DN80/80A sizes and larger)	214

12.7	7 Hygienic encapsulated antenna (2" ISO 2852 sanitary clamp)	216
12.8	8 Hygienic encapsulated antenna (3" ISO 2852 sanitary clamp)	217
12.9	9 Hygienic encapsulated antenna (4" ISO 2852 sanitary clamp)	218
12.1	Hygienic encapsulated antenna (DN50 nozzle/slotted nut to DIN 11851)	219
12.1	Hygienic encapsulated antenna (DN80 nozzle/slotted nut to DIN 11851)	220
12.1	Hygienic encapsulated antenna (DN100 nozzle/slotted nut to DIN 11851)	221
12.1	Hygienic encapsulated antenna (DN50 aseptic slotted nut to DIN 11864-1)	222
12.1		
12.1		
12.1		
12.1		
12.1		
12.1		
12.2		
12.2		
12.2	3 31 7	
12.2	33 7	
12.2		
12.2	5	
12.2	Raised-Face flange per EN 1092-1 for flanged horn antenna	235
12.2	Raised-Face flange per EN 1092-1 for flanged encapsulated antenna	237
12.2	28 Flat-Face flange	240
12.2	Aseptic/hygienic flange DN50, DN80, DN100 for DIN 11864-2	243
12.3	Process connection tag (pressure rated versions)	246
App	pendix A: Technical reference	247
A.1	Principles of operation	247
A.2	Echo Processing	248
A.2.	5	
A.2.		
A.2.	5	
A.2.		
A.2.		
A.2.	!!	
A.2. A 2	•	255 255
A /	O INCODICHICH RESOUNCE	/22

Α

	A.2.9	Damping	256
	A.3 A.3.1 A.3.2 A.3.3 A.3.4	Analog Output Sensor Mode Current Output Function Loss of Echo (LOE) Fail-safe Mode	
	A.4	Maximum Process Temperature Chart	260
	A.5 A.5.1 A.5.2 A.5.3 A.5.4 A.5.5	Process Pressure/Temperature derating curves Pressure Equipment Directive, PED, 97/23/EC Horn antenna Flanged horn antenna Flanged encapsulated antenna PVDF antenna	
	A.5.6	Hygienic encapsulated antenna	
	A.6 A.6.1 A.6.2 A.6.3	Loop power	274 275
	A.7	Startup behavior	276
В	Append	dix B: HART communications	277
	B.1	SIMATIC PDM	277
	B.2	HART Electronic Device Description (EDD)	277
	B.3	HART Handheld 375/475	277
	B.4	HART Communicator 375 menu structure	278
	B.5 B.5.1 B.5.2	HART version Burst Mode HART Multidrop Mode	280
С	Append	dix C: Certificates and support	281
	C.1	Certificates	281
	C.2	Technical support	281
13	List of a	abbreviations	283
14	LCD m	enu structure	285
	14.1	LCD menu structure	285
	Glossa	ry	289
	Indev		205

Introduction

1.1 LR250 mA/HART manual usage

Note

This manual applies to the SITRANS LR250 mA/HART version only. HART® is a registered trademark of the HART Communication Foundation.

Follow these operating instructions for quick, trouble-free installation, and maximum accuracy and reliability of your device.

We always welcome suggestions and comments about manual content, design, and accessibility. Please direct your comments to:

Technical publications (mailto:techpubs.smpi@siemens.com)

1.2 Purpose of this documentation

These instructions contain all information required to commission and use the device. It is your responsibility to read the instructions carefully prior to installation and commissioning. In order to use the device correctly, first review its principle of operation.

The instructions are aimed at persons mechanically installing the device, connecting it electronically, configuring the parameters and commissioning it, as well as service and maintenance engineers.

1.3 Document history

The following table notes major changes in the documentation compared to the previous edition.

Edition	Remark	
January 2014	Flanged encapsulated antenna version added.	
August 2014	Hygienic encapsulated antenna version added.	

1.4 Firmware revision history

1.4 Firmware revision history

This history establishes the correlation between the current documentation and the valid firmware of the device.

The documentation of this edition is applicable for the following firmware:

Firmware rev.	PDM EDD rev.	Date	Changes
1.00.03	1.00.03	25 Feb 2007	Initial release
1.01.00	1.01.00	27 Jul 2007	 EDD a)/SIMATIC PDM: View > Display > Distance b) correctly reported EDD/SIMATIC PDM: Improved rendering of the echo profile and TVT
1.01.01	1.01.01	10 Jun 2008	Maintenance release of firmware and EDD ^{a)}
1.01.01	1.01.03	17 Jun 2008	The internal EDD revision has been incremented
1.02.01	1.02.01	2 Apr 2009	 AMS EDD Rev. 1.02.01 Support NAMUR NE 43 Harmonization of menu structures and parameter names across products Display indicates progress towards first measurement
1.02.03	1.02.01	16 June 2010	Display contrast improvementAntenna type parameter cannot be modified
1.03.02 (requires HW 2.0.0)	1.02.01	16 June 2010	Low current HW 2.0.0 supported
1.03.03 (requires HW 2.0.0)	1.02.01	19 May 2011	Threaded PVDF antenna supported
1.03.04	1.02.03	31 Oct 2012	 LUI updated version (new startup, progress bars, quick start updated to latest version, echo profile pan/zoom on display) antenna parameter removed, default near range set at factory

a) Electronic Device Description

b) See **Sensor Mode (2.2.2.)** for an illustration of **Distance**.

1.5 Designated use

Use the device to measure process media in accordance with the information in the operating instructions.

Note

Use in a domestic environment

This is a Class A Group 1 equipment intended for use in industrial areas.

In a domestic environment this device may cause radio interference.

1.6 Checking the consignment

- 1. Check the packaging and the device for visible damage caused by inappropriate handling during shipping.
- 2. Report any claims for damages immediately to the shipping company.
- 3. Retain damaged parts for clarification.
- 4. Check the scope of delivery by comparing your order to the shipping documents for correctness and completeness.



Using a damaged or incomplete device

Danger of explosion in hazardous areas.

Do not use damaged or incomplete devices.

1.7 Transportation and storage

1.7 Transportation and storage

To guarantee sufficient protection during transport and storage, observe the following:

- Keep the original packaging for subsequent transportation.
- Devices/replacement parts should be returned in their original packaging.
- If the original packaging is no longer available, ensure that all shipments are properly packaged to provide sufficient protection during transport. Siemens cannot assume liability for any costs associated with transportation damages.



Insufficient protection during storage

The packaging only provides limited protection against moisture and infiltration.

Provide additional packaging as necessary.

1.8 Notes on warranty

The contents of this manual shall not become part of or modify any prior or existing agreement, commitment or legal relationship. The sales contract contains all obligations on the part of Siemens as well as the complete and solely applicable warranty conditions. Any statements regarding device versions described in the manual do not create new warranties or modify the existing warranty.

The content reflects the technical status at the time of publishing. Siemens reserves the right to make technical changes in the course of further development.

Safety information 2

2.1 Preconditions for safe use

This device left the factory in good working condition. In order to maintain this status and to ensure safe operation of the device, observe these instructions and all the specifications relevant to safety.

Observe the information and symbols on the device. Do not remove any information or symbols from the device. Always keep the information and symbols in a completely legible state.

2.1.1 Safety marking symbols

In manual	On product	Description
\triangle		WARNING: refer to accompanying documents (manual) for details.
	(Label on product: yellow background.)	

2.1.2 Laws and directives

Observe the test certification, provisions and laws applicable in your country during connection, assembly and operation.

2.1 Preconditions for safe use

2.1.3 FCC Conformity

US Installations only: Federal Communications Commission (FCC) rules



WARNING

Improper device modifications

Danger to personnel, system and environment can result from improper modifications to the device.

• Changes or modifications not expressly approved by Siemens could void the user's authority to operate the equipment.

Note

- This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment.
- This equipment generates, uses, and can radiate radio frequency energy and, if not
 installed and used in accordance with the operating instructions, may cause harmful
 interference to radio communications. Operation of this equipment in a residential area is
 likely to cause harmful interference to radio communications, in which case the user will
 be required to correct the interference at his own expense.

2.1.4 Conformity with European directives

The CE marking on the device symbolizes the conformity with the following European directives:

Electromagnetic compatibility EMC 2004/108/EC Directive of the European Parliament and of the Council on the approximation of the laws of the Member States relating to electromagnetic compatibility and repealing Directive

89/336/EEC.

Low voltage directive LVD

2006/95/EC

Directive of the European Parliament and of the Council on the harmonisation of the laws of Member States relating to

electrical equipment designed for use within certain voltage

limits.

Atmosphère explosible

ATEX 94/9/EC Directive of the European Parliament and the Council on the approximation of the laws of the Member States concerning equipment and protective systems intended for use in

potentially explosive atmospheres.

Radio and Directive of the European Parliament and of the Council on telecommunications terminal radio equipment and telecommunications terminal equipment equipment R&TTE and the mutual recognition of their conformity.

1999/5/EC

The applicable directives can be found in the EC conformity declaration of the specific device.

CE Electromagnetic Compatibility (EMC) Conformity 2.1.5

This equipment has been tested and found to comply with the following EMC Standards:

EMC Standard	Title
CISPR 11:2009 + A1:2010/EN 55011:2009 + A1:2010, CLASS A	Limits and methods of measurements of radio disturbance characteristics of industrial, scientific, and medical (ISM) radio-frequency equipment.
EN 61326:2013 (IEC 61326:2012)	Electrical Equipment for Measurement, Control and Laboratory Use – Electromagnetic Compatibility.
EN61000-4-2:2009	Electromagnetic Compatibility (EMC) Part 4-2: Testing and measurement techniques – Electrostatic discharge immunity test.
EN61000-4-3:2006 + A1:2008 + A2:2010	Electromagnetic Compatibility (EMC) Part 4-3: Testing and measurement techniques – Radiated, radio-frequency, electromagnetic field immunity test 2006 + A1:2008 + A2:2010.
EN61000-4-4:2004 + A1:2010	Electromagnetic Compatibility (EMC) Part 4-4: Testing and measurement techniques – Electrical fast transient/burst immunity test.
EN61000-4-5:2006	Electromagnetic Compatibility (EMC) Part 4-5: Testing and measurement techniques – Surge immunity test.
EN61000-4-6:2010	Electromagnetic Compatibility (EMC) Part 4-6: Testing and measurement techniques – Immunity to conducted disturbances, induced by radio-frequency fields.
EN61000-4-8:2010	Electromagnetic Compatibility (EMC) Part 4-8: Testing and measurement techniques – Power frequency magnetic field immunity test.

2.2 Improper device modifications



A WARNING

Improper device modifications

Danger to personnel, system and environment can result from modifications to the device, particularly in hazardous areas.

Only carry out modifications that are described in the instructions for the device. Failure to observe this requirement cancels the manufacturer's warranty and the product approvals.

2.3 Requirements for special applications

Due to the large number of possible applications, each detail of the described device versions for each possible scenario during commissioning, operation, maintenance or operation in systems cannot be considered in the instructions. If you need additional information not covered by these instructions, contact your local Siemens office or company representative.

Note

Operation under special ambient conditions

We highly recommend that you contact your Siemens representative or our application department before you operate the device under special ambient conditions as can be encountered in nuclear power plants or when the device is used for research and development purposes.

2.4 Use in hazardous areas

Qualified personnel for hazardous area applications

Persons who install, connect, commission, operate, and service the device in a hazardous area must have the following specific qualifications:

- They are authorized, trained or instructed in operating and maintaining devices and systems
 according to the safety regulations for electrical circuits, high pressures, aggressive, and
 hazardous media.
- They are authorized, trained, or instructed in carrying out work on electrical circuits for hazardous systems.
- They are trained or instructed in maintenance and use of appropriate safety equipment according to the pertinent safety regulations.



Loss of safety of device with type of protection "Intrinsic safety Ex i"

If the device has already been operated in non-intrinsically safe circuits or the electrical specifications have not been observed, the safety of the device is no longer ensured for use in hazardous areas. There is a danger of explosion.

- Connect the device with type of protection "Intrinsic safety" solely to an intrinsically safe circuit.
- Observe the specifications for the electrical data on the certificate.

2.4 Use in hazardous areas

Description 3

3.1 SITRANS LR250 overview



Loss of protection

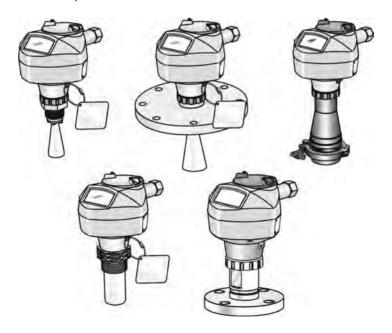
Danger to personnel, system and environment can result from improper use of the device.

• SITRANS LR250 is to be used only in the manner outlined in this manual, otherwise protection provided by the device may be impaired.

SITRANS LR250 is a 2-wire 25 GHz pulse radar level transmitter for continuous monitoring of liquids and slurries in storage vessels including high pressure and high temperature, to a range of 20 meters (66 feet). It is ideal for small vessels, material such as chemicals, food, beverages, solvents (including those of corrosive or aggressive nature), and low dielectric media.

The device consists of an electronic circuit coupled to an antenna and either a threaded or flange type process connection.

This device supports HART communication protocol. Signals are processed using Process Intelligence which has been field-proven in over 1,000,000 applications worldwide (ultrasonic and radar).



3.2 Programming

3.2 Programming

This device is very easy to install and configure via a graphical local user interface (LUI). You can modify the built in parameters either locally via the Siemens infrared handheld programmer, or from a remote location using one of the following options:

- SIMATIC PDM
- AMS Device Manager
- FDT/DTM platform (such as PACTware[™] or FieldCare)
- HART Handheld 375/475

3.3 Applications

- liquids and slurries
- bulk storage vessels
- simple process vessels
- corrosive and aggressive
- hygienic/sanitary

3.4 Approvals and certificates

Note

For further details see Approvals (Page 200).

SITRANS LR250 is available with approvals for General purpose, sanitary or hygienic and for hazardous areas. In all cases, check the nameplate on your device, and confirm the approval rating.

Process Connections

A wide range of process connections and antenna options are available to suit virtually any vessel configuration.

Installing/mounting 4

4.1 Basic safety information

Note

Material compatibility

Siemens can provide you with support concerning selection of sensor components wetted by process media. However, you are responsible for the selection of components. Siemens accepts no liability for faults or failures resulting from incompatible materials.



Unsuitable connecting parts

Danger of injury or poisoning.

In case of improper mounting hot, toxic and corrosive process media could be released at the connections.

• Ensure that connecting parts (such as flange gaskets and bolts) are suitable for connection and process media.



Exceeded maximum ambient or process media temperature

Danger of explosion in hazardous areas.

Device damage.

 Make sure that the maximum permissible ambient and process media temperatures of the device are not exceeded.



Open cable inlet or incorrect cable gland

Danger of explosion in hazardous areas.

• Close the cable inlets for the electrical connections. Only use cable glands or plugs which are approved for the relevant type of protection.

4.1 Basic safety information



Incorrect conduit system

Danger of explosion in hazardous areas as result of open cable inlet or incorrect conduit system.

• In the case of a conduit system, mount a spark barrier at a defined distance from the device input. Observe national regulations and the requirements stated in the relevant approvals.

4.1.1 Pressure applications



Pressure applications

Danger to personnel, system and environment will result from improper disassembly.

 Never attempt to loosen, remove, or disassemble process connection while vessel contents are under pressure.



Pressure applications

Danger to personnel, system and environment can result from improper installation.

• Improper installation may result in loss of process pressure.



Exceeded maximum permissible operating pressure

Danger of injury or poisoning.

The maximum permissible operating pressure depends on the device version. The device can be damaged if the operating pressure is exceeded. Hot, toxic and corrosive process media could be released.

 Make sure that the device is suitable for the maximum permissible operating pressure of your system.

Note

- The process connection tag shall remain with the process pressure boundary assembly. (The process pressure boundary assembly comprises the components that act as a barrier against pressure loss from the process vessel: that is, the combination of process connection body and emitter, but normally excluding the electrical enclosure). In the event the device package is replaced, the process connection tag shall be transferred to the replacement unit.
- SITRANS LR250 units are hydrostatically tested, meeting or exceeding the requirement of the ASME Boiler and Pressure Vessel Code and the European Pressure Equipment Directive.

Note

- The serial numbers stamped in each process connection body, (flange, threaded, or sanitary), provide a unique identification number indicating date of manufacture.
 Example: MMDDYY – XXX (where MM = month, DD = day, YY = year, and XXX= sequential unit produced)
- Further markings (space permitting) indicate flange configuration, size, pressure class, material, and material heat code.

4.1.1.1 Pressure Equipment Directive, PED, 97/23/EC

Siemens Level Transmitters with flanged, threaded, or sanitary clamp type process mounts have no pressure-bearing housing of their own and, therefore, do not come under the Pressure Equipment Directive as pressure or safety accessories (see EU Commission Guideline 1/8 and 1/20).

4.2 Installation location requirements

4.2 Installation location requirements



Aggressive atmospheres

Danger to personnel, system and environment can result from unsuitable environment.

• Provide an environment suitable to the housing rating and materials of construction.

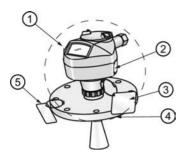


Direct sunlight

Device damage.

The device can overheat or materials become brittle due to UV exposure.

- Protect the device from direct sunlight.
- Make sure that the maximum permissible ambient temperature is not exceeded. Refer to the information in Chapter "Technical data (Page 193)".



- 1 Ambient temperature
- ② Device nameplate
- 3 Device tag
- 4 Process temperature (at process connection)
- ⑤ Process connection tag (contains process connection related information)

Antenna	1	3	
Horn	-40 to +80 °C (-40 to +176 °F)	with FKM O-ring:-40 to +200 °C (-40 to 392 °F)	
		with FFKM O-ring:-20 to +200 °C (-4 to +392 °F)	
PVDF	-40 to +80 °C (-40 to +176 °F)	-40 to +80 °C (-40 to +176 °F)	
Flanged encapsulated	-40 to +80 °C (-40 to +176 °F)	-40 to +170 °C (-40 to +338 °F)	
Hygienic encapsulated	-40 to +80 °C (-40 to +176 °F)	-40 to +170 °C (-40 to +338 °F)	
		with FKM seals used on process connection: -20 to +170 °C (-4 to +338 °F)	
		with EPDM seals used on process connection: -40 to +120 °C (-40 to +248 °F)	

Note

Details about the process connection, process temperature and materials are laser etched into the body of the flanged and hygienic versions. All other SITRANS LR250 versions have details listed on a tag.

4.3 Proper mounting

4.3 Proper mounting

Note

- Correct location is key to a successful application.
- Avoid reflective interference from vessel walls and obstructions by following guidelines in this chapter.

NOTICE

Incorrect mounting

The device can be damaged, destroyed, or its functionality impaired through improper mounting.

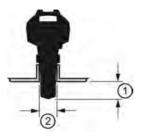
- Before installing ensure there is no visible damage to the device.
- Make sure that process connectors are clean, and suitable gaskets and glands are used.
- Mount the device using suitable tools. Refer to the information in Installation instructions (Page 34) for installation torque requirements.

Note

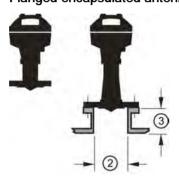
- On devices with a removable head, there is no limit to the number of times a device can be rotated without damage.
- When mounting, orient the front or back of the device towards the closest vessel wall or obstruction.
- Do not rotate the enclosure after programming and vessel calibration, otherwise an error may occur, caused by a polarity shift of the transmit pulse.

4.3.1 Nozzle design

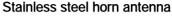
Threaded PVDF antenna

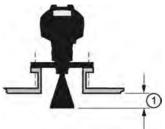


Flanged encapsulated antenna (FEA)

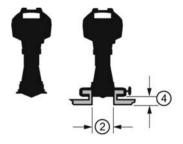


- ① Minimum clearance: 10 mm (0.4")
- (2) Minimum diameter: 50 mm (2")
- (3) Maximum nozzle length
- (4) Maximum length/diameter ratio 1:1
- The end of the antenna must protrude a minimum of 10 mm (0.4") to avoid false echoes being reflected from the nozzle¹⁾.
- Minimum recommended nozzle diameter for the threaded PVDF antenna is 50 mm (2").
- An antenna extension (100 mm/3.93") is available for the horn antenna only.
- The maximum nozzle length for the FEA is 500 mm (19.68") when the nozzle diameter is DN150 (6"). Only shorter lengths are recommended for smaller diameters.
- When installing the SITRANS LR250 with hygienic process connection, it is good hygienic practice to install the antenna in a nozzle that has a maximum length/diameter ratio of 1:1. For example, 2" (DN50) diameter nozzle should be no longer than 2" (50 mm).
- When removing any sanitary/hygienic clamp version of the HEA to clean the lens, ensure it is re-installed in the exact position it was removed from, to avoid re-commissioning the device.
- 1) Not applicable for FEA or HEA





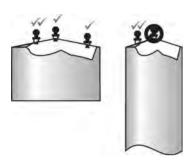
Hygienic encapsulated antenna (HEA)



4.3 Proper mounting

4.3.2 Nozzle location

- Avoid central locations on tall, narrow vessels
- Nozzle must be vertical and clear of imperfections





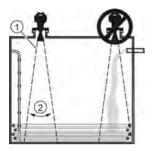
Preferred Undesirable

Beam angle

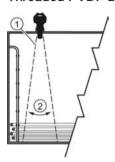
Note

- Beam width depends on antenna size and is approximate: see below.
- For details on avoiding false echoes, see Auto False Echo Suppression (Page 253).
- Beam angle is the width of the cone where the energy density is half of the peak energy density.
- The peak energy density is directly in front of and in line with the antenna.
- There is a signal transmitted outside the beam angle, therefore false targets may be detected.

Horn antenna

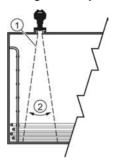


Threaded PVDF antenna

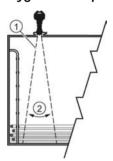


- ① Emission cone
- ② Beam angle

Flanged encapsulated antenna



Hygienic encapsulated antenna



4.3 Proper mounting

Emission cone type and beam angle

Antenna type	Antenna size		Beam angle
Horn	1.5"	1.5"	
	2"	2"	
	3"	3"	
	4"	4"	
Threaded PVDF			19°
	Process connection size	Process connection type	
Flanged encapsulated	2"	Class 150 ASME B16.5	12.8°
	3, 4, 6"	Class 150 ASME B16.5	9.6°
	50A	10K JIS B 2220	12.8°
	80A/100A/150A	10K JIS B 2220	9.6°
	DN50	PN10/16 EN1092-1	12.8°
	DN80/DN100/DN15 0	PN10/16 EN1092-1	9.6°
Hygienic encapsulated	2"	Sanitary Clamp according to	12.8°
	3, 4"	ISO 2852	9.6°
	DN50	Aseptic/Hygienic nozzle/slotted	12.8°
	DN80/DN100	nut according to DIN 11864-1 [Form A]	9.6°
	DN50	Aseptic/Hygienic flanged	12.8°
	DN80/DN100	according to DIN 11864-2 [Form A]	9.6°
	DN50	Aseptic/Hygienic Clamp	12.8°
	DN80/DN100	according to DIN 11864- 3 [Form A]	9.6°
	DN50	Hygienic nozzle/slotted nut	12.8°
	DN80/DN100	according to DIN 11851	9.6°
	Type F (50 mm) and Type N (68 mm)	Tuchenhagen Varivent	12.8°

Emission cone

 Keep emission cone free of interference from obstructions such as ladders, pipes, I-beams, or filling streams.

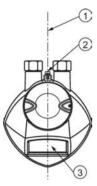
Access for programming

• Provide easy access for viewing the display and programming via the handheld programmer.

4.3.3 Orientation in a vessel with obstructions

Polarization reference point

For best results on a vessel with obstructions, or a stillpipe with openings, orient the front or back of the device toward the obstructions. For an illustration, see Device orientation (Page 33).



- ① Polarization axis
- 2 Polarization reference point
- 3 Display

4.3 Proper mounting

4.3.4 Mounting on a Stillpipe or Bypass Pipe

A stillpipe or bypass pipe is used for products with a low dK, or when vortex or extremely turbulent conditions exist. It can also be used to provide optimum signal conditions on foaming materials. See Dielectric constant of material measured in Performance (Page 193) for more information.

- The pipe diameter must be matched with the antenna size. Use the largest antenna size that will fit the stillpipe/bypass pipe¹⁾. See Threaded Horn dimensions, Raised-Face Flange per EN 1092-1 (Page 237), Flanged encapsulated dimensions (Page 212)or Hygienic encapsulated dimensions (Page 216).
- One continuous length of metallic pipe is preferred, without joints.
- Any false reflections created by joints/welds/imperfections will lead to inaccuracies of the measurement.
- Joints (if unavoidable) must be machined to ± 0.25 mm (± 0.010") and must have welded connecting sleeve on the outside.
- If using any hygienic process connections in conjunction with a stillpipe/bypass, please
 ensure that the antenna/lens are cleanable in accordance with the applicable approval.

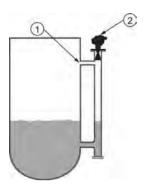
¹⁾ Mounting in a pipe greater than 100 mm (4") can cause large errors, and therefore is not recommended.

Suitable pipe diameters:	Horn antenna	40 to 100 mm (1.5 to 4")	
	PVDF antenna	50 mm (2") only	
	Flanged encapsulated antenna	50 to 100 mm (2 to 4")	
	Hygienic encapsulated antenna	50 to 100 mm (2 to 4")	
Not recommended:	> 100 mm (4")		
Bypass vent:	Required at the upper end of the bypass 1)		

To equalize pressure and keep the liquid level in the bypass constant with the liquid level in the vessel.

4.3.5 Device orientation

Bypass pipe installation



Stillpipe installation



① Vent

- ① Align front or back of device with stillpipe slots¹⁾
- ② Align front or back of device with vents¹⁾
- ② Slots

¹⁾ Horn antenna version shown as example

4.4 Installation instructions



Pressure applications

Danger to personnel, system and environment can result from improper installation.

Improper installation may result in loss of process pressure.



Improper installation

Danger to personnel, system and environment can result from improper installation.

• Installation shall only be performed by qualified personnel and in accordance with local governing regulations.

NOTICE

Device handling

Damage to device may result from improper handling.

- Handle the device using the enclosure, not the process connection or tag, to avoid damage.
- Take special care when handling the threaded PVDF and Hygienic or Flanged encapsulated antennas. Any damage to the antenna surface, particularly to the tip/lens, could affect performance. (For example, do not sit device on its lens antenna.)

Note

- For European Union and member countries, installation must be according to ETSI EN 302372.
- Refer to the device nameplate for approval information.

Note

The outer part of the lens on the flanged encapsulated antenna version may not appear to lie flush before installation and this is normal. This will flatten after installation and will not impact the performance of the device.

4.4.1 Threaded versions



Pressure applications

Danger of injury or poisoning.

It may be necessary to use PTFE tape or other appropriate thread sealing compound, and to tighten the process connection beyond hand-tight. (The maximum recommended torque for Threaded versions is 40 N-m (30 ft.lbs.)

- 1. Before inserting the device into its mounting connection, check to ensure the threads are matching, to avoid damaging them.
- 2. Simply screw the device into the process connection, and hand tighten, or use a wrench.

4.4.2 Flanged versions

NOTICE

Improper materials

The user is responsible for the selection of bolting and gasket materials (except for Flanged encapsulated antenna) which will fall within the limits of the process connection and its intended use, and which are suitable for the service conditions.

Special Instructions for Flanged encapsulated antenna only

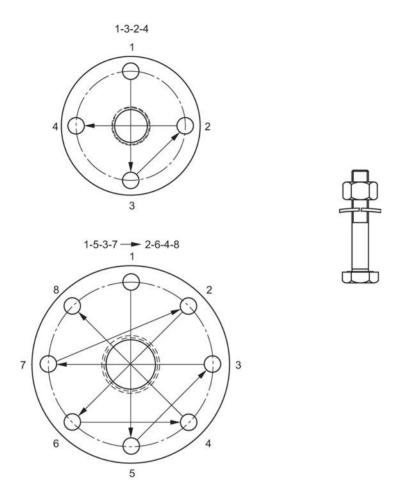
Note

- Use spring washers
- Lens assembly acts as integral gasket, no other required
- Use recommended torque values for tightening bolts

Flange bolting: recommended torque

Pressure class	Nominal pipe size (NPS)	Number of bolts	Recommended torque (Nm)
ASME B16.5, Class	2"	4	30 – 50
150	3"		50 – 70
	4"	8	40 – 60
	6"		70 – 90
EN1092-1, PN16 /	DN50/50A	4	30 – 50
JIS B 2220, 10K	DN80/80A	8	
	DN100/100A		
	DN150/150A		60 – 80

4.4 Installation instructions



Flange bolting instructions:

- 1. Use cross-pattern sequence as shown.
- 2. Check uniformity of the flange gap.
- 3. Apply adjustments by selective tightening if required.
- 4. Torque incrementally until desired value is reached.
- 5. Check/re-torque after 4 to 6 hours.

Recommendations for flange bolting:

- Check bolts periodically, re-torque as required.
- Use new lens, O-ring and spring washers after removal from installation. For instructions on replacing the lens, see Part replacement (Page 179).

See Flanged Horn with extension (Page 208), Raised-Face Flange per EN 1092-1 (Page 237), Flat-Face Flange (Page 240), and Flanged encapsulated antenna (3"/DN80/80A sizes and larger) (Page 214) for dimensions.

4.4.3 Hygienic versions



Loss of sanitary approvals

Loss of sanitary approvals can result from improper installation/mounting.

 Take special care when installing in hygienic or sanitary applications. Comply with installation/mounting guidelines to ensure cleanliness and the ability to keep the wetted parts in a position to be readily cleanable. (See relevant EHEDG/3A documentation - not supplied).

NOTICE

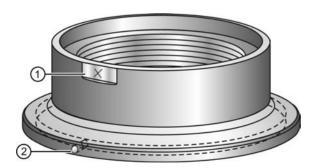
Loss of sanitary approvals

- For 3-A Sanitary Approved device installation where the customer tank process connection exists, a leak detection port of minimum 2.4 mm diameter must be provided at the lowest point in the process connection where leakage can occur.
- If leakage is detected at any time while the device is installed, then the device process connection parts must be disassembled and thoroughly cleaned prior to gasket replacement and reassembly.

Note

 For Hygienic encapsulated antenna, the lens acts as a gasket/seal and should be used in conjunction with a cleanable seal as required by the specific process connections (for example, DIN 11864-3).

Hygienic encapsulated antenna leak detection port



- Orientation mark for leak detection port
- (2) Leak detection port

4.5 Disassembly



Pressure applications

Danger to personnel, system and environment will result from improper disassembly.

• Never attempt to loosen, remove, or disassemble process connection while vessel contents are under pressure.



Incorrect disassembly

The following dangers may result through incorrect disassembly:

- Injury through electric shock
- Danger through emerging media when connected to the process
- Danger of explosion in hazardous area

In order to disassemble correctly, observe the following:

- Before starting work, make sure that you have switched off all physical variables such as pressure, temperature, electricity etc. or that they have a harmless value.
- If the device contains dangerous media, it must be emptied prior to disassembly. Make sure that no environmentally hazardous media are released.
- Secure the remaining connections so that no damage can result if the process is started unintentionally.

Connecting

5

5.1 Basic safety information

NOTICE

Condensation in the device

Damage to device through formation of condensation if the temperature difference between transportation or storage and the mounting location exceeds 20 °C (68°F).

 Before taking the device into operation let the device adapt for several hours in the new environment.

AWARNING

Missing PE/ground connection

Danger of electric shock.

Depending on the device version, connect the power supply as follows:

- Power plug: Ensure that the used socket has a PE/ground conductor connection. Check that the PE/ground conductor connection of the socket and power plug match each other
- Connecting terminals: Connect the terminals according to the terminal connection diagram. First connect the PE/ground conductor.

Operating Instructions, 08/2014, A5E32220602-AC

5.2 Connecting SITRANS LR250



Incorrect connection to power source

Danger to personnel, system and environment can result from improper power connection.

- The DC input terminals shall be supplied from a source providing electrical isolation between the input and output, in order to meet the applicable safety requirements of IEC 61010-1.
- All field wiring must have insulation suitable for rated voltages.



Loss of protection

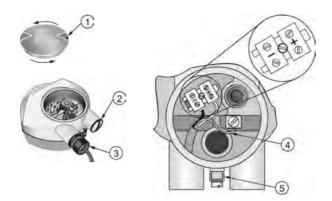
Loss of approvals can result from improper installation.

- · Check the nameplate on your device, to verify the approval rating.
- Use appropriate conduit seals to maintain IP or NEMA rating.
- See Wiring setups for hazardous area installations (Page 43).

NOTICE

Improper cables and conduit

 Separate cables and conduits may be required to conform to standard instrumentation wiring practices or electrical codes.



- (1) Use a 2 mm Allen key to loosen the lid-lock set screw (2) (4) Cable shield
- 2) Plug (IP68)

- ⑤ Ground terminal
- Optional cable gland a) b) (or NPT cable entry)b)
- a) May be shipped with the device.
- ^{b)} If cable is routed through conduit, use only approved suitable-size hubs for waterproof applications.
- c) Not applicable to 3-A Sanitary approved device.

Wiring instructions

- 1. Strip the cable jacket for approximately 70 mm (2.75") from the end of the cable, and thread the wires through the gland. (If cable is routed through conduit, use only approved suitable-size hubs for waterproof applications.)
- 2. Connect the wires to the terminals as shown: the polarity is identified on the terminal block.
- 3. Ground the device according to local regulations.
- 4. Tighten the gland to form a good seal.
- 5. Close the lid and secure the locking screw before programming and device configuration.

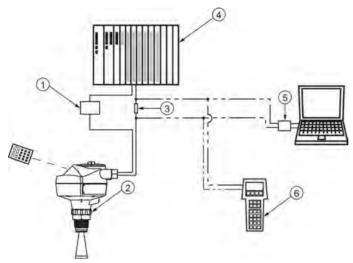
Note

Lid-lock set screw not applicable to 3-A Sanitary approved device.

5.2 Connecting SITRANS LR250

Connecting HART

Typical PLC/mA configuration with HART



- ① Power supply
- 4 Active PLC
- ② SITRANS LR250
- (5) HART modem
- 6 HART communicator

Note

- Depending on the system design, the power supply may be separate from the PLC, or integral to it.
- HART resistance (total loop resistance, that is, cable resistance plus 250 Ohm [resistor])
 must be limited according to the allowable operating area as shown in either Curve 1
 (Page 275) (General Purpose, Intrinsically Safe, Non-Sparking, Non-incendive) or Curve 2
 (Page 276) (Flameproof, Increased Safety, Explosion-proof).

5.3 Wiring setups for hazardous area installations

There are six wiring options for hazardous area installations:

- Intrinsically Safe wiring (Page 43)
- Non-Sparking wiring (Page 45)
- Non-incendive wiring (US/Canada only) (Page 45)
- Flameproof wiring (Page 46)
- Increased safety wiring (Page 47)
- Explosion-proof wiring (US/Canada only) (Page 47)

In all cases, check the nameplate on your instrument, confirm the approval rating, and perform installation and wiring according to your local safety codes.

5.3.1 Intrinsically safe wiring

Device nameplate (ATEX/IECEX/INMETRO/RCM)





ATEX certificate

The ATEX certificate listed on the nameplate can be downloaded from our website:

Product page (http://www.siemens.com/LR250)

Go to Support > Approvals / Certificates.

The IECEx certificate listed on the nameplate can be viewed on the IECEx website. Go to:

IECEx (http://iecex.iec.ch/)

Click on Certified Equipment then enter the certificate number IECEx SIR 05.0031X.

5.3 Wiring setups for hazardous area installations

Device nameplate (FM/CSA)





① Connection drawing number

The connection drawing number listed on the nameplate can be downloaded from our website: Product page (http://www.siemens.com/LR250)

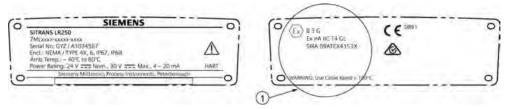
Go to Support > Installation Drawings > Level Measurement > SITRANS LR250.

- For power demands see Curve 1 (General Purpose, Intrinsically Safe, Non-Sparking, Non-incendive) (Page 275).
- For wiring requirements: follow local regulations.
- Approved dust-tight and water-tight conduit seals are required for outdoor NEMA 4X / type 4X / NEMA 6, IP67, IP68 locations.
- Refer to Instructions specific to hazardous area installations (Page 48).

Note

Selecting a suitable PLC input module or power supply requires knowledge about Intrinsic Safety and the application. It is the responsibility of the installer to ensure that the intrinsically safe installation complies with both the apparatus approval requirements and the relevant national code of practice.

5.3.2 Non-sparking wiring



ATEX certificate

The ATEX certificate listed on the nameplate can be downloaded from our website:

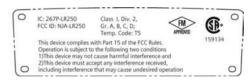
Product page (http://www.siemens.com/LR250)

Go to: Support > Approvals / Certificates.

- For power demands see Curve 1 (General Purpose, Intrinsically Safe, Non-Sparking/Energy Limited, Non-incendive) (Page 275).
- For wiring requirements follow local regulations.

5.3.3 Non-incendive wiring (US/Canada only)





The FM/CSA Class 1, Div 2 connection drawing number 23650673 can be downloaded from our website:

Product page (http://www.siemens.com/LR250)

Go to Support > Installation Drawings > Level Measurement > SITRANS LR250.

 For power demands see Curve 1 (General Purpose, Intrinsically Safe, Non-Sparking, Nonincendive) (Page 275).

5.3 Wiring setups for hazardous area installations

5.3.4 Flameproof wiring





1 ATEX certificate

The ATEX certificate listed on the nameplate can be downloaded from our website:

Product page (http://www.siemens.com/LR250)

Go to Support > Approvals / Certificates.

The IECEx certificate listed on the nameplate can be viewed on the IECEx website. Go to: IECEx (http://iecex.iec.ch/)

Click on Certified Equipment then enter the certificate number IECEx SIR 08.0107X.

- For power demands see Curve 2 (Flameproof, Increased Safety, Explosion-proof) (Page 276).
- For wiring requirements follow local regulations.
- See also Instructions specific to hazardous area installations (Page 48) and the ATEX certificate listed above.

5.3.5 Increased safety wiring





ATEX certificate

The ATEX certificate listed on the nameplate can be downloaded from our website:

Product page (http://www.siemens.com/LR250)

Go to Support > Approvals / Certificates.

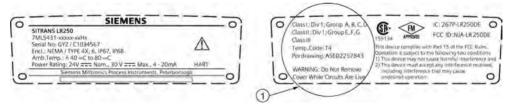
The IECEx certificate listed on the nameplate can be viewed on the IECEx website:

IECEx (http://iecex.iec.ch/)

Click on Certified Equipment then enter the certificate number IECEx SIR 08.0107X.

- For power demands see Curve 2 (Flameproof, Increased Safety, Explosion-proof) (Page 276).
- For wiring requirements follow local regulations.
- See also Instructions specific to hazardous area installations (Page 48) and the ATEX certificate listed above.

5.3.6 Explosion-proof wiring (US/Canada only)



① FM/CSA Explosion Proof connection drawing

The connection drawing number listed on the nameplate can be downloaded from our website:

Product page (http://www.siemens.com/LR250)

Go to Support > Installation Drawings > Level Measurement > SITRANS LR250

• For power demands see Curve 2 (Flameproof, Increased Safety, Explosion-proof) (Page 276).

5.4 Instructions specific to hazardous area installations

5.4 Instructions specific to hazardous area installations

5.4.1 (Reference European ATEX Directive 94/9/EC, Annex II, 1/0/6)

The following instructions apply to equipment covered by certificate number SIRA 06ATEX2358X, SIRA 08ATEX1301X, and SIRA 09ATEX4153X.

- 1. For use and assembly, refer to the main instructions.
- 2. The equipment is certified for use as Category 1GD equipment per SIRA 06ATEX2358X; Category 1/2 GD, 1D, 2D equipment per SIRA 08ATEX1301X; and Category 3G equipment per SIRA 09ATEX4153X.
- 3. The equipment may be used with flammable gases and vapors with apparatus group IIC, IIB and IIA and temperature classes T1, T2, T3 and T4.
- 4. The equipment has a degree of ingress protection of IP67 and a temperature class of T100 °C and may be used with flammable dusts.
- 5. The equipment is certified for use in an ambient temperature range of -40 °C to +80 °C.
- 6. The equipment has not been assessed as a safety related device (as referred to by Directive 94/9/EC Annex II, clause 1.5).
- 7. Installation and inspection of this equipment shall be carried out by suitably trained personnel in accordance with the applicable code of practice (EN 60079-14 and EN 60079-17 in Europe).
- 8. The equipment is non-repairable.
- 9. The certificate numbers have an 'X' suffix, which indicates that special conditions for safe use apply. Those installing or inspecting this equipment must have access to the certificates.
- 10.If the equipment is likely to come into contact with aggressive substances, then it is the responsibility of the user to take suitable precautions that prevent it from being adversely affected, thus ensuring that the type of protection is not compromised.
 - Aggressive substances: for example, acidic liquids or gases that may attack metals, or solvents that may affect polymeric materials.
 - Suitable precautions: for example, establishing from the material's data sheet that it is resistant to specific chemicals.

Special conditions for safe use (denoted by X after the certificate number)

- Parts of the enclosure may be non-conducting and may generate an ignition-capable level of
 electrostatic charge under certain extreme conditions. The user should ensure that the
 equipment is not installed in a location where it may be subjected to external conditions (such
 as high-pressure steam), which might cause a build-up of electrostatic charge on nonconducting surfaces.
- Aluminium, magnesium, titanium or zirconium may be used at the accessible surface of the
 equipment. In the event of rare incidents, ignition sources due to impact and friction sparks
 could occur. This shall be considered when the SITRANS LR250 mA/HART is being installed
 in locations that specifically require group II, level of protection Ga or Da.
- The equipment shall be bonded to the system earth in accordance with the relevant code of practice.
- When the SITRANS LR250 mA/HART is used in the presence of combustible dust, the gland that is fitted to the equipment shall also be suitable for use in the presence of combustible dust, as certified by an ATEX notified body, in addition, the installation of the gland shall not compromise the IP6X rating of the equipment enclosure.

5.4 Instructions specific to hazardous area installations

Commissioning

6.1 Basic safety information



Loss of explosion protection

Danger of explosion when device is not properly commissioned

If opening device

- Isolate from power.
- or -
- Ensure that the atmosphere is explosion-free (hot work permit).

Ensure device is properly closed before returning to operation.

6.2 Operating via the handheld programmer

The handheld programmer used with this device contains lithium batteries that are non-replaceable.

Lithium batteries are primary power sources with high energy content designed to provide the highest possible degree of safety.



Potential hazard

Lithium batteries may present a potential hazard if they are abused electrically or mechanically. Observe the following precautions when handling and using lithium batteries:

- Do not short-circuit, recharge or connect with false polarity.
- Do not expose to temperatures beyond the specified temperature range.
- Do not incinerate.
- Do not crush, puncture or open cells or disassemble.
- Do not weld or solder to the battery's body.
- Do not expose contents to water.

6.2 Operating via the handheld programmer

6.2.1 Power up

Power up the device. A transition screen showing first the Siemens logo and then the current firmware revision is displayed while the first measurement is being processed. The first time the device is configured, you will be prompted to select a language (English, German, French, or Spanish). To change the language again, see **Language (7.)**.

Press **Mode** to toggle between Measurement and Program mode.

6.2.2 Handheld programmer functions

The radar device carries out its level measurement tasks according to settings made via parameters. The settings can be modified locally via the Local User Interface (LUI) which consists of an LCD display and a handheld programmer.

A Quick Start Wizard provides an easy step-by-step procedure to configure the device for a simple application. Access the wizards:

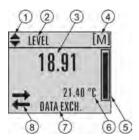
- locally [see Quick Start Wizard via the handheld programmer (Page 62)]
- or from a remote location [see Quick Start Wizard via SIMATIC PDM (Page 79), or Quick Start Wizard via AMS Device Manager (Page 104)]

For more complex setups see Application Examples (Page 67), and for the complete range of parameters see Parameter Reference (Page 123).

6.2.2.1 The LCD display

Measurement mode display

Normal operation



- 1 Toggle indicator a) for linear units or %
- 2 Selected operation: level, space, distance, or volume
- 3 Measured value (level, space, distance, or volume)
- 4 Units
- Bar graph indicates level
- 6 Secondary region indicates on request ^{b)} electronics temperature, echo confidence, loop current, or distance
- 7 Text area displays status messages
- 8 Device status indicator, see Device status icons (Page 184)

^{b)} In response to a key press request. For details, see Handheld Programmer (Page 55) for key functions in Measurement mode.

Fault present

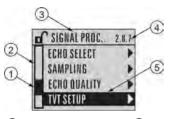


- ① Device status indicator, see Device status icons (Page 184)
- 2 Text area displays status messages

a) Press **UP** or **DOWN** arrow to switch.

PROGRAM mode display

Navigation view



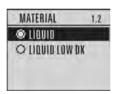
- 1 Item band
- 4 Current item number
- 2 Menu bar
- Current item
- 3 Current menu
- A visible menu bar indicates the menu list is too long to display all items.
- A band halfway down the menu bar indicates the current item is halfway down the list.
- The depth and relative position of the item band on the menu bar indicates the length of the menu list, and approximate position of the current item in the list.
- A deeper band indicates fewer items.

(5)

Parameter view



Edit view



- (1) Parameter name
- 2 Parameter number
- ③ Parameter value/selection

6.2.2.2 Handheld programmer (Part No. 7ML1930-1BK)

The programmer is ordered separately.



6.2 Operating via the handheld programmer

Key functions in measurement mode

Key	Function	Result	
5	Updates the loop current	New value is displayed in LCD secondary region.	
6	Updates internal enclosure temperature reading		
8	Updates echo confidence value	New value is displayed in LCD secondary region.	
•	Updates distance measurement		
	Mode opens PROGRAM mode	Opens the menu level last displayed in this power cycle, unless power has been cycled since exiting PROGRAM mode or more than 10 minutes have elapsed since PROGRAM mode was used. Then top level menu will be displayed.	
•	RIGHT arrow opens PROGRAM mode	Opens the top level menu.	
*	UP or DOWN arrow toggles between linear units and percent	LCD displays measured value in either linear units or percent.	

6.2.3 Programming

Note

- While the device is in PROGRAM mode the output remains fixed and does not respond to changes in the device.
- The device automatically returns to Measurement mode after a period of inactivity in PROGRAM mode (between 15 seconds and 10 minutes, depending on the menu level).

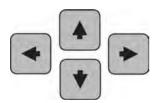
Change parameter settings and set operating conditions to suit your specific application. For remote operation see Operating via SIMATIC PDM (Page 75) or Operating via AMS Device Manager (Page 100).

Parameter menus

Note

For the complete list of parameters with instructions, see Parameter Reference (Page 123).

Parameters are identified by name and organized into function groups. See LCD menu structure (Page 285).



- 1. QUICK START
- 2. SETUP

2.1. DEVICE

Z. I. DEVICE

2.7. LINEARIZATION

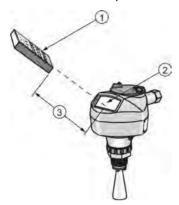
2.7.1. VOLUME

2.7.1.1. VESSEL SHAPE

6.2 Operating via the handheld programmer

1. Enter PROGRAM mode

- Point the programmer at the display from a maximum distance of 300 mm (1 ft).
- RIGHT arrow activates PROGRAM mode and opens menu level 1.
- Mode opens the menu level last displayed in PROGRAM mode within the last 10 minutes, or menu level 1 if power has been cycled since then.



① Handheld programmer

② Display

(3) Maximum distance: 300 mm (1 ft)

2. Navigating: key functions in Navigation mode

Note

- In Navigation mode ARROW keys move to the next menu item in the direction of the arrow
- For Quick Access to parameters via the handheld programmer, press Home , then enter the menu number, for example: **2.7.1.** (Volume).

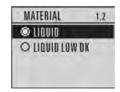
Key Name Menu level Fi		Function		
•	UP or DOWN arrow	menu or parameter	Scroll to previous or next menu or parameter	
•	RIGHT arrow	menu	Go to first parameter in the selected menu, or open next menu.	
		parameter	Open Edit mode.	
•	LEFT arrow	menu or parameter	Open parent menu.	
	Mode	menu or parameter	Change to MEASUREMENT mode.	
	Home	menu or parameter	Open top level menu: menu 1.	

3. Editing in PROGRAM mode

- Navigate to the desired parameter.
- Press **RIGHT arrow** to open parameter view.
- Press **RIGHT arrow** again to open **Edit** mode. The current selection is highlighted. Scroll to a new selection.
- Press **RIGHT arrow** to accept it.

The LCD returns to parameter view and displays the new selection.



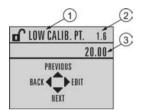


- Parameter name
- Parameter number
- 3 Current selection

6.2 Operating via the handheld programmer

- 4. Changing a numeric value
- Navigate to the desired parameter.
- Press **RIGHT arrow** to open parameter view. The current value is displayed.
- Press **RIGHT arrow** again to open **Edit** mode. The current value is highlighted.
- Key in a new value.
- Press **RIGHT arrow** to accept it.

The LCD returns to parameter view and displays the new selection.





- Parameter name
- ② Parameter number
- 3 Current selection

Key functions in edit mode

Key	Name	Function		
	UP or DOWN arrow	Selecting options	Scrolls to item.	
		Numeric	Increments or decrements digits	
		editing	Toggles plus and minus sign	
•	RIGHT arrow	Selecting options	Accepts the data (writes the parameter)	
			Changes from Edit to Navigation mode	
		Numeric editing	Moves cursor one space to the right	
		editing	or, with cursor on Enter sign, accepts the data and changes from Edit to Navigation mode	
•	LEFT arrow:	Selecting options	Cancels Edit mode without changing the parameter.	
		Numeric editing	Moves cursor to plus/minus sign if this is the first key pressed	
			or moves cursor one space to the left	
C	Clear	Numeric editing	Erases the display.	
	Decimal point	Numeric editing	Enters a decimal point.	
7+	Plus or minus sign	Numeric editing	Changes the sign of the entered value.	
0	Numeral	Numeric editing	Enters the corresponding character.	
to				
9				

6.2.3.1 Quick Start Wizard via the handheld programmer

Note

- A reset to factory defaults should be performed before running the Quick Start Wizard if the device has been used in a previous application. See Master Reset (4.1.).
- The Quick Start wizard settings are inter-related and changes apply only after you select **Finish** in the Wizard Complete step.
- Do not use the Quick Start wizard to modify parameters: see instead Parameter Reference (Page 123). (Perform customization for your application only after the Quick Start has been completed).
- Default settings in the parameter tables are indicated with an asterisk (*).

1. Quick Start

1.1. Quick Start Wiz

- Point the programmer at the display from a maximum distance of 300 mm (1 ft), then press RIGHT arrow to activate PROGRAM mode and open menu level 1.
- Press **RIGHT arrow** twice to navigate to menu item 1.1 and open parameter view.
- Press RIGHT arrow to open Edit mode or DOWN arrow to accept default values and move directly to the next item.
- To change a setting, scroll to the desired item or key in a new value.
- After modifying a value, press **RIGHT arrow** to accept it and press **DOWN arrow** to move to the next item.
- Quick Start settings take effect only after you select Finish.



Material

Selects the appropriate echo processing algorithms for the material [see **Position Detect** (2.8.4.2.) for more detail].





Options	*	LIQUID
		LIQUID LOW DK ^{a)} (low dielectric liquid – CLEF algorithm enabled)

a) dK < 3.0

Response Rate

Sets the reaction speed of the device to measurement changes in the target range. Use a setting just faster than the maximum filling or emptying rate (whichever is greater).





Options		Response Rate (1.3.)	Fill rate per Minute (2.4.2.)/Empty rate per Minute (2.4.3.)
* SLOW		SLOW	0.1 m/min (0.32 ft/min)
	MED 1.0 m/min (3.28 ft/min)		1.0 m/min (3.28 ft/min)
		FAST	10.0 m/min (32.8 ft/min)

Operating Instructions, 08/2014, A5E32220602-AC

6.2 Operating via the handheld programmer

Units

Sensor measurement units.



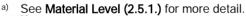


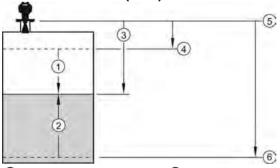
Options	m, cm, mm, ft, in.
	Default: m

Operation



Operation		Description
NO SERVICE		Measurement and associated loop current are not updated, and the device defaults to Fail-safe mode ^{a)} .
LEVEL	*	Distance to material surface referenced from Low Calibration Point
SPACE		Distance to material surface referenced from High Calibration Point
DISTANCE		Distance to material surface referenced from Sensor reference point





- ① Space
- 4 High Calibration Point (process full level)
- 2 Level
- Sensor reference point a)
- 3 Distance
- 6 Low Calibration Point (process empty level)

^{a)} The point from which High and Low Calibration points are referenced: see **Dimension drawings**.

Low Calibration Point

Distance from Sensor Reference to Low Calibration Point: usually process empty level. (See **Operation** for an illustration.)



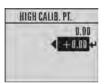


Values Range: 0.00 to 20.00 m

High Calibration Point

Distance from Sensor reference point to High Calibration Point: usually process full level. (See **Operation** for an illustration.)





Values Range: 0.00 to 20.00 m

Wizard complete

Options	BACK, CANCEL, FINISH (Display returns to 1.1 Quick Start Wiz menu when	
	Quick Start is successfully completed.)	

Press **DOWN arrow** (Finish). Then press **LEFT arrow** to return to **Measurement** mode. SITRANS LR250 is now ready to operate.

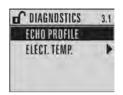
6.2.3.2 Auto False Echo Suppression

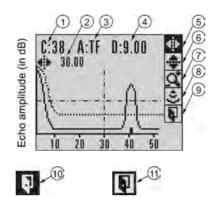
If you have a vessel with known obstructions, we recommend using Auto False Echo Suppression to prevent false echo detection. See **TVT setup (2.8.7.)** for instructions.

This feature can also be used if the display shows a false high level, or the reading is fluctuating between the correct level and a false high level.

6.2.3.3 Requesting an Echo Profile

- In PROGRAM mode, navigate to: Level Meter > 3. > 3.1.
- Press **RIGHT arrow** to request a profile.





(1) Confidence

- (7) Zoom
- ② Distance from Low Calibration Point to vertical cross-hair
- Measure

3 Algorithm: tF (trueFirst)

9 Exit

(4) Distance from flange face to target

Exit icon selected

(5) Pan left/right - selected

(ii) Exit icon deselected

- (6) Pan up/down
- Use **UP** or **DOWN** arrow to scroll to an icon. When an icon is highlighted, that feature becomes active.
- To move a cross-hair, press RIGHT → arrow to increase the value, LEFT → arrow to decrease.
- To Zoom into an area, position the intersection of the cross-hairs at the center of that area, select Zoom, and press RIGHT arrow. Press LEFT arrow to Zoom out.
- To update the profile, select **Measure** and press **RIGHT arrow**.
- To return to the previous menu, select **Exit** then press **RIGHT arrow**.

6.3 Application examples

Note

In the applications illustrated below, values are for example purposes only.

You can use these examples as setup references. Enter the values in the parameter tables to select the corresponding functions.

Configure the basic settings using the Quick Start wizard parameters. (These parameters are inter-related, and changes take effect only after you select **FINISH** to apply changes in the final step.)

In each example, after performing a Quick Start, navigate to the other required parameters either via the handheld programmer, or using a Device Management tool (SIMATIC PDM or AMS Device Manager) and enter the appropriate values.

6.3 Application examples

6.3.1 Liquid resin in storage vessel, level measurement

Note

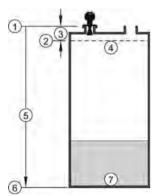
Minimum distance from flange face to target is limited by Near Range (2.8.1.).

To obtain level measurement/4 to 20 mA output proportional to resin levels:

- Low Calibration Pt. = 5 m (16.5 ft) from sensor reference point
- High Calibration Pt.= 0.5 m (1.64 ft) from sensor reference point
- Max.fill/empty rate = 0.2 m/min (0.65 ft/min)

In the event of a loss of echo:

• SITRANS LR250 is to go into Fail-safe High after 2 minutes.



- Sensor reference point
- ⑤ 5 m
- (2) High calibration point
- 6 Low calibration point

③ 0.5 m

⑦ 0% level

(4) 100% level

Parameter type	Parameter No. /Name	Options/ Values	Function
Quick Start	Introduction	NEXT	Continue with Wizard.
Wizard	Language	NEXT	Continue with current language.
parameters	Material	LIQUID	
	Response Rate	MED	Medium =1 m/minute
	Units	М	meters
	Operation	LEVEL	Level
	Low Calibration Point	5	5 m (16.5 ft)
	High Calibration Point	0.5	0.5 m (1.64 ft)
	Wizard Complete	FINISH Transfers Quick Start settings to device.	
Independent	LOE Timer (2.5.2.)	2	2 minutes
parameters	Material Level (2.5.1.)	HI	Fail-safe level set to High

Return to **Measurement**: press **Mode** to start normal operation.

6.3.2 Horizontal vessel with volume measurement

Note

The minimum distance from the flange face to the target is limited by **Near Range (2.8.1.)**.

To obtain level measurement/4 to 20 mA output proportional to vessel volume in a chemical vessel:

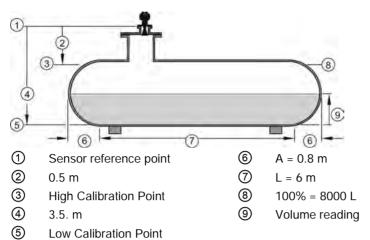
- Low Calibration Point = 3.5 m (11.48 ft) from sensor reference point
- High Calibration Point = 0.5 m (1.64 ft) from sensor reference point
- Max. fill/empty rate = 0.2 m/min (0.65 ft/min)

Select vessel shape, Parabolic Ends, and enter values for A and L, to obtain a volume reading instead of level.

In the event of a loss of echo: SITRANS LR250 is to go into Fail-safe High after 2 minutes.

Operating Instructions, 08/2014, A5E32220602-AC

6.3 Application examples



Parameter type	Parameter No./Name	Options/ Values	Function
Quick Start	Introduction	NEXT	Continue with Wizard.
Wizard parameters	Language	NEXT	Continue with current language.
	Material	LIQUID	
	Response Rate	MED	Medium =1 m/minute
	Units	М	meters
	Operation	LEVEL	Level is reported as Volume when a vessel shape is selected.
	Low Calibration Point	3.5	3.5 m (11.48 ft)
	High Calibration Point	0.5	0.5 m (1.64 ft)
	Wizard Complete	FINISH	Transfers Quick Start settings to device.
Independent parameters	Vessel Shape (2.7.1.1.)	PARABOLIC ENDS	Defines vessel shape.
	Maximum Volume (2.7.1.2.)	8000	8000 liters
	Vessel Dimension A (2.7.1.3.)	0.8	0.8 m (2.62 ft)
	Vessel Dimension L (2.7.1.4.)	6	6 m (19.68 ft)
	LOE Timer (2.5.2.)	2	2 minutes
	Material Level (2.5.1.)	HI	Fail-safe level set to High

Return to **Measurement**: press **Mode** to start normal operation.

6.3.3 Application with stillpipe

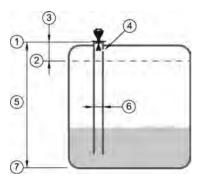
Note

- Near Range (2.8.1.) (Blanking) will be set at the factory. Check the process connection tag for specific values.
- Suitable pipe diameters are 40 mm (1.5") to 100 mm (4").
- The pipe diameter must be matched with the antenna size. Use the largest antenna size that will fit the stillpipe/bypass pipe. See Dimensions (Page 203).
- See Mounting on a Stillpipe or Bypass Pipe (Page 32) for installation guidelines.

This application is to obtain a level measurement and corresponding 4 to 20 mA output proportional to the oil level in a fuel storage vessel.

- Low Calibration Pt. is 5 m (16.5 ft) from the sensor reference point.
- High Calibration Pt. is 0.5 m (1.65 ft) from the sensor reference point.
- The stillpipe inside diameter is 50 mm (1.96").
- The maximum rate of filling or emptying is about 0.1 m (4")/min.

6.3 Application examples



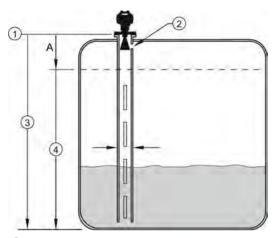
- sensor reference point
- 2 high calibration point
- ③ 0.5 m
- 4 vent hole

- ⑤ 5 m
- 6 50 mm I.D.
- (7) low calibration point

Parameter type	Parameter No./Name	Options/Values	Function
Quick Start Wizard	Introduction	NEXT	Continue with Wizard.
	Language	NEXT	Continue with current language.
	Material	LIQUID LOW DK	
	Response Rate	MED	Medium =1 m/minute
	Units	М	meters
	Operation	LEVEL	Level is reported as Volume when a vessel shape is selected.
	Low Calibration Point	5	5 m (16.5 ft)
	High Calibration Point	0.5	0.5 m (1.64 ft)
	Wizard Complete	FINISH	Transfers Quick Start settings to device.
Independent parameters	Propagation Factor (2.8.3.) ^{a)}	0.988	P.F. for a 50 mm (1.96") I.D. stillpipe
	Position Detect (2.8.4.2.)	HYBRID	
	CLEF Range (2.8.4.4.) ^{a)}	4.3	Low calibration point - 0.7 m = 4.3 m (14.1 ft)

a) The recommended values for the propagation factor and for CLEF range are dependent on the stillpipe diameter. Refer to the next table for values.

Propagation Factor/Stillpipe Diameter



- sensor reference point
- 3 low calibration point

② air gap

- 4 CLEF range 2.8.4.4.
- A 700 or 1000 mm (see CLEF Range settings in table below)

Values	Range	0.3 to 1.0 depe	nding on pipe size	
	Default	1.0000		
Nominal Pipe Size a)	40 mm (1.5")	50 mm (2")	80 mm (3")	100 mm (4")
Propagation Factor	0.9844	0.988	0.9935	0.9965
CLEF Range (2.8.4.4.) settings	Low calibration point - 700 mm (2.29 ft) ^{b)}	Low calibration point - 700 mm (2.29 ft) ^{b)}	Low calibration point -1000 mm (3.28 ft) ^{b)}	Low calibration point -1000 mm (3.28 ft) ^{b)}

a) Since pipe dimensions may vary slightly, the propagation factor may also vary.

Note

Flanged and Hygienic encapsulated antenna

For Flanged encapsulated antenna (7ML5432) and Hygienic encapsulated antenna (7ML5433) match the process connection size to the pipe diameter. For example, DN80/3" flange to DN80/3" pipe.

CLEF range covers the whole measurement range except first 700 or 1000 mm from sensor reference point

6.3 Application examples

Remote operation

7.1 Operating via SIMATIC PDM

SIMATIC PDM is a software package used to commission and maintain process devices. Please consult the operating instructions or online help for details on using SIMATIC PDM. You can find more information on versions and compatibility at our website:

SIMATIC PDM (www.siemens.com/simatic-pdm).

7.1.1 Functions in SIMATIC PDM

Note

- For a complete list of parameters, see Parameter Reference (Page 123).
- While the device is in PROGRAM mode the output remains fixed and does not respond to changes in the device.

7.1.1.1 PDM function overview

SIMATIC PDM monitors the process values, alarms and status signals of the device. It allows you to display, compare, adjust, verify, and simulate process device data; also to set schedules for calibration and maintenance.

Parameters are identified by name and organized into function groups. See LCD menu structure (Page 285) for a chart and Changing parameter settings using SIMATIC PDM (Page 84) for more details. The menu structure for SIMATIC PDM is almost identical to that for the LCD.

See Parameters accessed via pull-down menus (Page 85) for parameters that do not appear in the menu structure in SIMATIC PDM.

7.1.1.2 Features of SIMATIC PDM Rev. 6.0, SP4 or higher

The graphic interface in the device makes monitoring and adjustments easy.

Feature	Function	
Quick Start (Page 79)	Device configuration for simple applications	
Echo Profile Utilities (Page 86)	Easy access to echo profile viewing/comparison, TVT shaping, auto false echo suppression and echo setup	
Auto False Echo Suppression (Page 89)	Screen out false echoes	
TVT Shaper (Page 88)	Manual TVT adjustment	
Process Variables (Page 96)	Monitor process variables and level trend	
Security (Page 99)	Protect security and communication parameters from modification by the maintenance user	

7.1.1.3 Features of SIMATIC PDM Rev. 5.2, SP1

SIMATIC PDM Rev. 5.2 SP1 is supported only for basic configuration and troubleshooting. For advanced features such as the Quick Start wizard, Rev. 6.0 SP3 HF2 or higher is required.

7.1.1.4 SIMATIC PDM Version

Check the support page of our website to make sure you have the latest version of SIMATIC PDM, the most recent Service Pack (SP) and the most recent hot fix (HF): SIMATIC PDM Version (https://support.automation.siemens.com). Browse to Product Information > Automation Technology > Process control systems > SIMATIC PCS 7 > System components > SIMATIC PDM.

7.1.2 Initial setup

To ensure that SIMATIC PDM connects properly, complete the following two processes:

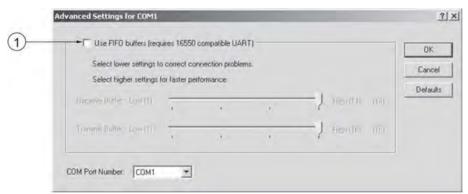
- 1. De-activate buffers
- 2. Update the Electronic Device Description (EDD)

7.1.2.1 Deactivating buffers

This deactivation is required to align SIMATIC PDM with the HART modem for Windows 2000® and Windows® XP operating Systems. Windows® is a registered trademark of the Microsoft Corporation.

Note

- This deactivation is only necessary when you're connecting via RS232 (COM1) as opposed to USB.
- You will need administrative rights on your operating system to deactivate buffers.
- SIMATIC PDM operates only in the Windows XP Professional version, not in the Home version.
- 1. Click Start/Settings/Control Panel to begin configuration.
- 2. Double click **System**, select the **Hardware** tab, and click the **Device Manager** button.
- 3. Open **Ports** folder and double click the COM Port used by the system to open the **Communications Port Properties** window.
- 4. Select the **Port Settings** tab and double click the **Advanced** button.
- 5. If the **Use FIFO buffers** radio box is selected, click to deselect.



- ① Deselect **Use FIFO buffers** radio box
- 6. Click **OK** to close out. Close all screens and then reboot.

7.1.3 Updating the Electronic Device Description (EDD)

You can locate the EDD in Device Catalog, under **Sensors/Level/Echo/SiemensMilltronics/SITRANS LR250**. The EDD revision must match the Firmware revision in the device.

To install a new EDD:

- 1. Download the most current EDD from our website: Product page (http://www.siemens.com/LR250)
- 2. Save files to your computer, and extract the zipped file to an easily accessed location.
- 3. Launch SIMATIC PDM Manage Device Catalog, browse to the unzipped EDD file and select it.

7.1.3.1 Configuring a new device

Note

- Clicking on Cancel during an upload from device to SIMATIC PDM will result in some parameters being updated.
- Application Guides for setting up HART devices with SIMATIC PDM can be downloaded from our website:
 - Product page (http://www.siemens.com/LR250).
- 1. Check that you have the most recent EDD, and if necessary update it. [See Updating the Electronic Device Description (EDD) (Page 78) above].
- 2. Launch SIMATIC Manager and create a new project for the device.
- 3. Open the menu **Device Master Reset** and click on **OK** to perform a reset to Factory Defaults.
- 4. After the reset is complete upload parameters to the PC/PG.
- 5. Configure the device via the Quick Start wizard.

7.1.4 Quick Start Wizard via SIMATIC PDM

The graphic Quick Start Wizard provides an easy step-by-step procedure that configures the device for a simple application.

Please consult the operating instructions or online help for details on using SIMATIC PDM.

- 1. If you have not already done so, check that you have the most up-to-date Electronic Device Description (EDD) for your device. [See Configuring a new device (Page 78).]
- 2. Launch SIMATIC Manager and create a new project. Application Guides for setting up HART and PROFIBUS PA devices with SIMATIC PDM can be downloaded from the product page of our website:

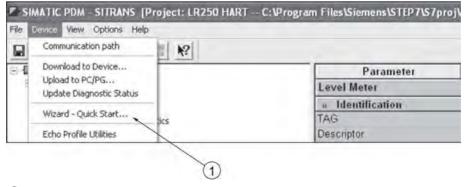
Product page (http://www.siemens.com/LR250)

Quick start

Note

- A reset to Factory Defaults should be performed before running the Quick Start Wizard if device has been used in a previous application. See Master Reset via SIMATIC PDM (Page 95).
- The Quick Start wizard settings are inter-related and changes apply only after you click on FINISH AND DOWNLOAD at the end of the last step to save settings offline and transfer them to the device.
- Do not use the Quick Start Wizard to modify individual parameters: for quick access to echo profile parameters, see Echo Profile via SIMATIC PDM (Page 86) or see Parameter Reference (Page 123) for a complete list. (Perform customization only after the Quick Start has been completed.)
- Click on BACK to return and revise settings or CANCEL to exit the Quick Start.
- For a vessel with obstructions see Auto False Echo Suppression via SIMATIC PDM (Page 89).

Launch SIMATIC PDM, open the menu Device - Wizard - Quick Start, and follow steps 1 to 5.

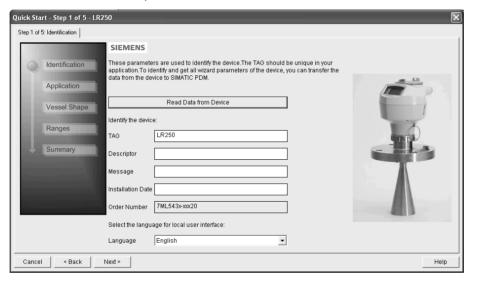


(1) Quick Start

Step 1 - Identification

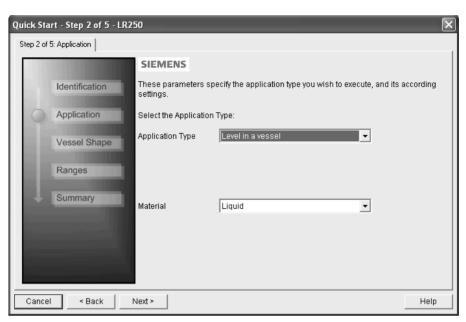
Note

- The layout of the dialog boxes shown may vary according to the resolution setting for your computer monitor.
- SITRANS PDM limits the TAG field to a maximum of 24 characters.
- 1. Click on **Read Data from Device** to upload Quick Start parameter settings from the device to the PC/PG and ensure PDM is synchronized with the device.
- 2. If required, change the language for the local user interface.
- 3. Click on **NEXT** to accept the default values. (Description, Message, and Installation Date fields can be left blank.)



Step 2 - Application

Select the application type (level or volume) and the material, then click on **NEXT**. See Application with Stillpipe (Page 71) for a Low Dielectric Liquid application.

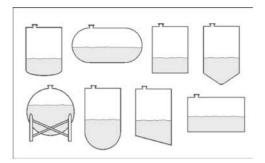


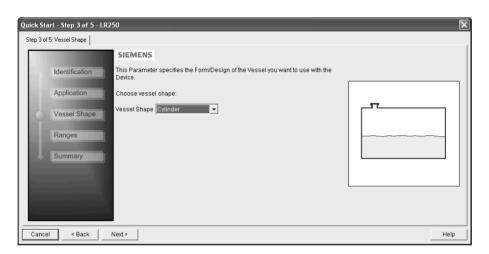
Step 3 - Vessel Shape

The vessel shapes shown are predefined.

For a vessel with obstructions, see Auto False Echo Suppression via SIMATIC PDM (Page 89).

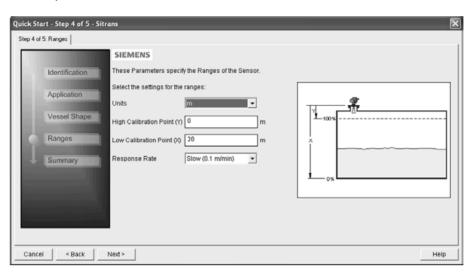
Select the vessel shape, and click on **NEXT**.





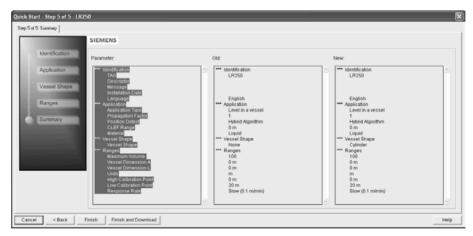
Step 4 - Ranges

Set the parameters, and click on **NEXT**.



Step 5 - Summary

Check parameter settings, and click on **BACK** to return and revise values, **FINISH** to save settings offline, or **FINISH AND DOWNLOAD** to save settings offline and transfer them to the device.



The message Quick Start was successful will appear. Click on OK.

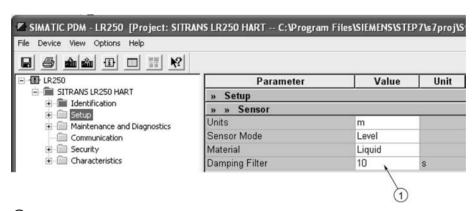
7.1.5 Changing parameter settings using SIMATIC PDM

Note

- For a complete list of parameters, see Parameter Reference (Page 123).
- Clicking on Cancel during an upload from device to SIMATIC PDM will result in some parameters being updated.

Many parameters are accessed via pull-down menus in PDM. See Parameters accessed via pull-down menus (Page 85) for others.

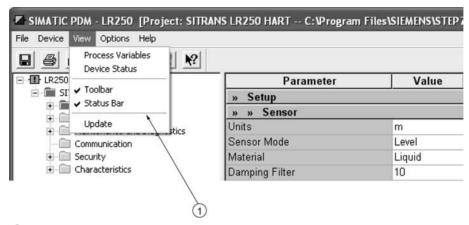
- 1. Launch SIMATIC PDM, connect to device, and upload data from device.
- 2. Adjust parameter values in the parameter value field then **Enter**. The status fields read **Changed**.
- 3. Open the Device menu, click on **Download to device**, then use **File Save** to save settings offline. The status fields are cleared.



Value fields

7.1.6 Parameters accessed via pull-down menus

Click on **Device** or **View** to open the associated pull-down menus.



1 pull-down menus

Pull-down menus

Device menus	View menus	
Communication path	Process Variables (Page 96)	
Download to device	Device Status (Page 98)	
Upload to PC/PG	Toolbar	
Update Diagnostic Status	Status bar	
Wizard - Quick Start (Page 79)	Update	
Echo Profile Utilities (Page 86)		
Maintenance (Page 92)		
Wear (Page 95)		
Select Analog Output (Page 94)		
Self Test (Page 94)		
Loop Test (Page 94)		
Configuration Flag Reset (Page 94)		
Master Reset (Page 95)		
HART Communication (Page 95)		

7.1.6.1 Echo profile utilities

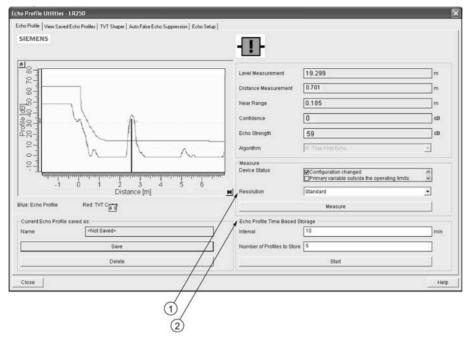
Open the menu **Device – Echo Profile Utilities** and click on the appropriate tab for easy access to:

- Echo profile (Page 86)
- View Saved Echo Profiles (Page 87)
- TVT Shaper (Page 88)
- Auto False Echo Suppression (Page 89)
- Echo Setup (Page 92)

7.1.6.2 Echo profile

Note

- Double click on each axis to see the Xscale and Data Scale values.
- To zoom in to a section of the profile, left-click and drag a marquee around it. Right click inside the window to zoom out.
- Expand or compress the x and/or y axes:
 - Left-click on the axis and drag in either direction to reposition the low end of the scale.
 - Right-click on the axis and drag in either direction to reposition the high end of the scale.
- After saving a profile click on OK, not the x button, to close the Echo Profile Utilities window, otherwise the profile will not be saved.
- In the Echo Profile Utilities window click the Echo Profile tab.
- Initial profile graph is blank upon entry to dialog. Click **Measure** to update the profile.
- It is recommended to use the **Detailed** resolution view of the echo profile for troubleshooting. For faster and more coarse views, the **Standard** resolution may be used.
- Click Save and in the new window enter a name and click OK.
- Click OK to exit.



- 1 Resolution
- 2 Echo Profile Time Based Storage

7.1.6.3 View saved echo profiles

To view a saved profile, click on the tab View Saved Echo Profiles.

Echo profile data logging

You can store up to 60 profiles at a selected interval (maximum 60 minutes). Inside Echo Profile Utilities, in the **Echo Profile Time Based Storage** window:

- Enter the desired interval between stored profiles.
- Enter the maximum number of profiles to be stored (maximum 60).
- Click on **Start**. A message appears warning of the time delay and warning that all previous saved profiles will be overwritten. Click on **OK** to proceed. The new profiles will be saved with their date and time.
- Click on the tab View Saved Echo Profiles to view the stored profiles.

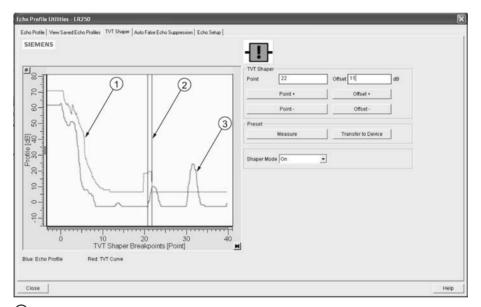
7.1.6.4 TVT Shaper

Note

Double click on each axis to see the X scale and data scale values. Right-click or Left-click on the axis and drag to reposition the scale.

This feature allows you to manually adjust the TVT to avoid false echoes caused by obstructions. For an explanation see Auto False Echo Suppression (Page 253).

Open the menu Device – Echo Profile Utilities and click the tab TVT Shaper.



- ① TVT
- ② Cursor
- 3 Echo profile
- Initial profile graph is blank upon entry to dialog. Click on **Measure** to view and upload the current TVT from device.
- Change the position of the cursor on the TVT using the Point+ and Point- buttons: raise and lower the TVT using Offset+ and Offset-.
- Alternatively, enter values for Point and Offset directly into the dialog boxes.
- Click on Transfer to Device.

7.1.6.5 Auto false echo suppression

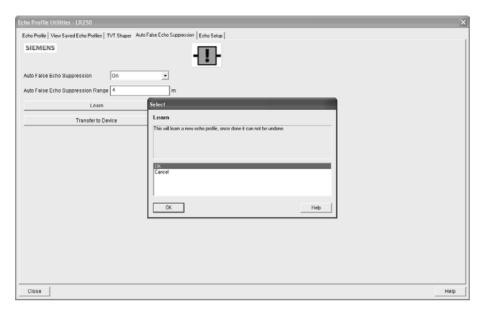
Note

- Ensure material level is below all known obstructions when using Auto False Echo
 Suppression to learn the echo profile. An empty or almost empty vessel is recommended.
- Note the distance to material level when learning the echo profile, and set Auto False Echo Suppression Range to a shorter distance to avoid the material echo being screened out.
- Set Auto False Echo Suppression and Auto False Echo Suppression Range during startup, if possible.
- If the vessel contains an agitator it should be running.
- Before adjusting these parameters, rotate the device for best signal (lower false-echo amplitude).

If you have a vessel with known obstructions, use Auto False Echo Suppression to prevent false echo detection. This feature can also be used if the device displays a false high level, or the reading is fluctuating between the correct level and a false high level.

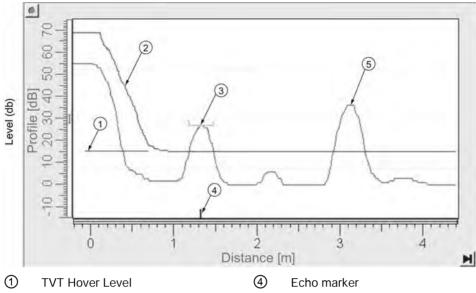
The device learns the echo profile over the whole measurement range and the TVT is shaped around all echoes present at that moment. See Auto False Echo Suppression (Page 253) for a more detailed explanation.

The learned TVT will be applied over a specified range. The default TVT is applied over the remainder of the measurement range.



- 1. Make sure the material level is below all known obstructions.
- 2. Determine **Auto False Echo Suppression Range**. Measure the actual distance from the sensor reference point to the material surface using a rope or tape measure. Subtract 0.5 m (20") from this distance, and use the resulting value.
- 3. Open the menu **Device Echo Profile Utilities** and click on the tab **Auto False Echo Suppression**.
- 4. Make sure Auto False Echo Suppression Range is On.
- 5. Enter the value for **Auto False Echo Suppression Range**.
- 6. Click Learn. The message appears: 'This will learn a new echo profile. Once done it cannot be undone'. Click OK.
- 7. Once Auto TVT is complete click **Transfer to Device**. To exit click **Close**. Auto TVT is enabled and the learned TVT will be used.
- 8. To turn **Auto False Echo Suppression** off or on, reopen the **Auto False Echo Suppression** window, change the Auto False Echo Suppression to **Off** or **On**, click on **Transfer to Device**.

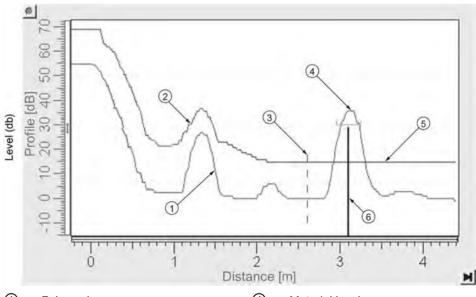
Before Auto False Echo Suppression



- 2 Default TVT
- 3 False echo

Material level

After Auto False Echo Suppression



1 False echo

4 Material level

2 Learned TVT

⑤ Default TVT

6

- 3 Auto False Echo Suppression Range
- Echo marker

7.1.6.6 Echo setup

 $\label{provides} \mbox{ Provides quick access to echo selection, filtering, and response rate parameters.}$

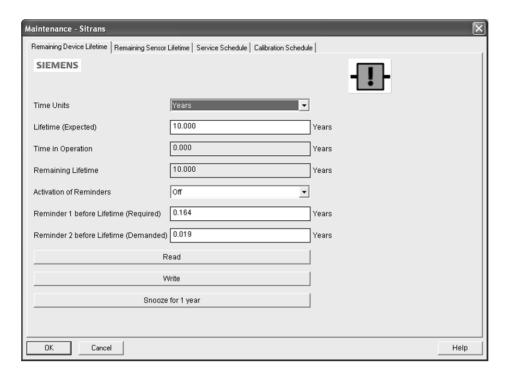
Open the menu Device – Echo Profile Utilities and click on Echo Setup.



7.1.6.7 Maintenance

You can set schedules and reminders for:

- device maintenance based on its projected lifetime
- sensor maintenance based on its projected lifetime
- service
- calibration



To set Device/Sensor Maintenance schedules:

- Open the menu Device Maintenance, and click on the Remaining Device/Sensor Lifetime tab.
- 2. Modify desired values, and if desired, set reminders for either or both of Reminder 1 before Lifetime (Required)/Reminder 2 before Lifetime (Demanded).
- 3. Click Write.
- 4. Click **Read**, to see the effects of your modification.
- 5. Click **Snooze** to add a year to the Total Expected Device Life.

To set Service/Calibration schedules:

- 1. Open the menu Device Maintenance, and click on the Service/Calibration Schedule tab.
- 2. Modify desired values and if desired, set reminders for either or both of **Reminder 1 before Lifetime (Required)/Reminder 2 before Lifetime (Demanded)**.
- 3. Click Write.
- 4. Click **Read**, to see the effects of your modification.
- 5. Click Service/Calibration Performed to reset the schedule.

7.1.6.8 Select analog output

Allows you to set the mA Output to report Level, Distance, Space, or Volume. See **Current Output Function (2.6.1.)** for an illustration.

If a volume application is selected, mA Output is automatically set to **Volume**. See Analog Output (Page 256) for more details.

- 1. Open the menu **Device Select Analog Output**.
- 2. **Select Analog Output** window displays the current setting: click **OK**.
- 3. Select a different setting and click **OK**.
- 4. Select Analog Output window displays the new setting: click OK.

7.1.6.9 Self test

Checks memory (RAM and Flash). If there are no errors, returns the message 'Self Test OK.' If errors are found, returns the message 'Self Test Fails'.

Open the menu **Device – Self Test**, select **Yes** and click **OK**.

7.1.6.10 Loop test

Note

The simulated AO (Analog Output) value influences output to the control system.

Allows you to input a simulated value (4 mA, 20 mA, or a user-defined value) in order to test the functioning of the mA connections during commissioning or maintenance of the device. The range is 3.56 mA to 22.6 mA, see mA Output Value (2.6.6.).

To simulate a user-defined mA value:

- 1. Open the menu **Device Loop Test**.
- 2. Select **Other**, enter the new value, and click on **OK**. The message 'Field Device fixed at [new value]' appears. Click on **OK**. The Loop Test window remains open.
- 3. When you are ready to end simulation, select **End** and click on **OK** to return the device to the actual output value.

7.1.6.11 Configuration flag reset

To reset the configuration flag to zero, open the menu **Device – Configuration Flag Reset** and perform a reset.

7.1.6.12 Master reset

Factory Defaults

Factory Defaults resets all parameters to the default settings with the following exceptions:

- **Device Address (5.1.)** remains unchanged if the reset command is sent remotely (via AMS, PDM, DTM, FC375) but is reset to 0 if the reset command is sent via LUI.
- Write Protect (6.2.1.) and PIN to Unlock (6.2.2.)
- Learned TVT curve, see Auto False Echo Suppression (2.8.7.1)
- 1. Open the menu **Device Master Reset**, select **Yes**, and click on **OK** to perform a reset to Factory Defaults.
- 2. After the reset is complete upload parameters to the PC/PG. (If you are performing a reset after replacing the device with a different instrument, do not upload parameters to the PC/PG).

7.1.6.13 Wear

Reports the number of hours the device has been operating, and the number of times it has been powered up.

Open the menu **Device - Wear** to view:

- Powered Days
- Power-on Resets

Note

Powered days are whole days only. Fractional days are truncated.

7.1.6.14 HART Communication

Sets the number of request/response preambles (default 5).

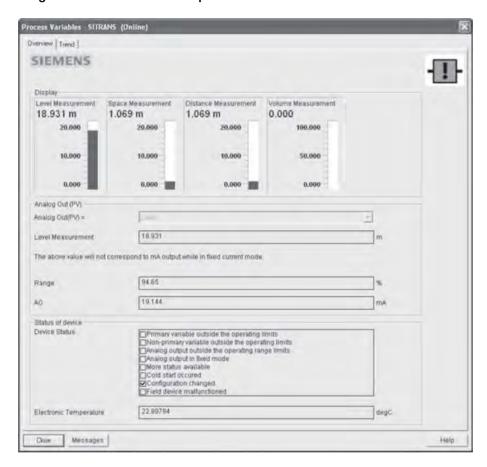
The preamble consists of three or more hexadecimal FF characters (all 1s). This allows the receiving modem to get its frequency-detection circuits synchronized to the signal after any pause in transmission.

We recommend you do not change the default value (5).

7.1.6.15 Process variables

To compare outputs in real time open the menu **View – Process Variables** and click on **Overview** to see reading (level, space, distance, volume); analog output; device status; and current electronics temperature.

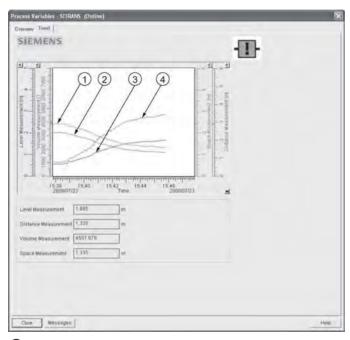
To see highest and lowest electronics temperatures, navigate to **Level Meter > Maintenance and Diagnostics > Electronics Temperature**.



7.1.6.16 Trend

Open the menu View – Process Variables and click on Trend.

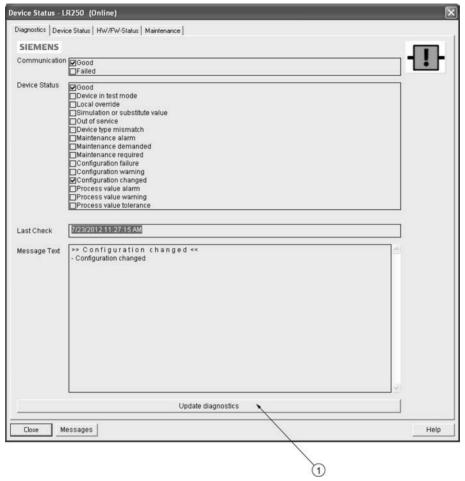
Four trend lines can be monitored (distinguished by color in SIMATIC PDM):



- Space
- ② Distance
- 3 Level
- 4 Volume

7.1.6.17 Device status

Open the menu **View – Device Status** to view Diagnostics, Device Status, Hardware/ Firmware (HW/FW) Status, and Maintenance status.



1 update diagnostics

In the Diagnostics window, click on **Update diagnostics** to update diagnostic information and refresh linked icons.

7.1.6.18 Update

Open the menu View - Update to refresh the screen.

7.1.6.19 Security

A password option protects security and communication control parameters from modification by a maintenance user.

When you open a project the **User** dialog window provides two options: maintenance or specialist. If a password has been set it will not be possible to open the project as a specialist without it. A maintenance user will be able to open the project without a password but will not have access to security and communication control parameters.

- 1. Open a project, double-click on the device icon, and in the **User** window select **Specialist**.
- 2. Open the menu **Options Settings** and click on the **Password** tab.
- 3. Enter a new password and re-enter it in the **Confirmation** window. Click on **OK**.



7.2 Operating via AMS Device Manager

7.2 Operating via AMS Device Manager

AMS Device Manager is a software package that monitors the process values, alarms and status signals of the device. Please consult the operating instructions or online help for details on using AMS Device Manager. You can find more information at:

Emerson (http://www.emersonprocess.com/AMS/)

Application Guides for setting up Siemens HART devices with AMS Device Manager are available on our website:

Process automation (www.siemens.com/processautomation)

7.2.1 Functions in AMS Device Manager

Note

While the device is in PROGRAM mode the output remains fixed and does not respond to changes in the device.

7.2.1.1 AMS function overview

AMS Device Manager monitors the process values, alarms and status signals of the device. It allows you to display, compare, adjust, verify, and simulate process device data.

Parameters organized into three main function groups allow you to configure and monitor the device:

- Configure/Setup
- Device Diagnostics (read only)
- Process Variables (read only)

See AMS Menu Structure (Page 117) for a chart and Changing parameter settings using AMS Device Manager (Page 107) for more details. The menu structure for AMS Device Manager is almost identical to that for the LCD.

7.2.1.2 Features of AMS Device Manager

The graphic interface in the radar device makes monitoring and adjustments easy.

Feature	Function	
Quick Start (Page 104)	Device configuration for simple applications	
Echo Profile (Page 111)	Echo profile viewing	
TVT (Page 111)	Screen out false echoes	
Linearization (Page 106)	Volume measurement in an irregular vessel	
Process Variables (Page 115)	Monitor process variables and level trend	
Security (Page 113)	Protect security and communication parameters from modification by the maintenance user	

7.2.1.3 Electronic Device Description (EDD)

The EDDs are linked to the type, version of configuration software, and protocol being used. Select the LR250 AMS EDD for the version of AMS installed. EDDs can be downloaded from our website, see Product page (http://www.siemens.com/LR250).

The HART EDD for LR250 is labeled as supporting AMS Device Manager version 9.5. This EDD is also operational with AMS version 9.0 and 10.1. There is also an application guide that details how to use the Hart Communication Foundation EDDs in AMS version 11.5 and above. There is no EDD for the LR250 for AMS version 10.5 to 11.1.

Please check the product page for updated EDDs and application guide.

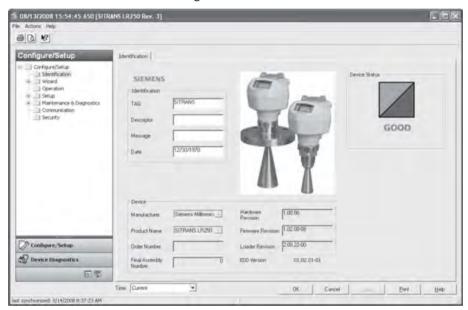
7.2.1.4 Configuring a new device

- Check our website to make sure you have the most recent EDD.
 Product page (http://www.siemens.com/LR250)
 Go to Support > Software Downloads and if necessary download it. Save the files to your computer, and extract the zipped file to an easily accessed location.
- 2. Launch AMS Device Manager– Add Device Type, browse to the unzipped EDD file and select it.

7.2 Operating via AMS Device Manager

7.2.1.5 Startup

- Launch AMS Device Manager. (Application Guides for setting up HART devices with AMS Device Manager can be downloaded from our website: Product page (http://www.siemens.com/LR250)
- 2. In **Device Connection View** right-click on the device icon and select **Scan Device** to upload parameters from the device.
- 3. Double click the device icon to open the startup screen. The startup screen shows device identification details, and a navigation window on the left-hand side of the screen.



Master reset

Note

Device Address (5.1.) remains unchanged if the reset command is sent remotely (via AMS, PDM, DTM, FC375) but is reset to 0 if the reset command is sent via LUI.

- Navigate to Configure/Setup > Operation
- In the General field click on Master Reset and accept the option Factory Defaults.

7.2.1.6 Pull-down menu access



Action menu items

A pull-down menu under **Actions** gives alternative access to several features.

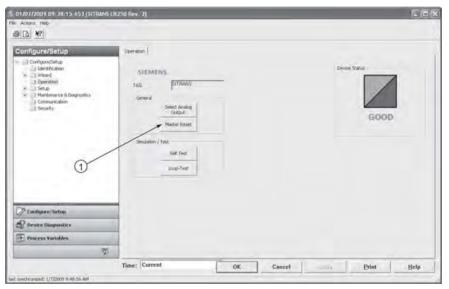
Scan Device

- Open the menu Actions Scan Device.
- Scan Device uploads parameters from the device (synchronizes parameters).

7.2 Operating via AMS Device Manager

7.2.1.7 Device configuration

- 1. Navigate to **Configure/Setup > Operation** and click to open the dialog window.
- 2. In the General field, click on Master Reset and perform a reset to Factory Defaults.
- 3. Open the pull-down menu **Actions Scan Device** to synchronize parameters (upload parameters from the device to AMS).
- 4. Configure the device via the Quick Start wizard.



Master reset

7.2.1.8 Quick Start Wizard via AMS Device Manager

Note

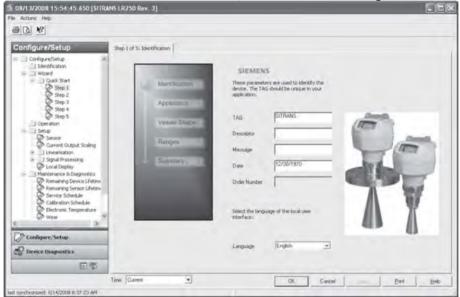
- A reset to Factory Defaults should be performed before running the Quick Start Wizard if device has been used in a previous application. See Master Reset (Page 102).
- The layout of the dialog boxes shown may vary according to the resolution setting for your computer monitor.
- At each step, you can accept the default values without modification and click on the next step to proceed.
- After modifying parameters click on Apply inside the Quick Start window to write the new values to the device.
- Click on OK only if you wish to update all parameters to the device and close AMS.

A Wizard provides an easy 5-step Quick Start procedure that configures the device for a simple application.

Quick Start

Step 1 - Identification

- 1. Navigate to Configure/Setup > Wizard > Quick Start.
- 2. Click on Step 1.
- 3. You can accept the default values without modification. (Description, Message, and Installation Date fields can be left blank.) If desired, make changes then click on **Apply**.



Step 2 - Application

- 1. Click on Step 2.
- 2. Select the application type (Level/vessel, Level/stillpipe, Level/bypass pipe, Volume/vessel, Volume/stillpipe, or Volume/bypass pipe) and the material (Liquid or Low dielectric liquid).
- 3. Click on Apply.

Step 3 - Vessel Shape

- 1. Click on Step 3.
- 2. Select a predefined vessel shape. To describe a more complex shape see Linearization (Page 106).
- 3. Click on Apply.

Step 4 - Ranges

- 1. Click on Step 4.
- 2. Change units if desired (in meters by default).
- 3. Set High and Low Calibration points.
- 4. To convert the reading from level to volume enter a value for Maximum Volume.
- 5. If a vessel shape with parabolic ends has been selected, set dimensions A and L.
- 6. Click on Apply.

Step 5 - Summary

Check parameter settings, and click on **Cancel** to abort, or **Apply** to transfer values to the device.

7.2 Operating via AMS Device Manager

Linearization

You can use the linearization feature to define a more complex vessel shape and enter up to 32 level breakpoints where the corresponding volume is known. The values corresponding to 100% and 0% levels must be entered. The breakpoints can be ordered from top to bottom, or the reverse.

Using linearization via the Quick Start wizard

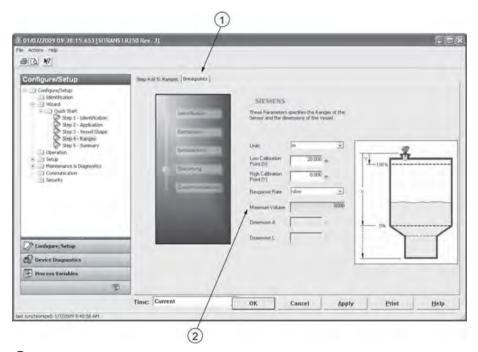
Navigate to Configure/Setup > Wizard > Quick Start.

In Step 1 – Identification, make any desired modifications and click on Apply.

In Step 2 – Application, select a level application and liquid as a material.

In Step 3 – Vessel Shape, choose the vessel shape option Linearization Table.

In Step 4 – Ranges, enter a value for maximum volume.



- ① Breakpoints
- 2 Maximum volume
- 1. Click on the **Breakpoints** tab and enter values for level and volume for up to **32** breakpoints.
- Navigate to Configure/Setup > Setup > Linearization and click on Characteristic to preview
 the characteristic curve of the vessel breakpoints. (The conversion will function correctly even
 if not all breakpoints are entered, but the curve will display correctly only if all breakpoints are
 entered.)
- 3. In **Step 5 Summary**, check parameter values. Click on the appropriate step menu to return and revise values, or click on a different menu to exit **Quick Start**.

Changing parameter settings using AMS Device Manager

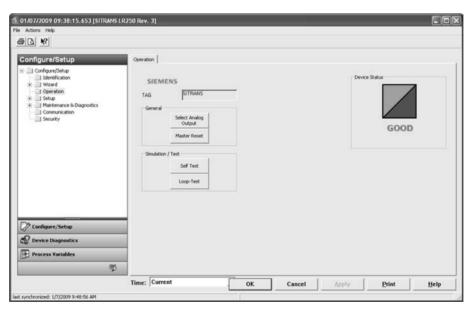
Note

For a complete list of parameters, see Parameter Reference (Page 123).

For more detailed explanations of the parameters listed below see the pages referenced.

- 1. Adjust parameter values in the parameter value field in Configure/Setup view, then click on **Apply** to write the new values to the device. The parameter field will display in yellow until the value has been written to the device.
- 2. Click on **OK** only if you wish to update all parameters and exit AMS.

Operation



Navigate to **Configure/Setup > Operation** and click on **Operation** to open the dialog window for access to:

General

- Select Analog Output [see Select Analog Output (Page 94)]
- Master Reset [see Master Reset (Page 95)]

Simulation/Test

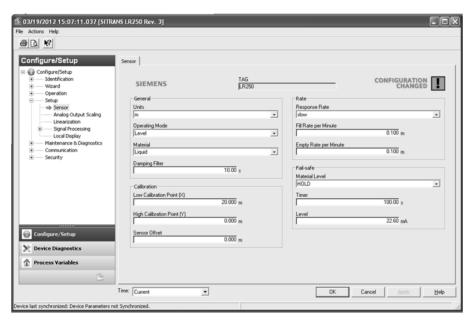
- Self Test [see Self Test (Page 94)]
- Loop Test [see Loop Test (Page 94)]

Setup

Note

For more detailed explanations of the parameters listed below see the pages referenced.

Sensor



Navigate to Configure/Setup > Setup and click on Sensor for access to:

General [see Sensor (2.2.)]

- Units
- Operating Mode
- Material
- Damping Filter

Calibration [see Calibration (2.3.)]

- Low Calibration Point
- High Calibration Point
- Sensor Offset

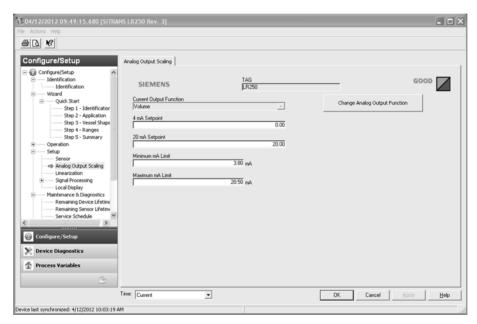
Rate [see Rate (2.4.)]

- Response Rate
- Fill Rate per Minute
- Empty Rate per Minute

Fail-safe [see Fail-safe (2.5.)]

- Material level
- Timer
- Level

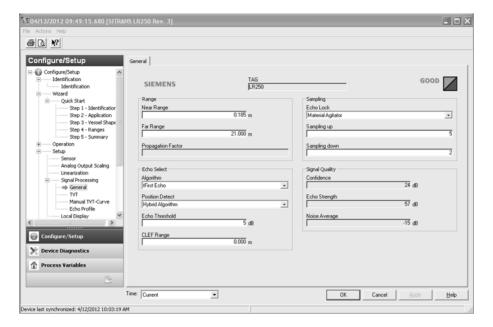
Analog Output Scale



Navigate to **Configure/Setup > Setup** and click on **Analog Output Scaling** for access to: Analog Output Scaling [see **Analog Output Scaling (2.6.)**]

- Current Output Function
- 4 mA Setpoint
- 20 mA Setpoint
- Minimum mA Limit
- Maximum mA Limit

Signal Processing



General

Navigate to Configure/Setup > Setup > Signal Processing and click on General for access to:

Range [see Signal Processing (2.8.)]

- Near Range
- Far Range
- Propagation Factor

Echo Select [see Echo Select (2.8.4.)]

- Algorithm
- Position Detect
- Echo Threshold
- CLEF Range

Sampling [see Sampling (2.8.5.)]

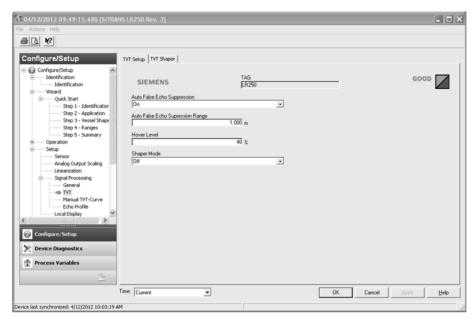
- Echo Lock
- Sampling Up
- Sampling Down

Signal Quality

- Confidence
- Echo Strength
- Noise Average

TVT

Modify the TVT to screen out false echoes. See Auto False Echo Suppression (2.8.7.1.) (Page 253).



Navigate to **Configure/Setup > Setup > Signal Processing** and click on **TVT**. Click on one of the two tabs to access the parameters listed:

TVT Setup [see TVT setup (2.8.7.)]

- Auto False Echo Suppression
- Auto False Echo Suppression Range
- Hover Level
- Shaper Mode

TVT Shaper

• Shaper breakpoints 1 to 40. (Turn TVT Setup/Shaper Mode on to activate.)

Manual TVT Curve

Displays the effects of the TVT shaper modifications. Navigate to **Configure/Setup > Setup > Signal Processing** and click on **Manual TVT Curve**.

Echo Profile

- Navigate to Configure/Setup > Setup > Signal Processing and click on Echo Profile.
- Select **Standard** operation for faster display.

Local Display

Navigate to Configure/Setup > Setup > Local Display for access to:

- Language
- LCD Fast Mode [see LCD Fast Mode (4.9.)]
- LCD Contrast [see LCD Contrast (4.10.)]

7.2.2 Maintenance and diagnostics

Navigate to Maintenance and Diagnostics for access to:

Remaining Device Lifetime [see Remaining Device Lifetime (4.2.)]

- Lifetime (expected)
- Time in Operation
- Remaining Lifetime
- Activation of Reminders
- Reminder 1 before Lifetime (Required)
- Reminder 2 before Lifetime (Demanded)

Remaining Sensor Lifetime [see Remaining Sensor Lifetime (4.3.)]

- Lifetime (expected)
- Time in Operation
- Remaining Lifetime
- Activation of Reminders
- Reminder 1 before Lifetime (Required)
- Reminder 2 before Lifetime (Demanded)

Service Schedule [see Service Schedule (4.4.)]

- Service Interval
- Time Since Last Service
- Time Until Next Service
- Activation of Reminders
- Reminder 1 before Service (Required)
- Reminder 2 before Service (Demanded)

Calibration Schedule [see Calibration Schedule (4.5.)]

- Calibration Interval
- Time Since Last Calibration
- Time Until Next Calibration
- Activation of Reminders
- Reminder 1 before Calibration (Required)
- Reminder 2 before Calibration (Demanded)

Electronic Temperature

- Electronic Temperature
- Lowest Value
- Highest Value

Wear

- Powered Days
- Poweron Resets

See Wear via SIMATIC PDM (Page 95) for more detail.

7.2.3 Communication

Navigate to Communication to read the following:

Tag; Manufacturer's ID; Device ID; Product ID; Device Revision; EDD Revision; Universal Command Revision

7.2.4 Security

Navigate to Configure/Setup > Security to access:

Remote Access [see Remote Access (6.1.)]

Note

If access control is changed to limit remote access, it can only be reset via the handheld programmer. See **Access Control (6.1.1.)**.

- Write Protect (read only)
- Access Control

Local Access [see Local Access (6.2.)]

- Local Write Protected
- PIN to Unlock

See also Password Protection (Page 115).

7.2.5 Device Diagnostics

Click on the **Device Diagnostics** bar at the bottom of the navigation window, for access to:

Device Status

Hardware/Firmware Status

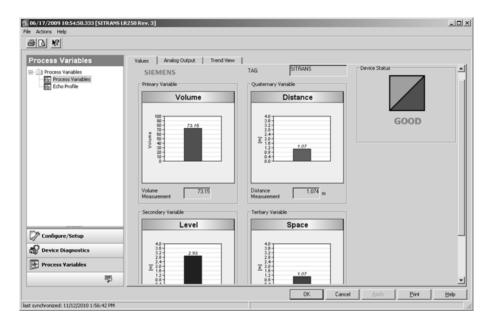


7.2.5.1 Process variables

To compare outputs in real time click on **Process Variables** at the bottom of the navigation window for access to:

Process Variables

- Values (level, volume, space, distance)
- Analog Output
- Trend View



Echo Profile

7.2.5.2 Password protection

An AMS Device Manager administrator can configure the user to require a password. The use of passwords is recommended. A password should be assigned to the 'admin' username immediately after installing AMS Device Manager.

Each user is given an AMS Device Manager username and password and required to enter them when they start AMS Device Manager. Access to functions depends on the level of permissions granted.

Login types

standard, local, or domain

A standard user can change their password in AMS Device Manager. A Local or Domain Windows user cannot change their password using AMS Device Manager and must request their network administrator to do so.

7.2.5.3 User Manager utility

Usernames, passwords, and permissions, are assigned to users by an AMS Device Manager administrator, using the User Manager utility on the Server Plus Station. Only a user with AMS Device Manager System Administration rights can log in to User Manager.

To configure a new user/edit existing user:

- 1. From the Windows taskbar select: **Start > AMS Device Manager > User Manager**.
- 2. In the User Manager window click on Add User.

The Add User Wizard dialog allows you to:

- select a user type, standard (AMS Device Manager) or Window user.
- enter the username and password, and set permissions
- edit existing users



7.2.6 AMS menu structure

```
Configure/Setup
       Identification
              Identification
                         Identification
                                 Tag
Descriptor
                                 Message
                                 Date
                         Device
                                 Manufacturer
                                 Product Name
Order Number
                                 Final Assembly Number
Hardware Revision
                                 Firmware Revision
                                 Loader Revision
                                 EDD version
                         Device Status
      -Wizard
              Quick Start
                         Start
Step 1 (Identification)
Step 2 (Application)
Step 3 (Vessel Shape)
Step 4 (Ranges)
Step 5 (Summary)
       Operation
              Operation
                        General
                                 Select Analog Output
                        Master Reset
Simulation/Test
                                  Self Test
                                  Loop Test
                        Device Status
       Setup
              Sensor
                         Sensor
                                 Tag
                                 General
Units
                                          Operating Mode
                                          Material
Damping Filter
                                 Calibration
Low Calibration Point
High Calibration Point
Sensor Offset
```

```
Configure/Setup (continued)
     Setup/Sensor (continued)
                                 Response Rate
                                Fill Rate per Minute
                                Empty Rate per Minute
                         Fail-safe
                                Material Level
                                Timer
                                Level
                         Device Status
           Analog Output Scaling
                   Analog Output Scaling
                         Tag
Current Output Function
                         4 mA Setpoint
                         20 mA Setpoint
                         Minimum mA Limit
                         Maximum mA Limit
                         Device Status
         Linearization
                  Vessel Shape
                         Tag
                         Vessel Shape
                                 Vessel Shape
                         Vessel Dimensions
                                Maximum Volume
                                 Dimension A
                                Dimension L
                         Device Status
                  Breakpoints
                         Tag
                         Levels and Volume breakpoints
                         Device status
Vessel Shape
    Signal Processing
          General
                  General
                        Tag
                        Range
                               Near Range
Far Range
Propogation Factor
                         Echo Select
                                Algorithm
                                Position Detect
                                Echo Threshold
                         CLEF Range
Sampling
Echo Lock
                               Sampling Up
Sampling Down
                         Signal Quality
                                Confidence
                                Echo Strength
                                Noise average
                         Device Status
```

```
Configure/Setup (continued)
     Signal Processing (continued)
                  TVT Setup
                        Tag
                        Auto False Echo Suppression
                        Auto False Echo Suppression Range
                        Hover Level
                        Shaper Mode
Device Status
                  TVT Shaper
                        Tag
                        Breakpoints
                        Device Status
                        Shaper Mode
          Manual TVT Curve
                 Manual TVT diagram
                        Tag
                        Shaper Mode
          Echo Profile
                  Echo Profile
                        Tag
                        Device Status
                 Echo Profile Parameters
                        Level Measurement
                        Distance Measurement
                        Confidence
                        Near Range
     Local Display
          Local Display
                 Tag
                 Language
                 LCD Fast Mode
LCD Contrast
                 Device Status
Maintenance and Diagnostics
     Remaining Device Lifetime
          Device Lifetime
                   Tag
                   Lifetime (expected)
                   Time in Operation
                  Remaining Lifetime
Activation of Reminders
                   Reminder 1 before Lifetime (Required)
                  Reminder 2 before Lifetime (Demanded)
                  Device Status
     Remaining Sensor Lifetime
          Sensor Lifetime
                  Tag
Lifetime (expected)
                  Time in Operation
Remaining Lifetime
                  Activation of Reminders
                  Reminder 1 before Lifetime (Required)
                  Reminder 2 before Lifetime (Demanded)
                  Device Status
```

```
Maintenance and Diagnostics (continued)
     Service Schedule
          Service Schedule
                  Tag
                  Service interval
                  Time Since Last Service
                  Time Until Next Service
                  Activation of Reminders
                  Reminder 1 before Service (Required)
                  Reminder 2 before Service (Demanded)
                  Device Status
     Calibration Schedule
          Calibration Schedule
                  Tag
Calibration Interval
                  Time Since Last Calibration
                  Time Until Next Calibration
                  Activation of Reminders
                  Reminder 1 before Calibration (Required)
                  Reminder 2 before Calibration (Demanded)
                  Device Status
    Electronic Temperature
          Electronic Temperature
                  Tag
Electronic Temperature
                  Lowest Value
Highest Value
Device Status
     Wear
          Wear
                   Tag
                  Powered Days
Poweron Resets
Device Status
Communication
     Communication
          Communication
                   Tag
                   Manufacturer's ID
                   Device ID
Product ID
                   Device Revision
                   EDD Revision
                   Universal Command Revision
                   Device Status
Security
     Security
          Remote Access
                   Write Protect
                   Access Control
          Remote Access
                  Local Write Protected
                  PIN to Unlock
          Device Status
```

7.3 Operating via FDT (Field Device Tool)

FDT is a standard used in several software packages designed to commission and maintain field devices. Two commercially available FDTs are PACTware and Fieldcare.

Functionally FDT is very similar to PDM. See Operating via SIMATIC PDM (Page 75) for more detail.

- To configure a field device via FDT you need the DTM (Device Type Manager) for the device.
- To configure a field device via SIMATIC PDM, you need the EDD (Electronic Data Description) for the device.

7.3.1 Device Type Manager (DTM)

A DTM is a type of software that 'plugs into' FDT. It contains the same information as an EDD but an EDD is independent of the operating system.

7.3.2 SITRANS DTM

- SITRANS DTM is an EDDL interpreter developed by Siemens to interpret the EDD for that device.
- To use SITRANS DTM to connect to a device, you must first install SITRANS DTM on your system and then install the device EDD written for SITRANS DTM.
- You can download SITRANS DTM from the Siemens service and support website. Go to Service & Support (http://www.siemens.com/automation/service&support), click on Product Support, and drill down to Product Information/Automation Technology/Sensor systems/Process Instrumentation/Software & Communications.

7.3 Operating via FDT (Field Device Tool)

7.3.3 The device EDD

The SITRANS LR250 HART EDD for SITRANS DTM can be downloaded from our website:

Product page (http://www.siemens.com/LR250).

Go to Support > Software Downloads.



7.3.4 Configuring a new device via FDT

The full process to configure a field device via FDT is outlined in an Application Guide which can be downloaded from our website under **Support > Application Guides**.

Product page (http://www.siemens.com/LR250)

Parameter reference 8

Note

- Parameter names and menu structure are almost identical for SIMATIC PDM and the local user interface (LUI).
- Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.
- Mode toggles between PROGRAM and Measurement Modes.
- For Quick Access to parameters via the handheld programmer, press **Home** , then enter the menu number, for example: **2.2.1**.
- In Navigation mode, **ARROW keys** () navigate the menu in the direction of the arrow.
- Press RIGHT arrow to open Edit Mode, or to save a modification.

Parameters are identified by name and organized into function groups. See LCD menu structure (Page 285) for a chart. For AMS Device Manager the structure varies slightly.

Parameters accessible via the handheld programmer are followed by the device menu number in parenthesis. Parameters not followed by a number are accessible only via remote operation.

For more details see:

- Operating via SIMATIC PDM (Page 75)
- Operating via AMS Device Manager (Page 100)

Quick Start (1.)

Wizards provide step-by-step procedures to configure the device, filter out false echoes, and upload and download parameters and firmware to the optional display for easy configuration of multiple devices.

Operating Instructions, 08/2014, A5E32220602-AC

Quick Start Wizard (1.1.)

From measurement screen, press **RIGHT arrow** twice to open the Quick Start Wizard menu. Select a wizard, press **RIGHT arrow** to open the first step, and follow the instructions.

Note

Do not use the Quick Start Wizard to modify individual parameters. (Perform customization only after the Quick Start has been completed.)

- See Quick Start Wizard via the handheld programmer (Page 62).
- See Quick Start Wizard via SIMATIC PDM (Page 75).
- See Quick Start Wizard via AMS Device Manager (Page 104).

Setup (2.)

Note

Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.

Device (2.1.)

Hardware Revision (2.1.1.)

Corresponds to the electronics hardware of the SITRANS LR250.

Firmware Revision (2.1.2.)

Corresponds to the firmware that is embedded in the SITRANS LR250.

Loader Revision (2.1.3.)

Corresponds to the software used to update the SITRANS LR250.

Order Option (2.1.4.)

Read only. Displays the device type: standard or NAMUR NE 43-compliant.

Menu Timeout (2.1.5.)

Time menu stays visible before switching back to Measurement view if no key is pressed.

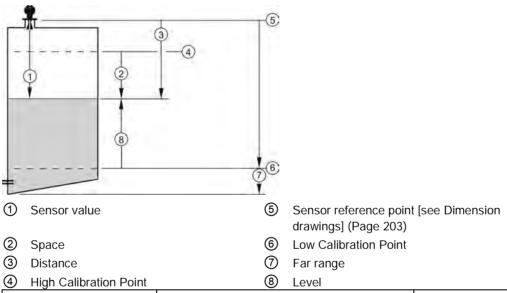
Sensor (2.2.)

Units (2.2.1.)

PV (Primary Value) and SV (Secondary Sensor measurement units). Used in setting High/Low Calibration Point, and displayed on LCD and in PDM.

Values	m, cm, mm, ft, in
	Default: m

Sensor Mode (2.2.2.)



Mode		Description	Reference point	
NO SERVICE		Measurement and associated loop current are not updated, and the device defaults to Failsafe mode a).	n/a	
LEVEL	*	Distance to material surface	Low Calibration Point (process empty level)	
SPACE		Distance to material surface	High Calibration Point (process full level)	
DISTANCE		Distance to material surface	Sensor reference point	

a) See Material Level (2.5.1.) for more detail.

Material (2.2.3.)

Automatically configures the device to operate in the chosen application type, by changing one or more of the following parameters: **Propagation Factor (2.8.3.)**, **Position Detect (2.8.4.2.)**, and/or **CLEF Range (2.8.4.4.)**.

Options	* LIQUID		
		LIQUID LOW DK a) (low dielectric liquid - CLEF algorithm enabled)	
Related parameters	Propagation Factor (2.8.3.)		
	Position Detect (2.8.4.2.)		
	CLEF Range (2.8.4.4.)		

a) dK < 3.0

You can configure each of the related parameters to suit your particular application.

Damping Filter (2.2.4.)

The time constant for the damping filter. The damping filter smooths out the response to a sudden change in level. This is an exponential filter and the engineering unit is always in seconds [see Damping (Page 256) for more detail].

Values	Range: 0 to 100.000 s
	Default: 10.000 s

Calibration (2.3.)

Note

We recommend using the Quick Start wizard to configure the device.

Low Calibration Pt. (2.3.1.)

Distance from sensor reference point¹⁾ to Low Calibration Point. Units are defined in **Units** (2.2.1.)

Values Range: 0 to 20 m. Default: 20.00 m			
Related parameters	Units (2.2.1.)		
Far Range (2.8.2.)			

¹⁾ The point from which level measurement is referenced, see Threaded Horn Antenna with extension (Page 203), Flanged Horn with extension (Page 208), and Flanged encapsulated antenna (3"/DN80/80A sizes and larger) (Page 214).

High Calibration Pt. (2.3.2.)

Distance from sensor reference point ¹⁾ to High Calibration Point. Units are defined in **Units** (2.2.1.).

Values	Range: 0 to 20 m. Default 0.00 m
Related parameters	Units (2.2.1.)
-	Near Range (2.8.1.)

When setting the High Calibration Point value, note that echoes are ignored within **Near Range** (2.8.1.).

Sensor Offset (2.3.3.)

A constant offset that can be added to or subtracted from the sensor value¹⁾ to compensate for a shifted sensor reference point. (For example, when adding a thicker gasket or reducing the standoff/nozzle height.) The units are defined in **Units (2.2.1.)**.

Values	Range: -100 to 100 m. Default: 0.00 m
Related parameters	Units (2.2.1.)

¹⁾ The value produced by the echo processing which represents the distance from sensor reference point to the target, see **Sensor Mode (2.2.2.)**.

¹⁾ The value produced by the echo processing which represents the distance from sensor reference point to the target. [see Threaded Horn Antenna with extension (Page 203), Flanged Horn with extension (Page 208), and Flanged encapsulated antenna (3"/DN80/80A sizes and larger) (Page 214)].

Rate (2.4.)

Response Rate (2.4.1.)

Note

Changing Response Rate resets Fill Rate per Minute (2.4.2.), Empty Rate per Minute (2.4.3.), and Damping Filter (2.2.4.).

Sets the reaction speed of the device to measurement changes.

Response Rate (2.4.1.)		Fill Rate per Minute Empty Rate per Minute (2.4.3.)		Damping Filter (2.2.4.)
*	Slow	0.1 m/min (0.32 ft/min)		10 s
	Medium	1.0 m/min (3.28 ft/min)		10 s
	Fast	10.0 m/min (32.8 ft/mir	n)	0 s

Use a setting just faster than the maximum filling or emptying rate (whichever is faster).

Fill Rate per Minute (2.4.2.)

Defines the maximum rate at which the reported sensor value is allowed to decrease. Allows you to adjust the SITRANS LR250 response to decreases in the actual material level. Fill Rate is automatically updated whenever Response Rate is altered.

Options	Ra	Range: 0 to 99999 m / min.		
	Re	sponse Rate (2.4.1.)	Fill Rate per Minute (2.4.2.)	
	*	Slow	0.1 m/min (0.32 ft/min)	
		Medium	1.0 m/min (3.28 ft/min)	
		Fast	10.0 m/min (32.8 ft/min)	
Altered by:	Response Rate (2.4.1.)			
Related parameters	Units (2.2.1.)			

Enter a value slightly greater than the maximum vessel-filling rate, in units per minute.

Sensor value is the value produced by the echo processing which represents the distance from sensor reference point to the target. See **Sensor Mode (2.2.2.)** for an illustration.

Empty Rate per Minute (2.4.3.)

Defines the maximum rate at which the reported sensor value is allowed to increase. Adjusts the SITRANS LR250 response to increases in the actual material level. Empty Rate is automatically updated whenever Response Rate is altered.

Options	Range: 0 to 99999 m / min.			
	Response Rate (2.4.1.)		Empty Rate per Minute (2.4.3.)	
	*	Slow	0.1 m/min (0.32 ft/min)	
		Medium	1.0 m/min (3.28 ft/min)	
		Fast	10.0 m/min (32.8 ft/min)	
Altered by:	Response Rate (2.4.1.)			
Related parameters	Units (2.2.1.)			

Enter a value slightly greater than the vessel's maximum emptying rate, in units per minute.

Sensor value is the value produced by the echo processing which represents the distance from sensor reference point to the target. See **Sensor Mode (2.2.2.)** for an illustration.

Fail-safe (2.5.)

Note

Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.

Material Level (2.5.1.)

Note

The default setting depends whether your device is a standard or NAMUR NE 43-compliant device.

Defines the mA output to use when the Fail-safe timer expires.

STANDARD DEVICE					
Options		HI 20.5 mA (max. mA Limit)			
		LO	3.8 mA (min. mA Limit)		
	*	HOLD	Last valid reading (default 22.6 mA)		
		VALUE	User-selected value [defined in Fail-Safe mA Value (2.5.3.)]		

NAMUR NE 43-COMPLIANT DEVICE ¹⁾			
Options		HI	20.5 mA (max. mA Limit)
		LO	3.8 mA (min. mA Limit)
		HOLD	Last valid reading
	*	VALUE	User-selected value [defined in Fall-Safe mA Value (2.5.3.) : default 3.58 mA]

¹⁾ Orderable option

LOE Timer (2.5.2.)

Note

When a Loss of Echo occurs **Material Level (2.5.1.)** determines the material level to be reported when the Fail-safe timer expires. See Loss of Echo (LOE) (Page 258) for more detail.

Sets the time to elapse since the last valid reading, before the Fail-safe Level is reported.

Values	Range: 0.00 to 7200 seconds	
	Default: 100 s	

Fail-Safe mA Value (2.5.3.)

Note

- The default settings are dependent on standard or NAMUR NE 43-compliant device.
- Material Level (2.5.1.) must be set to VALUE to enable the Fail-Safe mA Value to be reported.

Allows the user to define the mA value to be reported when the Fail-safe timer expires.

Device Type		STANDARD	NAMUR NE43- COMPLIANT
Values	Range	3.56 mA to 22.6 mA	
	Default	22.60 mA	3.58 mA

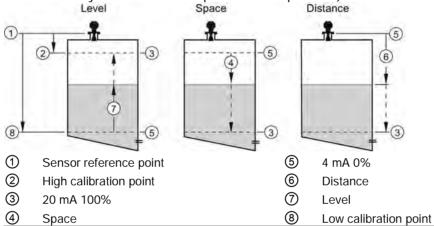
Analog Output Scaling (2.6.)

Current Output Function (2.6.1.)

Note

- Level, space, and distance, have different reference points.
- Use caution when changing Current Output Function while the device is connected to a HART network. Current Output Function controls the primary value and the loop current for the device.
- Current Output Function also affects the secondary, tertiary and quaternary variables in a HART network.

Can be set to either **Level**, **Space**, **Distance**, or **Volume**. (The device can carry out a volume calculation only after a vessel shape has been specified.)



Options Reference point Description		Description		
*	Level	Low Calibration Point	measured as a percentage of the	
	Space	High Calibration Point	difference between High Calibration Point and Low Calibration Point	
	Distance	Sensor reference point	measured as a percentage of Low Calibration Point	
	Volume	converts a level measurement to a volume output		
	Manual a)	allows mA Output Value (2.6.6.) to be set to a user-defined value		
	(LUI only)			

Current Output Function must be set to **Manual** before modifying **mA Output Value (2.6.6.).**Remember to restore the previous Current Output Function setting after modifying mA Output Value.

To view the mA reading in the secondary region of the LCD, press on the handheld programmer.

To modify Current Output Function via SIMATIC PDM:

• Open the menu **Device – Select Analog Output**. See Select Analog Output via SIMATIC PDM (Page 94) for more detail.

4 mA Setpoint (2.6.2.)

Sets the process level corresponding to the 4 mA value. 4 mA always defaults to 0, and Current Output Function (2.6.1.) determines whether this is a Level, Space, Distance, or Volume measurement. (See Current Output Function (2.6.1.) for an illustration.)

Values	Range: -999999 to +999999 (limits vary with current function and units)	
	Default: 0.00 m (set to value corresponding to 0% as defined by Current Output Function)	
Related Parameters	Units (2.2.1.)	
	Current Output Function (2.6.1.)	

- Enter the reading that is to correspond to a 4 mA output.
- Units are defined in Units (2.2.1.) for Level, Space, or Distance. Units are unspecified for Volume.

20 mA Setpoint (2.6.3.)

Sets the process level corresponding to the 20 mA value. 20 mA always defaults to 100%, and Current Output Function (2.6.1.) determines whether this is a Level, Space, or Distance measurement. (See Current Output Function (2.6.1.) for an illustration.)

Values	Range: -999999 to +999999 (limits vary with current function and units)		
	Default: 20.00 m (set to value corresponding to 100% as defined by Current		
	Output Function)		
Related Parameters	Units (2.2.1.)		
	Current Output Function (2.6.1.)		

- Enter the reading that is to correspond to a 20 mA output.
- Units are defined in Units (2.2.1.) for Level, Space, or Distance. Units are unspecified for Volume.

Minimum mA limit (2.6.4.)

Prevents the mA output from dropping below this minimum level for a measurement value. This does not restrict the Fail-safe or Manual settings.

Values	Range: 3.8 to 20.5 (mA)
	Default: 3.8 (mA)

Maximum mA limit (2.6.5.)

Prevents the mA output from rising above this maximum level for a measurement value. This does not restrict the Fail-safe or Manual settings.

Values	Range: 3.8 to 20.50 (mA)
	Default: 20.50 (mA)

mA Output Value (2.6.6.)

Allows you to use a simulated value to test the functioning of the loop. You can enter 4 mA, 20 mA, or any other user-defined value within the range.

Values	Range: 3.56 mA to 22.6 mA
	Read Only unless Current Output Function (2.6.1.) is set to Manual.
Related parameter	Current Output Function (2.6.1.)

- 1. First set Current Output Function (2.6.1.) to Manual.
- 2. Enter the desired mA value in mA Output Value.
- 3. After completing the test, remember to reset **Current Output Function (2.6.1.)** to the previous setting.

Via SIMATIC PDM:

Open the menu Device – Loop Test. For more detail, see Loop Test (Page 94).

Linearization (2.7.)

Volume (2.7.1.)

Carries out a volume conversion from a level value.

Vessel Shape (2.7.1.1.)

Defines the vessel shape and allows the LR250 to calculate volume instead of level. If **None** is selected, no volume conversion is performed. Select the vessel shape matching the monitored vessel or reservoir.

	Vessel Shape	LCD DISPLAY/ Description	Also required
*	None	NONE/ No volume calculation required	N/A
		CYLINDER/ Flat end horizontal cylinder	Maximum volume
		SPHERE/ Sphere	Maximum volume
		LINEAR/ Upright, linear (flat bottom)	Maximum volume
	A A	CONICAL BOT/ Conical or pyramidal bottom	Maximum volume, dimension A
	A	PARABOLIC BOT/Parabolic bottom	Maximum volume, dimension A
	A A	HALF SPHERE BOT/ Half-sphere bottom	Maximum volume, dimension A

Vessel Shape	LCD DISPLAY/ Description	Also required
A A	FLAT SLOPED BOT/ Flat sloped bottom	Maximum volume, dimension A
A	PARABOLIC ENDS/ Parabolic end horizontal cylinder	Maximum volume, dimension A, dimension L
	LINEAR TABLE ^{a)} / Linearization table (level/volume breakpoints)	Maximum volume, tables 1-32 level and volume breakpoints

a) Linearization Table must be selected in order for level/volume values [see **Table 1-8 (2.7.2.)**] to be transferred.

Maximum Volume (2.7.1.2.)

The maximum volume of the vessel. Enter the vessel volume corresponding to High Calibration Point. For example, if your maximum vessel volume is 8000 L, enter a value of 8000. Volume units are defined by the user but are not explicitly stated or shown in the SITRANS LR250.

Values	Range: 0.0 to 99999 m	
	Default: 100.0	
Related Parameters	Low Calibration Pt. (2.3.1.)	
	High Calibration Pt. (2.3.2.)	
	Vessel Shape (2.7.1.1.)	

Vessel Dimension A (2.7.1.3.)

The height of the vessel bottom when the bottom is conical, pyramidal, parabolic, spherical, or flat -sloped. If the vessel is horizontal with parabolic ends, the depth of the end. See **Vessel Shape (2.7.1.1.)** for an illustration.

Values	Range: 0.0 to 99.999 m	
	Default: 0.0	
Related Parameters	Units (2.2.1.)	
	Vessel Shape (2.7.1.1.)	

Vessel Dimension L (2.7.1.4.)

Length of the cylindrical section of a horizontal parabolic end vessel. See **Vessel Shape** (2.7.1.1.) for an illustration.

Values	Range: 0.0 to 99.99 m	
	Default: 0.0	
Related Parameters	Units (2.2.1.)	
	Vessel Shape (2.7.1.1.)	

Table 1-8 (2.7.2.)

Note

Linearization Table must be selected in **Vessel Shape (2.7.1.1.)** in order for level/volume values to be transferred.

If your vessel shape is more complex than any of the preconfigured shapes, you can define the shape as a series of segments. A value is assigned to each level breakpoint and a corresponding value is assigned to each volume breakpoint. Level values are defined in **Units** (2.2.1.). Volume units are defined by the user but are not explicitly stated in the SITRANS LR250.

Level Values	Range: 0.0 to span		
	Span = High Calibration Pt. (2.3.2.) - Low Calibration Pt. (2.3.1.)		
	Default: 0.0		
Volume Values	Range: 0.0 to Maximum Volume (2.7.1.2.)		
	Default: 0.0		

Enter up to 32 level breakpoints, where the corresponding volume is known. The values corresponding to 100% and 0% levels must be entered. The breakpoints can be ordered from top to bottom, or the reverse.

Breakpoints are grouped into four tables: Table 1-8, Table 9-16, Table 17-24, and Table 25-32.

Entering breakpoints via the handheld programmer:

- 1. The default unit for level values is **m**: to change it navigate to **Setup (2.) > Sensor (2.2.) > Units(2.2.1.)**, and select the desired unit.
- Navigate to Setup (2.) > Linearization (2.7.) > Maximum Volume (2.7.1.2.), and enter the value.
- 3. Go to the appropriate table for the particular breakpoint you wish to adjust: for example, go to Table 1-8 for breakpoint 1.
- 4. Under Table 1-8, go to Level 1 (2.7.2.1.) to enter the level value for the breakpoint 1.
- 5. Under Table 1-8, go to Volume 1 (2.7.2.2.) to enter the volume value for the breakpoint 1.
- 6. Repeat steps 3 to 5, until values have been entered for all required breakpoints.

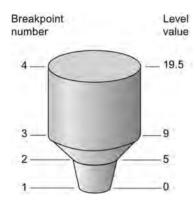
Level 1 (2.7.2.1.)

- 1. Press **RIGHT arrow** to open Edit mode.
- 2. Enter level value and press RIGHT arrow to except it.
- 3. Press **DOWN arrow** to move to corresponding volume breakpoint.

Volume 1 (2.7.2.2.)

- 1. Press **RIGHT arrow** to open Edit mode.
- 2. Enter volume value and press RIGHT arrow to accept it.
- 3. Press **DOWN arrow** to move to next level breakpoint.

Example (values are for example purposes only)



Breakpoint Number	Level value (m)	Volume value (I)
1	0	0
2	5	500
3	9	3000
4	19.5	8000

Table 9-16 (2.7.3.)

Table 17-24 (2.7.4.)

Table 25-32 (2.7.5.)

Signal Processing (2.8.)

Note

Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.

Near Range (2.8.1.)

The range in front of the device (measured from the sensor reference point) within which any echoes will be ignored. This is sometimes referred to as blanking or a dead zone. The factory setting is 50 mm (2") past the end of the antenna, and the default is dependent on the antenna type and process connection. [See Dimension drawings (Page 203) for antenna heights.]

Values	Range: 0 to 20 m (0 to 65.6 ft)
	Default depends on antenna type and process connection:
Related parameters	Units (2.2.1.)

Far Range (2.8.2.)

Note

Far Range can extend beyond the bottom of the vessel.

Allows the material level to drop below Low Calibration Point without generating a Loss of Echo (LOE) state. See **Sensor Mode (2.2.2.)** for an illustration.

Values	Range: Min. = Low Calibration Pt.
	Max. = 23 m (75.45 ft)
	Default: Value for Low Calibration Pt. + 1 m (3.28 ft)
Related parameters	Units (2.2.1.)

Use this feature if the measured surface can drop below the Low Cal. Point in normal operation.

Propogation Factor (2.8.3.)

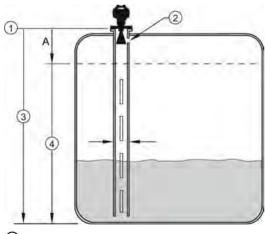
Note

- When operating in a stillpipe, values for **CLEF Range (2.8.4.4.)**, and for the propagation factor, should be set according to the pipe size. See the table below.
- For reliable results the antenna size must be close to the pipe size.

Compensates for the change in microwave velocity due to propagation within a metal stillpipe instead of in free space.

instead of in free space.				
Values	Range	0.3 to 1.0 depe	ending on pipe size	
	Default	1.0000		
Nominal Pipe Size a)	40 mm (1.5")	50 mm (2")	80 mm (3")	100 mm (4")
Propagation Factor	0.9844	0.988	0.9935	0.9965
CLEF Range (2.8.4.4.) settings	Low calibration point - 700 mm (2.29 ft) ^{b)}	Low calibration point - 700 mm (2.29 ft) ^{b)}	Low calibration point -1000 mm (3.28 ft) ^{b)}	Low calibration point -1000 mm (3.28 ft) ^{b)}

- a) Since pipe dimensions may vary slightly, the propagation factor may also vary.
- b) CLEF range covers the whole measurement range except first 700 or 1000 mm from unit reference point (see A in graphic below)



- sensor reference point
- 2 air gap
- **A** 700 or 1000 mm

- 3 low calibration point
- 4 CLEF range 2.8.4.4.

Note

Flanged encapsulated antenna

For Flanged encapsulated antenna (7ML5432) match the process connection size to the pipe diameter whenever possible (for example, mount a DN80/3" flange on DN80/3" pipe).

Echo Select (2.8.4.)

Algorithm (2.8.4.1.)

Selects the algorithm to be applied to the echo profile to extract the true echo.

Options	*	tF	True First echo
		L	Largest echo
		BLF	Best of Largest and First echo

Position Detect (2.8.4.2.)

Defines where on the echo the distance measurement is determined.

Options		Center
	*	Hybrid (Center and CLEF)
		CLEF (Constrained Leading Edge Fit)
Related parameters		CLEF Range (2.8.4.4.)

If the vessel bottom is being reported as the level instead of the actual material level (at low level conditions), or if the dielectric constant of the liquid to be monitored is less than 3, we recommend setting Position Detect to Hybrid and **CLEF Range (2.8.4.4.)** to 0.5 m (1.64 ft).

Echo Threshold (2.8.4.3.)

Sets the minimum echo confidence that the echo must meet in order to prevent a Loss of Echo condition and the expiration of the Fail-safe (LOE) timer. When **Confidence (2.8.6.1.)** exceeds **Echo Threshold (2.8.4.3.)**, the echo is accepted as a valid echo and is evaluated.

Values	Range: 0 to 99
	Default: 5
Related Parameters	LOE Timer (2.5.2.)

CLEF Range (2.8.4.4.)

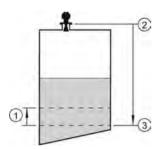
Note

CLEF Range is referenced from Far range.

The CLEF algorithm is used mainly to allow correct level reporting for low dK materials which may otherwise cause an incorrect reading in an empty or almost empty vessel.

It is used from Low Calibration Point (process empty level) up to the level defined by CLEF Range (see illustration below). Above that point the Center algorithm is used. For more detail see CLEF Range (Page 252).

Values	Range: 0 to 20 m (0 to 65.6 ft)
	Default: 0.0 m
Related parameters	Position Detect (2.8.4.2.)



- ① CLEF Range
- Sensor reference point
- 3 Low Calibration Point (process empty level)

In applications with low dK materials we recommend setting CLEF Range to 0.5 m (1.64 ft) and **Position Detect (2.8.4.2.)** to Hybrid.

Sampling (2.8.5.)

Provides a method of checking the reliability of a new echo before accepting it as the valid reading, based on numbers of samples above or below the currently selected echo.

Echo Lock (2.8.5.1.)

Note

Ensure the agitator is always running while SITRANS LR250 is monitoring the vessel, to avoid stationary blade detection.

Selects the measurement verification process.

Options		Lock Off	
		Maximum Verification (not recommended for radar)	
	*	Material Agitator	
		Total Lock (not recommended for radar)	
Related parameters		Fill Rate per Minute (2.4.2.)	
		Empty rate per Minute (2.4.3.)	
		Sampling Up (2.8.5.2.)	
		Sampling Down (2.8.5.3.)	

For radar applications, Material Agitator is the most often-used setting, to avoid agitator blade detection.

Sampling Up (2.8.5.2.)

Specifies the number of consecutive echoes that must appear above the echo currently selected, before the measurement is accepted as valid.

Values	Range: 1 to 50
	Default: 5

Sampling Down (2.8.5.3.)

Specifies the number of consecutive echoes that must appear below the echo currently selected, before the measurement is accepted as valid.

Values	Range: 1 to 50
	Default: 2

Echo Quality (2.8.6.)

Confidence (2.8.6.1.)

Indicates echo reliability: higher values represent better echo quality. The display shows the echo confidence of the last measurement. **Echo Threshold (2.8.4.3.)** defines the minimum criterion for echo confidence.

Values	0 to 99		
(view only)		Shot not used	
Related Parameters	Echo Threshold (2.8.4.3.)		

Open the menu Device - Echo Profile Utilities and click on the tab Echo Profile.

Echo Strength (2.8.6.2.)

Displays the absolute strength (in dB above 1 μV rms) of the echo selected as the measurement echo.

Values	-20 to 99			
(view only)		Shot not used		

Open the menu Device - Echo Profile Utilities and click on the tab Echo Profile.

Noise Average (2.8.6.3.)

Displays the average ambient noise (in dB above 1 μ V rms) of a noise profile. Noise level is a combination of transient noise and receiving circuitry. After a measurement, the values from the previous noise shot will be displayed.

TVT Setup (2.8.7.)

Note

Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.

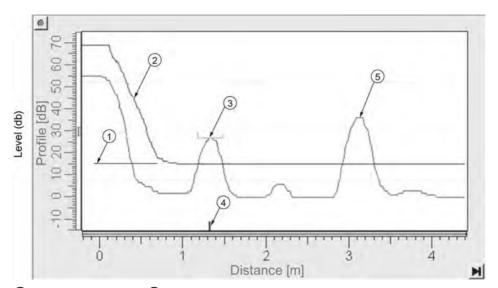
Auto False Echo Suppression (2.8.7.1.)

Used together with **Auto False Echo Suppression Range (2.8.7.2.)** to screen out false echoes in a vessel with known obstructions. A 'learned TVT' (time varying threshold) replaces the default TVT over a specified range. See Auto False Echo Suppression (Page 253) for a more detailed explanation.

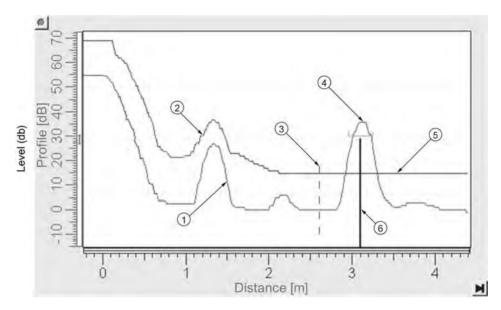
Note

- Make sure material level is below all known obstructions when Auto False Echo Suppression is used to learn the echo profile. (An empty or almost empty vessel is recommended.)
- Note the distance to material level when Auto False Echo learns the environment. Set Auto False Echo Suppression Range to a shorter distance to avoid the material echo being screened out.
- Set Auto False Echo Suppression and Auto False Echo Suppression Range during startup, if possible.
- If the vessel contains an agitator it should be running.
- Before adjusting these parameters, rotate the instrument for best signal (lower false-echo amplitude).

Before Auto False Echo Suppression



- 1 TVT Hover Level
- 4 echo marker
- ② default TVT
- 5 material level
- 3 false echo
- 1. Determine Auto False Echo Suppression Range. Measure the actual distance from the sensor reference point to the material surface using a rope or tape measure.
- 2. Subtract 0.5 m (20") from this distance, and use the resulting value.
- 3. Go to **Auto False Echo Suppression Range (2.8.7.2.)** and enter the value calculated in step 2.
- 4. Go to Auto False Echo Suppression (2.8.7.1.) and press RIGHT arrow to open Edit Mode.
- 5. Select **Learn**. The device will automatically revert to **On** (Use Learned TVT) after a few seconds.



After Auto False Echo Suppression

(1) false echo

(4) material level

(2) learned TVT

- 6 default TVT
- 3 Auto False Echo Suppression 6 Range
- echo marker

To set Auto False Echo Suppression via SIMATIC PDM:

Open the menu **Device – Echo Profile Utilities** and click on the tab **Auto False Echo Suppression**. For more detailed instructions see Auto False Echo Suppression via SIMATIC PDM (Page 89).

To set Auto False Echo Suppression via the handheld programmer:

Options		OFF	Default TVT will be used.
	*	ON	'Learned' TVT will be used.
		LEARN	'Learn' the TVT ^a).

a) The learned TVT takes effect only at the next measurement.

Auto False Echo Suppression Range (2.8.7.2.)

Note

Changes take effect only at the next measurement. "Master reset" does not clear the learned/stored TVT, select "Off" to turn it off or "learn" for a new TVT. See **Master Reset** (4.1.)

Specifies the range within which Learned TVT is used [see **Auto False Echo Suppression** (2.8.7.1.) for more detail].

Values	Range: 0.00 to 20.00 m	
	Default: 1.00 m	
Related parameters	Units (2.2.1.)	

- 1. Calculate range according to Auto False Echo Suppression (2.8.7.1.) steps 1 and 2.
- 2. Press **RIGHT arrow** to open Edit mode.
- 3. Enter the new value and press RIGHT arrow to accept it.
- 4. Set Auto False Echo Suppression (2.8.7.1.).

Hover Level (2.8.7.3.)

Note

Changes take effect only at the next measurement.

Defines how high the TVT (Time Varying Threshold) is placed above the noise floor of the echo profile, as a percentage of the difference between the peak of the largest echo in the profile and the noise floor. See **Auto False Echo Suppression (2.8.7.1.)** for an illustration.

Values	Range: 0 to 100 %
	Default: 40%

When the device is located in the center of the vessel, the TVT hover level may be lowered to increase the confidence level of the largest echo.

Shaper Mode (2.8.7.4.)

Enables/disables the TVT shaper.

Options		ON	
	*	OFF	l

TVT shaper (2.8.8.)

Note

- The range is –100 to 100 bits. With 2 bits per dB this gives a range of –50 to 50 dB.
- Shaper Mode (2.8.7.4.) must be turned ON in order for TVT shaper points to be transferred.

Adjusts the TVT (Time Varying Threshold) at a specified range (breakpoint on the TVT). This allows you to reshape the TVT to avoid unwanted echoes. There are 40 breakpoints arranged in 5 groups. (We recommend using SIMATIC PDM to access this feature.)

To use TVT shaper via SIMATIC PDM:

- 1. Go to Level Meter > Setup > Signal Processing > TVT setup > Shaper Mode and select On.
- 2. Open the menu **Device Echo Profile Utilities** and click on **TVT Shaper**. For more detail see TVT shaper via SIMATIC PDM (Page 88).

To use TVT shaper via LUI (local user interface):

- 1. Go to Shaper Mode (2.8.7.4.) and select On.
- 2. Go to Breakpoint 1-9 (2.8.8.1.).
- 3. Open Shaper 1 and enter the TVT Offset value (between -50 and 50).
- 4. Go to the next Shaper point and repeat steps 3 and 4 until all desired breakpoint values have been entered.

Breakpoint 1-9 (2.8.8.1.)

Values	Range: -50 to 50 dB
	Default: 0 dB

Breakpoint 10-18 (2.8.8.2.)

Values	Range: –50 to 50 dB
	Default: 0 dB

Breakpoint 19-27 (2.8.8.3.)

Values	Range: -50 to 50 dB
	Default: 0 dB

Breakpoint 28-36 (2.8.8.4.)

Values	Range: -50 to 50 dB	
	Default: 0 dB	l

Breakpoint 37-40 (2.8.8.5.)

Values	Range: –50 to 50 dB		
	Default: 0 dB		

Measured Values (2.8.9.)

Read only. Allows you to view measured values for diagnostic purposes.

To access measured values via SIMATIC PDM:

Open the menu View - Process Variables.

Level Measurement (2.8.9.1.)

The value for level.

Space Measurement (2.8.9.2.)

The value for space.

Distance Measurement (2.8.9.3.)

The value for distance.

Volume Measurement (2.8.9.4.)

The value for volume.

Diagnostics (3.)

Echo Profile (3.1.)

Allows you to request the current echo profile either locally via the handheld programmer, or remotely via SIMATIC PDM, or AMS Device Manager. [For more detail see Echo Processing (Page 248)].

To request a profile via SIMATIC PDM:

Open the menu **Device – Echo Profile Utilities**. [For more detail see Echo Profile Utilities via SIMATIC PDM (Page 86)].

To request a profile via the handheld programmer:

- 1. In PROGRAM mode, navigate to Level Meter > Diagnostics (3.) > Echo Profile (3.1.)
- 2. Press **RIGHT arrow** to request a profile.

[For more detail see Requesting an Echo Profile (Page 66)].

Electronics Temperature (3.2.)

Current Internal Temperature (3.2.1.)

Read only. Displays (in degrees C) the current temperature on the circuit board recorded by the internal electronics.

For access via SIMATIC PDM open the menu **View – Process Variables** and check the field **Electronics Temperature**.

Highest Value (3.2.2.)

Read only. Displays (in degrees C) the maximum temperature recorded by the internal electronics. The high and low values are maintained over a power cycle.

Via SIMATIC PDM navigate to Maintenance and Diagnostics > Electronics Temperature.

Lowest Value (3.2.3.)

Read only. Displays (in degrees C) the minimum temperature recorded by the internal electronics. The high and low values are maintained over a power cycle.

Via SIMATIC PDM navigate to **Maintenance and Diagnostics** > **Electronics Temperature**.

Service (4.)

Note

Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.

Master Reset (4.1.)

Note

Following a reset to Factory Defaults, complete reprogramming is required.

Resets all parameter to factory defaults, with the following exceptions:

- Device Address (5.1.) remains unchanged if the reset command is sent remotely (via AMS, PDM, DTM, FC375) but is reset to 0 if the reset command is sent via LUI.
- Write Protect (6.2.1.) and PIN to Unlock (6.2.2.) values are not reset.
- Auto False Echo Suppression (2.8.7.1.) learned TVT and Auto False Echo Suppression Range (2.8.7.2.) are not lost.

Options	*	Idle or Done (Return to previous menu)
		Factory Defaults

To perform a reset to factory defaults via SIMATIC PDM, open the menu **Device – Master Reset** and click on **Factory Defaults**.

Remaining Device Lifetime (4.2.)

Note

- Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.
- Four sets of parameters allow you to monitor the Device/Sensor Lifetimes and set up Maintenance/Service schedules, based on operating hours instead of a calendar-based schedule. See also Remaining Sensor Lifetime (4.3.), Service Schedule (4.4.), and Calibration Schedule (4.5.).
- Performing a reset to **Factory Defaults** will reset all the Maintenance Schedule parameters to their factory defaults.
- The device operates in years. To view Remaining Device Lifetime parameters in hours or days (via SIMATIC PDM only) see **Lifetime (Expected) (4.2.1.)**.

The device tracks itself based on operating hours and monitors its predicted lifetime. You can modify the expected device lifetime, set up schedules for maintenance reminders, and acknowledge them.

The maintenance warnings and reminders are available through HART communications. This information can be integrated into an Asset Management system. For optimal use, we recommend that you use SIMATIC PCS7 Asset Management Software in conjunction with SIMATIC PDM.

To access these parameters via SIMATIC PDM:

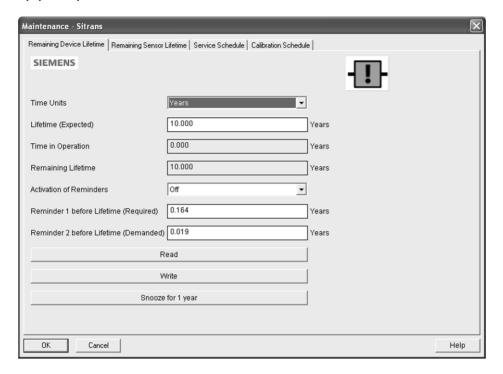
- Open the menu **Device Maintenance** and select the **Remaining Device Lifetime** tab.
- After modifying values/units as required, click on **Write** to accept the change, and **Read** to view the effect of the change.
- Click on **Snooze** to add a year to the Total Expected Device Life.

Time Units

Options a)	Hours; days; years
	Default: years

a) Selectable only via SIMATIC PDM.

Lifetime (Expected) (4.2.1.)



Note

The device always operates in years. Changing the units affects only the parameter view of the Service Interval parameters in SIMATIC PDM.

User-configurable recommended time between product inspections.

Values	Units a): hours, days, years		
	Range: 0 to 20 years		
	Default: 10 years		

a) Units are selectable only via SIMATIC PDM.

Time in Operation (4.2.2.)

Read only. The amount of time the device has been operating.

Remaining Lifetime (4.2.3.)

Read only. Lifetime (Expected) (4.2.1.) less Time in Operation (4.2.2.).

Activation of Reminders (4.2.4.)

Note

To modify this parameter via SIMATIC PDM it must be accessed via the pull-down menu **Device – Maintenance**.

Allows you to enable a maintenance reminder.

Values	*	Timer OFF
		ON - no reminders checked
		ON - Reminder 1 (Maintenance Required) checked
		ON - Reminders 1 and 2 checked
		ON - Reminder 2 (Maintenance Demanded) checked

- 1. First set the values in Reminder 1 before Lifetime (Required) (4.2.5.)/ Reminder 2 before Lifetime (Demanded) (4.2.6.).
- 2. Select the desired **Activation of Reminders** option.

Reminder 1 before Lifetime (Required) (4.2.5.)

If **Remaining Lifetime (4.2.3.)** is equal to or less than this value, the device generates a Maintenance Required reminder.

Values	Range: 0 to Lifetime (Expected) (4.2.1.)
	Default: 0.164 years

- 1. Modify values as required.
- 2. Set Activation of Reminders (4.2.4.) to the desired option.

Reminder 2 before Lifetime (Demanded) (4.2.6.)

If **Remaining Lifetime (4.2.3.)** is equal to or less than this value, the device generates a Maintenance Demanded reminder.

Values	Range: 0 to Lifetime (Expected) (4.2.1.)
	Default: 0.019 years

- 1. Modify values as required.
- 2. Set **Activation of Reminders (4.2.4.)** to the desired option.

Maintenance Status (4.2.7.)

Indicates which level of maintenance reminder is active.

In SIMATIC PDM, open the menu **View – Device Status**, click on the **Maintenance** tab, and check the **Device Lifetime Status** window.

Acknowledge Status (4.2.8.)

Indicates which level of maintenance reminder has been acknowledged.

In SIMATIC PDM, open the menu **View – Device Status**, click on the **Maintenance** tab, and check the **Device Lifetime Status** window.

Acknowledge (4.2.9.)

Acknowledges the current maintenance reminder.

To acknowledge a reminder via SIMATIC PDM:

- 1. Open the menu **View Device Status** and click on the **Maintenance** tab.
- 2. In the **Device Lifetime** section, click on **Acknowledge Warnings**.

To acknowledge a reminder via the handheld programmer:

- 1. Press **RIGHT arrow** twice to open parameter view and activate Edit Mode.
- 2. Press **RIGHT arrow** to acknowledge the reminder.

Remaining Sensor Lifetime (4.3.)

Note

- Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.
- Four sets of parameters allow you to monitor the Device/Sensor Lifetimes and set up Maintenance/Service schedules, based on operating hours instead of a calendar-based schedule. See also Remaining Device Lifetime (4.2.), Service Schedule (4.4.), and Calibration Schedule (4.5.).
- Performing a reset to Factory Defaults will reset all the Maintenance Schedule parameters to their factory defaults.
- The device operates in years. To view Remaining Sensor Lifetime parameters in hours or days (via SIMATIC PDM only) see **Lifetime Expected (4.3.1.)**.

The device monitors the predicted lifetime of the sensor (the components exposed to the vessel environment). You can modify the expected sensor lifetime, set up schedules for maintenance reminders, and acknowledge them.

To access these parameters via SIMATIC PDM:

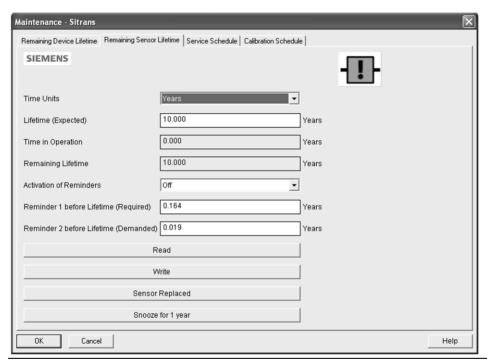
- Open the menu Device Maintenance and select the Remaining Sensor Lifetime tab.
- After modifying values/units as required, click on Write to accept the change, and Read to view the effect of the change.
- Click on **Snooze** to add a year to the Total Expected Sensor Life.
- Click on Sensor Replaced to restart the timer and clear any fault messages.

Time Units

Options a)	Hours; days; years
	Default: years

a) Selectable only via SIMATIC PDM.

Lifetime (Expected) (4.3.1.)



Note

The device always operates in years. Changing the units affects only the parameter view of Remaining Sensor Life parameters in SIMATIC PDM.

Allows you to override the factory default.

Values	Units a): hours, days, years
	Range: 0 to 20 years
	Default: 10.00 years

a) Units are selectable only via SIMATIC PDM.

Time in Operation (4.3.2.)

The amount of time the sensor has been operating. Can be reset to zero after performing a service or replacing the sensor.

To reset to zero:

- In SIMATIC PDM, open the menu **Device Maintenance**, click on the **Remaining Sensor Lifetime** tab, and click on **Sensor Replaced** to restart the timer and clear any fault messages.
- Via the handheld programmer, manually reset **Time in Operation (4.3.2.)** to zero.

Remaining Lifetime (4.3.3.)

Read only. Lifetime (Expected) (4.3.1.) less Time in Operation (4.3.2.).

Activation of Reminders (4.3.4.)

Note

To modify this parameter via SIMATIC PDM it must be accessed via the pull-down menu **Device – Maintenance**.

Allows you to enable a maintenance reminder.

Options		Reminder 1 (Maintenance Required)
		Reminder 2 (Maintenance Demanded)
		Reminders 1 and 2
	*	OFF

- 1. First set the values in Reminder 1 before Lifetime (Required) (4.3.5.)/Reminder 2 before Lifetime (Demanded) (4.3.6.).
- 2. Select the desired **Activation of Reminders** option.

Reminder 1 before Lifetime (Required) (4.3.5.)

If **Remaining Lifetime (4.3.3.)** is equal to or less than this value, the device generates a **Maintenance Required** reminder.

Values	Range: 0 to Lifetime (Expected) (4.3.1.)
	Default: 0.164 years

- 1. Modify values as required.
- 2. Set Activation of Reminders (4.3.4.) to the desired option.

Reminder 2 before Lifetime (Demanded) (4.3.6.)

If **Remaining Lifetime (4.3.3.)** is equal to or less than this value, the device generates a **Maintenance Demanded** reminder.

Values	Range: 0 to Lifetime (Expected) (4.3.1.)
	Default: 0.019 years

- 1. Modify values as required.
- 2. Set Activation of Reminders (4.3.4.) to the desired option.

Maintenance Status (4.3.7.)

Indicates which level of maintenance reminder is active.

In SIMATIC PDM, open the menu **View – Device Status**, click on the **Maintenance** tab, and check the **Sensor Lifetime Status** window.

Acknowledge Status (4.3.8.)

Indicates which level of maintenance reminder has been acknowledged.

In SIMATIC PDM, open the menu **View – Device Status**, click on the **Maintenance** tab, and check the **Sensor Lifetime Status** window.

Acknowledge (4.3.9.)

Acknowledges the current maintenance reminder.

To acknowledge a reminder via SIMATIC PDM:

- 1. Open the menu View Device Status and click on the Maintenance tab.
- 2. In the Sensor Lifetime section, click on Acknowledge Warnings.

To acknowledge a reminder via the handheld programmer:

- 1. Press **RIGHT arrow** twice to open parameter view and activate **Edit** Mode.
- 2. Press **RIGHT arrow** to acknowledge the reminder.

Service Schedule (4.4.)

Note

- Four sets of parameters allow you to monitor the Device/Sensor Lifetimes and set up Maintenance/Service schedules, based on operating hours instead of a calendar-based schedule. See also Remaining Device Lifetime (4.2.), Remaining Sensor Lifetime (4.3.), and Calibration Schedule (4.5.).
- Performing a reset to Factory Defaults will reset all the Maintenance Schedule parameters to their factory defaults.
- The device operates in years. To view Service Interval parameters in hours or days (via SIMATIC PDM only) see Service interval (4.4.1.).

The device tracks service intervals based on operating hours and monitors the predicted lifetime to the next service. You can modify the Total Service Interval, set schedules for maintenance reminders, and acknowledge them.

The maintenance warnings and reminders are communicated to the end user through status information. This information can be integrated into any Asset Management system. For optimal use, we recommend that you use SIMATIC PCS7 Asset Management Software in conjunction with SIMATIC PDM.

To access these parameters via SIMATIC PDM:

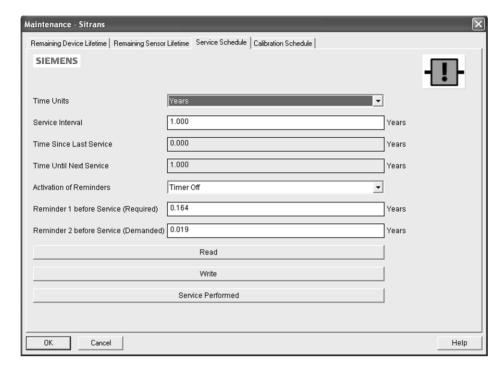
- Open the menu **Device Maintenance** and select the **Service Schedule** tab.
- After modifying values/units as required, click on **Write** to accept the change, and **Read** to view the effect of the change.
- Click on **Service Performed** to restart the timer and clear any fault messages.

Time Units

Options a)	Hours; days; years
	Default: years

a) Selectable only via SIMATIC PDM.

Service Interval (4.4.1.)



Note

The device always operates in years. Changing the units affects only the parameter view of the Service Interval parameters in SIMATIC PDM.

User-configurable recommended time between product inspections.

Values	Units a): hours, days, years
	Range: 0 to 20 years
	Default: 1.0 year

a) Units are selectable only via SIMATIC PDM.

Time Since Last Service (4.4.2.)

Time elapsed since last service. Can be reset to zero after performing a service.

To reset to zero:

- In SIMATIC PDM, open the menu **Device Maintenance**, click on the **Service Schedule** tab, and click on **Service Performed** to restart the timer and clear any fault messages.
- Via the handheld programmer, manually reset **Time since Last Service (4.4.2.)** to zero.

Time Until Next Service (4.4.3.)

Read only. Service Interval (4.4.1.) less Time Since Last Service (4.4.2.).

Activation of Reminders (4.4.4.)

Note

To modify this parameter via SIMATIC PDM it must be accessed via the pull-down menu **Device – Maintenance**.

Allows you to enable a maintenance reminder.

Options	*	Timer OFF
		ON - no reminders checked
		ON - Reminder 1 (Maintenance Required) checked
		ON - Reminders 1 and 2 checked
		ON - Reminder 2 (Maintenance Demanded) checked

- 1. First set the values in Reminder 1 before Service (Required) (4.4.5.)/Reminder 2 before Service (Demanded) (4.4.6.).
- 2. Select the desired **Reminder Activation** option.

Reminder 1 before Service (Required) (4.4.5.)

If **Time Until Next Service (4.4.3.)** is equal to or less than this value, the device generates a **Maintenance Required** reminder.

Values	Range: 0 to Service Interval (4.4.1.)
	Default: 0.164 years

- 1. Modify values as required.
- 2. Set Activation of Reminders (4.4.4.) to the desired option.

Reminder 2 before Service (Demanded) (4.4.6.)

If **Time Until Next Service (4.4.3.)** is equal to or less than this value, the device generates a **Maintenance Required** reminder.

Values	Range: 0 to Service Interval (4.4.1.)
	Default: 0.019 years

- 1. Modify values as required
- 2. Set Activation of Reminders (4.4.4.) to the desired option.

Maintenance Status (4.4.7.)

Indicates which level of maintenance reminder is active.

Open the menu View – Device Status, click on the Maintenance tab and check the Service Schedule Status window.

Acknowledge Status (4.4.8.)

Indicates which level of maintenance reminder has been acknowledged.

Open the menu **View – Device Status**, click on the **Maintenance** tab and check the **Service Schedule Status** window.

Acknowledge (4.4.9.)

Acknowledges the current maintenance reminder.

To acknowledge a reminder via SIMATIC PDM:

- 1. Open the menu View Device Status and click on the Maintenance tab.
- 2. In the Service Schedule Status section, click on Acknowledge Warnings.

To acknowledge a reminder via the handheld programmer:

- 1. Press **RIGHT** arrow twice to open parameter view and activate **Edit** Mode.
- 2. Press **RIGHT** arrow to acknowledge the reminder.

Calibration Schedule (4.5.)

Note

- Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.
- Four sets of parameters allow you to monitor the Device/Sensor Lifetimes and set up Maintenance/Service schedules, based on operating hours instead of a calendar-based schedule. See also Remaining Device Lifetime (4.2.), Remaining Sensor Lifetime (4.3.), and Service Schedule (4.4.).
- Performing a reset to **Factory Defaults** will reset all the Maintenance Schedule parameters to their factory defaults.
- The device operates in years. To view Calibration Interval parameters in hours or days (via SIMATIC PDM only) see Calibration Interval (4.5.1.).

The device tracks calibration intervals based on operating hours and monitors the predicted lifetime to the next calibration. You can modify the Total Calibration Interval, set schedules for maintenance reminders, and acknowledge them.

To access these parameters via SIMATIC PDM:

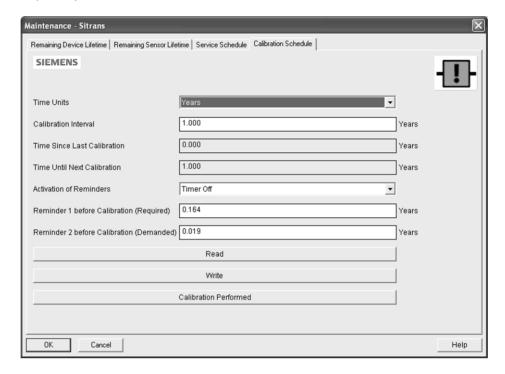
- Open the menu **Device Maintenance** and select the **Calibration Schedule** tab.
- After modifying values/units as required, click on Write to accept the change, and Read to view the effect of the change.
- Click on Calibration Performed to restart the timer and clear any fault messages.

Time Units

Options a)	Hours; days; years
	Default: years

a) Selectable only via SIMATIC PDM.

Calibration Interval (4.5.1.)



Note

The device always operates in years. Changing the units affects only the parameter view of Remaining Sensor Life parameters in SIMATIC PDM.

User-configurable recommended time between product calibrations.

Values	Units a): hours, days, years
	Range: 0 to 20 years
	Default: 1.0 year

a) Units are selectable only via SIMATIC PDM.

Time Since Last Calibration (4.5.2.)

Time elapsed since last calibration. Can be reset to zero after performing a calibration.

To reset to zero:

- In SIMATIC PDM, open the menu Device Maintenance, click on the Calibration Schedule
 tab, and click on Calibration Performed to restart the timer and clear any fault messages.
- Via the handheld programmer, manually reset Time Since Last Calibration (4.5.2.) to zero.

Time Until Next Calibration (4.5.3.)

Read only. Calibration Interval (4.5.1.) less Time Since Last Calibration (4.5.2.).

Activation of Reminders (4.5.4.)

Note

To modify this parameter via SIMATIC PDM it must be accessed via the pull-down menu Device – Maintenance.

Allows you to enable a maintenance reminder.

Options		Timer OFF
		ON - no reminders checked
		ON - Reminder 1 (Maintenance Required) checked
	*	ON - Reminders 1 and 2 checked
		ON—Reminder 2 (Maintenance Demanded) checked

- 1. First set the values in Reminder 1 before Calibration (Required) (4.5.5.)/Reminder 2 before Calibration (Demanded) (4.5.6.).
- 2. Select the desired **Activation of Reminders** option.

Reminder 1 before Calibration (Required) (4.5.5.)

If **Time Until Next Calibration (4.5.3.)** is equal to or less than this value, the device generates a **Maintenance Required** reminder.

Values	Range: 0 to Calibration Interval (4.5.1.)
	Default: 0.164 years

- 1. Modify values as required.
- 2. Set Activation of Reminders (4.5.4.) to the desired option.

Reminder 2 before Calibration (Demanded) (4.5.6.)

If **Time Until Next Calibration (4.5.3.)** is equal to or less than this value, the device generates a **Maintenance Demanded** reminder.

Values	Range: 0 to Calibration Interval (4.5.1.)	
	Default: 0.164 years	

- 1. Modify values as required.
- 2. Set Activation of Reminders (4.5.4.) to the desired option.

Maintenance Status (4.5.7.)

Indicates which level of maintenance reminder is active.

In SIMATIC PDM, open the menu **View – Device Status**, click on the **Maintenance** tab and check the **Calibration Schedule Status** window.

Acknowledge Status (4.5.8.)

Indicates which level of maintenance reminder has been acknowledged.

In SIMATIC PDM, open the menu **View – Device Status**, click on the **Maintenance** tab and check the **Calibration Schedule Status** window.

Acknowledge (4.5.9.)

Acknowledges the current maintenance reminder.

To acknowledge a reminder via SIMATIC PDM:

- 1. Open the menu View Device Status and click on the Maintenance tab.
- 2. In the Service Schedule Status section, click on Acknowledge Warnings.

To acknowledge a reminder via the handheld programmer:

- 1. Press **RIGHT** arrow twice to open parameter view and activate **Edit** Mode.
- 2. Press **RIGHT** arrow to acknowledge the reminder.

Manufacture Date (4.6.)

Read only. The date of manufacture of the SITRANS LR250 (yy mm dd).

Powered Hours (4.7.)

Read only. Displays the number of hours the unit has been powered up since manufacture. In SIMATIC PDM, open the menu **Device – Wear**.

Power-on Resets (4.8.)

Read only. The number of power cycles that have occurred since manufacture.

In SIMATIC PDM, open the menu **Device – Wear**.

LCD Fast Mode (4.9.)

Note

- LCD Fast Mode takes effect only after 30 minutes of inactivity. (Each time the device is powered up, a further 30 minutes of inactivity is required.)
- LCD Fast Mode affects Measurement mode only; it has no effect on Navigation mode.

Enables a faster rate of measurement from the device by disabling most of the display area. Only the bar graph will be refreshed when LCD Fast Mode is set to ON.

Values	ON or OFF
	Default: OFF

LCD Contrast (4.10.)

The factory setting is for optimum visibility at room temperature and in average light conditions. Extremes of temperature will lessen the contrast.

Values	Range: 0 (High contrast) to 20 (Low contrast). Default: 10

Adjust the value to improve visibility at room temperature and in average light conditions. Change the value in small steps to ensure you can continue to read the display.

Secondary Value (4.11.)

Use the secondary value to capture the menu navigation path to any viewable parameter. Once the navigation path is stored, the value of that parameter will be displayed in **Measurement** mode as the secondary value.

While in Parameter view of the current parameter, press the decimal point key. This stores the path to the current parameter in the Secondary Value, and displays the value for that parameter on the LCD display when in **Measurement** mode. See The LCD Display (Page 53) for an illustration.

Memory Test (4.12.)

Allows verification of the RAM, EEPROM, and Flash memory of the SITRANS LR250.

LCD Display	IDLE	No test in progress.
	BUSY	Test in progress.
	PASS	Memory test successful.
	FAIL	Test failed.
	Err1	Test returned unexpected results.
	P Oxcafe	Test passed with result data.
	F Oxcafe	Test failed with result data.
Handheld programmer entry	1	Any numeric key from 1 to 9 activates test.
	to	
	9	

- Press **RIGHT** arrow to edit then press any numeric key from 1 to 9 to activate the test.
- The reading will display BUS and then the test result text.

Communication (5.)

Note

Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.

Device Address (5.1.)

Sets the device address or poll ID on a HART network. Any address other than 0 will cause the output current to be a fixed value, and the current will not indicate the reading.

Values	Range: 0 to 15
	Default: 0

To set Device Address via SIMATIC PDM:

- Open the project in Process Device Network View then right-click on the device.
- Go to **Object Properties > Connection** to access the field **Short Address**.

Security (6.)

Note

Default settings in the parameter tables are indicated with an asterisk (*) unless explicitly stated.

Remote Access (6.1.)

Access Control (6.1.1.)

Note

If access control is changed to limit remote access, it can only be reset via the handheld programmer.

Enables/disables the read/write access to parameters via remote communications.

inables, disables the read, write access to parameters that emote communications.			
Options		Read only	No changes are permitted via remote communications.
	*	Read Write	Changes are permitted.
		Restricted	Sets the status to Read only, with the potential for another HART device to change this parameter only, via remote communications.

Local Access (6.2.)

Write Protect (6.2.1.)

Note

This lock affects only the handheld programmer. A remote master can change configuration if **Access Control (6.1.1.)** is set to allow this.

Prevents any changes to parameters via the handheld programmer.

Options		Range: 0 to 9999	
	*	Unlock value [stored in PIN to Unlock (6.2.2.)]	Lock Off
		Any other value	Lock On

- To turn Lock On, key in any value other than the Unlock Value stored in PIN to Unlock (6.2.2.).
- To turn Lock Off, key in the Unlock Value stored in PIN to Unlock (6.2.2.).

PIN to Unlock (6.2.2.)

Note

- Do not lose your Unlock Value: it cannot be displayed once **Write Protect (6.2.1.)** has been set to a different value.
- Valid only for operation via the handheld programmer.
- A reset to **Factory Defaults** will not restore the unlock value at time of shipping.

Stores the value to be entered in **Write Protect (6.2.1.)** to unlock programming. If **Write Protect (6.2.1.)** is set to a different value, **PIN to Unlock (6.2.2.)** does not display the Unlock value.

Handheld Programmer Values	Range: 0 to 9999	
	Value when shipped: 1954. Not restored by a reset to Factory Defaults.	
		Display when Lock is on

Language (7.)

Selects the language to be used on the LCD.

Options	*	English
		Deutsch
		Français
		Español

8.1 Alphabetical parameter list

Note

For a detailed list of parameters see Parameter Reference (Page 123). Maintenance Parameters are not listed below. See **Remaining Device Lifetime (4.2.)**, **Remaining Sensor Lifetime (4.3.)**, **Service Schedule (4.4.)** and **Calibration Schedule (4.5.)** for those parameters.

```
20 mA Setpoint (2.6.3.)
4 mA Setpoint (2.6.2.)
Access Control (6.1.1.)
Algorithm (2.8.4.1.)
Analog Output Scaling (2.6.)
Auto False Echo Suppression (2.8.7.1.)
Auto False Echo Suppression Range (2.8.7.2.)
Breakpoint 1-9 (2.8.8.1.)
Breakpoint 10-18 (2.8.8.2.)
Breakpoint 19-27 (2.8.8.3.)
Breakpoint 28-36 (2.8.8.4.)
Breakpoint 37-40 (2.8.8.5.)
Calibration (2.3.)
CLEF Range (2.8.4.4.)
Communication (5.)
Confidence (2.8.6.1.)
Current Internal Temperature (3.2.1.)
Current Output Function (2.6.1.)
Damping Filter (2.2.4.)
Device (2.1.)
Device Address (5.1.)
Diagnostics (3.)
Distance Measurement (2.8.9.3.)
Echo Lock (2.8.5.1.)
Echo Profile (3.1.)
Echo Quality (2.8.6.)
```

Echo Select (2.8.4.)

Echo Strength (2.8.6.2.)

Echo Threshold (2.8.4.3.)

Electronics Temperature (3.2.)

Empty Rate per Minute (2.4.3.)

Fail-safe (2.5.)

Fail-Safe mA Value (2.5.3.)

Far Range (2.8.2.)

Fill Rate per Minute (2.4.2.)

Firmware Revision (2.1.2.)

Hardware Revision (2.1.1.)

High Calibration Pt. (2.3.2.)

Highest value (3.2.2.)

Hover Level (2.8.7.3.)

Language (7.)

LCD Contrast (4.10.)

LCD Fast Mode (4.9.)

Level 1 (2.7.2.1.)

Level Measurement (2.8.9.1.)

Linearization (2.7.)

Loader Revision (2.1.3.)

Local Access (6.2.)

LOE Timer (2.5.2.)

Low Calibration Pt. (2.3.1.)

Lowest value (3.2.3.)

mA Output Value (2.6.6.)

Manufacture Date (4.6.)

Master Reset (4.1.)

Material (2.2.3.)

Material Level (2.5.1.)

Maximum mA limit (2.6.5.)

Maximum Volume (2.7.1.2.)

Measured Values (2.8.9.)

Memory Test (4.12.)

Menu Timeout (2.1.5.)

Minimum mA limit (2.6.4.)

Near Range (2.8.1.)

Noise Average (2.8.6.3.)

Order Option (2.1.4.)

PIN to Unlock (6.2.2.)

Position Detect (2.8.4.2.)

Power-on Resets (4.8.)

Powered Hours (4.7.)

Propagation Factor (2.8.3.)

Quick Start (1.)

Quick Start Wizard (1.1.)

Rate (2.4.)

Remote Access (6.1.)

Response Rate (2.4.1.)

Sampling (2.8.5.)

Sampling Down (2.8.5.3.)

Sampling Up (2.8.5.2.)

Shaper Mode (2.8.7.4.)

Signal Processing (2.8.)

Secondary Value (4.11.)

Security (6.)

Sensor (2.2.)

Sensor Mode (2.2.2.)

Sensor Offset (2.3.3.)

Service (4.)

Setup (2.)

Space Measurement (2.8.9.2.)

Table 1-8 (2.7.2.)

Table 9-16 (2.7.3.)

Table 17-24 (2.7.4.)

Table 25-32 (2.7.5.)

TVT Setup (2.8.7.)

TVT Shaper (2.8.8.)

Units (2.2.1.)

Vessel Dimension A (2.7.1.3.)

Vessel Dimension L (2.7.1.4.)

Vessel Shape (2.7.1.1.)

Volume (2.7.1.)

Volume 1 (2.7.2.2.)

Volume Measurement (2.8.9.4.)

Write Protect (6.2.1.)

Service and maintenance

9.1 Basic safety information



Impermissible repair of the device

• Repair must be carried out by Siemens authorized personnel only.



Releasing key lock

Improper modification of parameters could influence process safety.

 Make sure that only authorized personnel may cancel the key locking of devices for safety-related applications.

9.2 Cleaning

The radar device requires no cleaning under normal operating conditions.

Under severe operating conditions, the antenna may require periodic cleaning. If cleaning becomes necessary:

- Note the antenna material and the process medium, and select a cleaning solution that will not react adversely with either.
- Remove the device from service and wipe the antenna clean using a cloth and suitable cleaning solution.

NOTICE

Penetration of moisture into the device

Device damage.

• Make sure when carrying out cleaning and maintenance work that no moisture penetrates the inside of the device.



Electrostatic charge

Danger of explosion in hazardous areas if electrostatic charges develop, for example, when cleaning plastic surfaces with a dry cloth.

Prevent electrostatic charging in hazardous areas.

9.3 Maintenance and repair work

9.3 Maintenance and repair work

The device is maintenance-free. However, a periodic inspection according to pertinent directives and regulations must be carried out.

An inspection can include check of:

- Ambient conditions
- Seal integrity of the process connections, cable entries, and cover screws
- Reliability of power supply, lightning protection, and grounds



Maintenance during continued operation in a hazardous area

There is a danger of explosion when carrying out repairs and maintenance on the device in a hazardous area.

- Isolate the device from power.
- or -
- Ensure that the atmosphere is explosion-free (hot work permit).



Humid environment

Danger of electric shock.

- Avoid working on the device when it is energized.
- If working on an energized device is necessary, ensure that the environment is dry.
- Make sure when carrying out cleaning and maintenance work that no moisture penetrates the inside of the device.

9.3.1 Unit repair and excluded liability

All changes and repairs must be done by qualified personnel, and applicable safety regulations must be followed. Please note the following:

- The user is responsible for all changes and repairs made to the device.
- All new components must be provided by Siemens.
- Restrict repair to faulty components only.
- Do not re-use faulty components.

9.3.2 Part replacement

If the antenna, lens, secondary O-ring, and spring washers require replacement due to damage or failure, they may be replaced without the need for re-calibration if of the same type and size.

Replacing the antenna

Changing to a different antenna type may be performed by a Siemens authorized repair center or personnel.

If the electronics or enclosure require replacement due to damage or failure, please ensure the correct antenna version is used, otherwise a re-calibration will need to be performed by Siemens authorized personnel.

Replacing the lens

- 1. Remove existing lens by turning it counter-clockwise until it separates from the unit.
- 2. Replace the O-ring between the lens and process connection with a new one.
- 3. Carefully thread the replacement lens, and turn it clockwise until resistance is encountered. Do not over-tighten the lens, as this will permanently damage it.
- 4. For flange installation instructions, see Flanged versions (Page 35).

Note

After installation of the new lens onto the flanged encapsulated antenna version and before mounting on the vessel/tank, some lenses may not appear to lie flush on the device, but this is normal and will not impact performance.

9.3 Maintenance and repair work

Raised-Face flange kits

Description	Process connection size	Part number
Replacement TFM TM 1600 PTFE Lens and Spring Washer	2"	A5E32462817
Kit for ASME B16.5 Class 150 raised faced	3"	A5E32462819
	4"	A5E32462820
	6"	A5E32462821
Replacement TFM™ 1600 PTFE Lens and Spring Washer	50A	A5E32462822
Kit for JIS B 2220 10K raised Face	80A	A5E32462823
	100A	A5E32462824
	150A	A5E32462825
Replacement TFM TM 1600 PTFE Lens and Spring Washer	DN50	A5E32462826
Kit for EN 1092-1 PN10/16 type B1 raised face	DN80	A5E32462827
	DN100	A5E32462828
	DN150	A5E32462829

Spare part kits

Description	Process connection size	Part number
ISO2852, Hygienic encapsulated antenna Lens and silicon O-ring	2"	A5E32572731
	3"	A5E32572745
	4"	A5E32572747
DIN11851, Hygienic encapsulated antenna Lens and silicon O-	DN50	A5E32572758
ring	DN80	A5E32572770
	DN100	A5E32572772
DIN11864-1, Hygienic encapsulated antenna Lens and silicon O-	DN50	A5E32572773
ring	DN80	A5E32572779
	DN100	A5E32572782
DIN11864-2/3, Hygienic encapsulated antenna Lens and silicon	DN50	A5E32572785
O-ring	DN80	A5E32572790
	DN100	A5E32572791
Tuchenhagen, Hygienic encapsulated antenna Lens and silicon	Type F	A5E32572794
O-ring	Type N	A5E32572795

Note

For more information about accessories such as clamps, seals and process connections, please see the catalog on the product page (http://www.siemens.com/LR250).

9.4 Disposal

9.4 Disposal

Note

Special disposal required

The device includes components that require special disposal.

• Dispose of the device properly and environmentally through a local waste disposal contractor.

9.4 Disposal

Diagnosing and troubleshooting 10

10.1 Communication troubleshooting

- 1. Check the following:
 - There is power at the device.
 - The LCD shows the relevant data.
 - The device can be programmed using the handheld programmer.
 - If any fault codes are being displayed see General Fault Codes (Page 186) for a detailed list.
- 2. Verify that the wiring connections are correct.
- 3. See the table below for specific symptoms.

Symptom	Corrective action
The device cannot be programmed via the handheld programmer.	Ensure Write Protect (6.2.1.) is set to the unlock value.
You try to set a SITRANS LR250 parameter via remote communications but the parameter remains unchanged.	 Ensure Write Protect (6.2.1.) is set to the unlock value, then try setting the parameter via the handheld programmer. Ensure Access Control (6.1.1.) is set to Read/ Write. Some parameters can be changed only when the device is not scanning. Try pressing Mode to put the device into PROGRAM mode.

If you continue to experience problems go to our website and check the FAQs for SITRANS LR250:

Product page (http://www.siemens.com/LR250), or contact your Siemens representative.

10.2 Device status icons

Icon	Priority Level	Meaning
£	1	Maintenance alarm
4		Measurement values are not valid
متل.:	2	Maintenance warning: maintenance demanded immediately
7		Measured signal still valid
if F	3	Maintenance required
•,		Measured signal still valid
: ‡	1	Process value has reached an alarm limit
: ‡	2	Process value has reached a warning limit
· ‡	3	Process value has reached a tolerance limit
:	1	Configuration error
, E		Device will not work because one or more parameters/components is incorrectly configured
:[]	2	Configuration warning
		Device can work but one or more parameters/components is incorrectly configured
.[]	3	Configuration changed
		Device parameterization not consistent with parameterization in project. Look for info text.
am	1	Manual operation (local override)
ર્		Communication is good; device is in manual mode.
:2"	2	Simulation or substitute value
		Communication is good; device is in simulation mode or works with substitute values.
·2	3	Out of operation
		Communication is good; device is out of action.
11		Data exchanged
×		No data exchange

Icon	Priority Level	Meaning
-		Write access enabled
a		Write access disabled

10.3 General fault codes

Note

- If more than one fault is present, the device status indicator and text for each fault alternate at 2 second intervals.
- Some faults cause the device to go to Fail-safe mode (Fault 52). These are indicated with an asterisk (*).

Code/ Icon		Meaning	Corrective Action
S: 0	*	The device was unable to get a measurement within the Fail-safe LOE Timer period. Possible causes: faulty installation, antenna material buildup, foaming/other adverse process conditions, invalid configuration range.	 Ensure installation details are correct. Ensure no antenna material buildup. Clean if necessary. Adjust process conditions to minimize foam or other adverse conditions. Correct configuration range. If fault persists, contact your local Siemens representative.
S: 2	*	Unable to collect profile because of a power condition that is outside the operating range of the device.	Repair required: contact your local Siemens representative.
S: 3		Device is nearing its lifetime limit according to the value set in Maintenance Required Limit.	Replacement is recommended
S: 4		Device is nearing its lifetime limit according to the value set in Maintenance Demanded Limit.	Replacement is recommended.
S: 6		Sensor is nearing its lifetime limit according to the value set in Maintenance Required Limit.	Replacement is recommended.
S: 7		Sensor is nearing its lifetime limit according to the value set in Maintenance Demanded Limit.	Replacement is recommended.
S: 8		Service interval as defined in Maintenance Required Limit has expired.	Perform service.

Code/ Icon		Meaning	Corrective Action
S: 9		Service interval as defined in Maintenance Demanded Limit has expired.	Perform service.
S: 11		Internal temperature sensor failure.	Repair required: contact your local Siemens representative.
S: 12		Internal temperature of device has exceeded specifications: it is operating outside its temperature range.	 Relocate device and/or lower process temperature enough to cool device. Inspect for heat-related damage and contact your local Siemens representative if repair is required. Fault code will persist until a manual reset is performed using SIMATIC PDM or the LCD interface.
S: 17		Calibration interval as defined in Maintenance Required Limit has expired.	Perform calibration.
S: 18		Calibration interval as defined in Maintenance Demanded Limit has expired.	Perform calibration.
S: 28	*	Internal device failure caused by a RAM memory error.	Repair required: contact your local Siemens representative.
S: 29	*	EEPROM damaged.	Repair required: contact your local Siemens representative
S: 31	*	Flash error.	Repair required: contact your local Siemens representative
S: 33	*	Factory calibration for the internal temperature sensor has been lost.	Repair required: contact your local Siemens representative
S: 34	*	Factory calibration for the device has been lost.	Repair required: contact your local Siemens representative
S: 35	*	Factory calibration for the device has been lost.	Repair required: contact your local Siemens representative

10.3 General fault codes

Code/ Icon		Meaning	Corrective Action
S: 36	*	Unable to start microwave module.	Repair required: contact your local Siemens representative
S: 37	*	Measurement hardware problem.	Repair required: contact your local Siemens representative
S: 38	*	Failure in the device electronics.	Repair required: contact your local Siemens representative
S: 43	*	Factory calibration for the radar receiver has been lost.	Repair required: contact your local Siemens representative.
S: 45	*	No valid boot program detected: firmware corrupt	Repair required: contact your local Siemens representative.
S: 48	*	User configuration is invalid. One or more of parameters: Low Calibration Point, High Calibration Point, Volume breakpoints, and/or Auto False-Echo Suppression, are set to invalid values.	 Reconfigure the unit. Ensure the difference between High Calibration Point and Low Calibration Point is not less than or equal to zero; do a Master Reset.
S: 49	*	EEPROM corrupt.	Repair required: contact your local Siemens representative.
S: 50	*	EEPROM corrupt.	Repair required: contact your local Siemens representative.
S: 51	*	EEPROM corrupt.	Repair required: contact your local Siemens representative.

Code/ Icon		Meaning	Corrective Action
S: 52		Fail-safe is activated. Possible causes:	For 3:
:[]		 hardware failure memory failure Fail-safe LOE timer expired – possible causes: faulty installation, antenna material buildup, foaming/other adverse process conditions, invalid calibration range. 	 Correct configuration; ensure installation is correct; no antenna buildup; adjust process conditions to minimize foaming/other adverse conditions; correct calibration range. If fault persists, or for 1 and 2, contact your local Siemens representative.
S: 53	*	Configuration lost: one or more parameter settings have been lost. This may occur after a firmware upgrade causes user parameters to be reset.	Restore user parameters using SIMATIC PDM.

10.4 Operation troubleshooting

Operating symptoms, probable causes, and resolutions.

Symptom	Cause	Action	
Display shows S: 0 LOE Display shows S: 0 LOE	level or target is out of range material build-up on antenna	 check specifications check Low Calibration Pt. (2.3.1.) increase Confidence (2.8.6.1.) clean the antenna re-locate SITRANS LR250 	
Display shows S: 0 LOE	location or aiming: • poor installation • flange not level • Auto False Echo Suppression may be incorrectly applied	 check to ensure nozzle is vertical ensure end of antenna protrudes from end of nozzle review Auto False Echo Suppression (Page 253). ensure Auto False Echo Suppression Range is set correctly 	
Display shows S: 0 LOE	 antenna malfunction: temperature too high physical damage excessive foam multiple echoes 	 check Current Internal Temperature (3.2.1.) use foam deflector or stillpipe relocate use a defoamer set Algorithm (2.8.4.1.) to F (First echo) 	
Reading does not change, but the level does	SITRANS LR250 processing wrong echo, for example, vessel wall, or structural member	 re-locate SITRANS LR250 check nozzle for internal burrs or welds rotate device 90° use Auto False Echo Suppression (2.8.7.1.) if necessary: see Auto False Echo Suppression (Page 253). 	
Measurement is consistently off by a constant amount	 setting for Low Calibration Pt. (2.3.1.) not correct setting for Sensor Offset (2.3.3.) not correct 	check distance from sensor reference point to Low Calibration Pt. (2.3.1.) check Sensor Offset (2.3.3.)	
Screen blank	power error too much load resistance	 check nameplate rating against voltage supply check power wiring or source change barrier type, or remove something from the loop, or 	
		increase supply voltagereduce wire distance or use larger gage wire	

Symptom	Cause	Action
Reading erratic	echo confidence weak	 refer to Confidence (2.8.6.1.) use Auto False Echo Suppression (2.8.7.1.) and Auto False Echo Suppression Range (2.8.7.2.) use foam deflector or stillpipe
	liquid surface vortexed	 decrease Fill Rate per Minute (2.4.2.) relocate device to side pipe increase confidence threshold in Echo Threshold (2.8.4.3.)
	material filling	Re-locate SITRANS LR250
Reading response slow	Fill Rate per Minute (2.4.2.) setting incorrect	increase measurement response if possible
Reads correctly but occasionally reads high when vessel is not full	detecting close range echobuild up near top of vessel or nozzlenozzle problem	 clean the antenna use Auto False Echo Suppression (2.8.7.1.) and Auto False Echo Suppression Range (2.8.7.2.)
Level reading lower than actual material level	material is within Near Range zonemultiple echoes processed	 decrease Near Range (2.8.1.) (minimum value depends on antenna type) raise SITRANS LR250 ensure Algorithm (2.8.4.1.) is set to F (First echo)
	vessel near empty and low dK material	 ensure Material (2.2.3.) selection is LIQUID LOW DK set Position Detect (2.8.4.2.) to Hybrid set CLEF Range (2.8.4.4.) to 0.5 m

10.4 Operation troubleshooting

Technical data

Note

• Siemens makes every attempt to ensure the accuracy of these specifications but reserves the right to change them at any time.

11.1 Power

\triangle	General Purpose Intrinsically Safe Non-Sparking Non-incendive (FM/CSA US/Canada only)	Nominal 24 V DC at 550 Ohm
\triangle	Flameproof Increased Safety Explosion-proof (FM/CSA US/Canada only)	Nominal 24 V DC at 250 Ohm

- Maximum 30 V DC
- 4 to 20 mA
- Max. startup current see Startup Behaviour (Page 276).

11.2 Performance

Reference operating conditions according to IEC 60770-1

Ambient temperature	15 to 25 °C (59 to 77 °F)
Humidity	45 to 75% relative humidity
Ambient pressure	860 to 1060 mbar a (86000 to 106000 N/m ² a)
Interference reflections	minimum 20 dB lower than the main target reflections

11.2 Performance

Measurement Accuracy (measured in accordance with IEC 60770-1)

Maximum measured error	= 3 mm (0.12") ^{1) 2) 3)} including hysteresis and non-repeatability		
Frequency	K-band		
Maximum measurement range ⁴⁾	1.5" antenna	10 m (32.8 ft) ⁵⁾	
	2" threaded PVDF antenna		
	2"/DN50/50A Flanged encapsulated antenna (FEA)		
	2" ISO 2852, DN50 DIN 11864- 1/2/3, DN50 DIN11851, Tuchenhagen Types F and N Hygienic encapsulated antenna (HEA)		
	all other versions	20 m (65.6 ft)	
Minimum detectable distance	50 mm (2") from end of antenna ⁶⁾	•	
Update time ⁷⁾	minimum 1 second, depending on se Response Rate (2.4.1.) and LCD Fas		
Influence of ambient temperature	< 0.003%/K (average over full temperature range, referenced to maximum range)		
Dielectric constant of material measured	dK > 1.6 [antenna and application dependent ⁸⁾]		
Memory	non-volatile EEPROM		
	no battery required		

¹⁾ The statistical accuracy is typically 3 mm (0.12") 90% of the time, when tested in accordance with IEC 60770-1.

See Flanged horn antenna (Page 208).

See Flanged encapsulated antenna (3"/DN80/80A sizes and larger) (Page 214).

See Hygienic encapsulated antenna (2" ISO 2852 sanitary clamp) (Page 216).

²⁾ Under severe EMI/EMC environments per IEC 61326-1 or NAMUR NE21, the device error may increase to a maximum of 10 mm (0.4").

³⁾ For 2" threaded PVDF, Flanged encapsulated antennas and Hygienic encapsulated antennas, the maximum measured error <500 mm from the sensor reference point =25 mm (1").

⁴⁾ From sensor reference point: see Dimensions (Page 203).

^{5) 20} m (65.6 ft) possible in a stillpipe/bypass

⁶⁾ Minimum range is antenna length + 50 mm (2"). See Dimension drawings (Page 203).

⁷⁾ Reference conditions: Response Rate (2.4.1.) set to FAST, LCD Fast Mode (4.9.) set to ON.

⁸⁾ For 1.5" (40 mm) antenna, 2" (50 mm) threaded PVDF antenna, 2"/DN50/50A flanged encapsulated antenna, and 2" ISO 2852, DN50 DIN 11864-1/2/3, DN50 DIN11851, Tuchenhagen Types F and N hygienic encapsulated antenna the minimum dK is limited to 3 unless a stillpipe is used.

11.3 Interface

Analog output	Signal range	4 to 20 mA (± 0.02 mA accuracy) upper limit 20 to 23 mA adjustable
	Fail signal	3.6 mA to 23 mA [For more details, see Fail-safe Mode] (Page 259)
Communication:	Load	230 to 600 Ω , 230 to 500 Ω when connecting a coupling module
HART ¹⁾	Max. line length	multi-wire: ≤ 1500 m (4921 ft)
	Protocol	HART, Version 5.1
Configuration	Remote	Siemens SIMATIC PDM or AMS Device Manager (PC)
	Local	Siemens infrared handheld programmer, or HART handheld communicator
	Display (local) ²⁾	graphic LCD, with bar graph representing level

¹⁾ See A.6.3 for details on version exclusions

²⁾ Display quality will be degraded in temperatures below –25 °C (–13 °F) and above +65 °C (+149 °F).

11.4 Mechanical

11.4 Mechanical

Process connection:	Threaded connection	1.5" NPT (ASME B1.20.1), R (BSPT, EN 10226-1) a) or G (BSPP, EN ISO 228-1) or 2" NPT (ASME B1.20.1), R (BSPT, EN 10226-1) or G (BSPP, EN ISO 228-1) or 3" NPT (ASME B1.20.1), R (BSPT, EN 10226-1) or G (BSPP, EN ISO 228-1)		
	Flange connection (flat-face)	2, 3, 4" (ASME 150 lb, 300 lb) DN50, DN80, DN100 (PN10/16, PN25/40) 50A, 80A, 100A (JIS 10K)		
	Materials	316L /1.4404 or 316L /1.4435 stainless steel		
	Flange connection (raised face)	DN50, DN80, DN100, DN150 (PN10/16, PN25/40)		
	Materials	1.4404 or 1.4435 stainless steel, optional Alloy N06022/2.4602 (Hastelloy®C-22 or equivalent)		
	Flanged encapsulated antenna (FEA) connection (raised face)	2, 3, 4, 6" (ASME 150 lb); DN50, DN80, DN100, DN150 (PN10/16); 50A, 80A, 100A, 150A (JIS 10K)		
	Materials	316L /1.4404 or 316L /1.4435 stainless steel		
	Hygienic encapsulated antenna (HEA)	ISO 2852 (2, 3, 4")		
	connection	DIN 11851 (DN50, DN80, DN100)		
		DIN 11864-1/2/3 (DN50, DN80, DN100)		
	Materials	Tuchenhagen (Type F [50 mm] and Type N [68 mm]) 316L /1.4404 or 316L /1.4435 stainless steel		
		ISO 2852 (2, 3, 4") clamp: 304/1.4301 stainless steel DN80, DN100)		
		Tuchenhagen (Type F [50 mm] and Type N [68 mm]) clamp: 304/1.4301 stainless steel		
		[68 mm]) 316L /1.4404 or 316L /1.4435 stainless steel		
		DIN 11851/11864-1 captive slotted nut connection: 304L/1.4307		
		DIN 11864-2 (DN50, DN80, DN100) mounting nuts and bolts: 304/1.4301 stainless steel		

r			
Antenna:	Horn	standard 1.5" (40 mm), 2" (50 mm), 3" (80 mm), and 4" (100 mm) horn, optional 100 mm (4") horn extension	
	Materials	extension	
		316L stainless steel with PTFE emitter optional Alloy N06022/2.4602 (Hastelloy®C-22 or equivalent) with PTFE emitter	
	Threaded PVDF antenna	2" (50 mm)	
	Wetted materials	PVDF (Polyvinylidene fluoride)	
	Flanged encapsulated antenna	316L /1.4404 or 316L /1.4435 stainless steel	
	Wetted materials	TFM [™] 1600 PTFE lens	
	Hygienic encapsulated antenna	316L/1.4404 or 316L/1.4435 stainless steel	
	Wetted material	TFM [™] 1600 PTFE (plus chosen seal)	
Enclosure	Construction	aluminum, polyester powder-coated	
	Conduit entry	2 x M20x1.5, or 2 x ½" NPT	
	Ingress protection	Type 4X/NEMA 4X, Type 6/NEMA 6, IP67, IP68	
Weight (excluding extensions):	1.5" threaded connection with 1.5" horn antenna	approximately 5.1kg (11.2 lb)	
	2" threaded connection with 2" horn antenna	approximately 5.5 kg (12.1 lb)	
	3" threaded connection with 3" horn antenna	approximately 7.0 kg (15.4 lb)	
	2" threaded PVDF antenna	approximately 3.3 kg (7.3 lb)	
	DN50 PN10/16 or 2" 150 lb flat-face flange with 2" horn antenna	approximately 8 kg (17.6 lb)	
	DN100 PN25/40 or 4" ASME 300 lb flat-face flange with 4" horn antenna	approximately 17.4 kg (38.3 lb)	
	DN50 PN10/16 raised-face flange with 2" horn antenna	approximately 6 kg (13.2 lb)	
	DN100 PN25/40 raised-face flange with 4" horn antenna	approximately 11.3 kg (24.9 lb)	
	2" ASME 150 lb FEA	approximately 7.0 kg (15.4 lb)	
	3" ASME 150 lb FEA	approximately 10.7 kg (23.6 lb)	
	4" ASME 150 lb FEA	approximately 13.1 kg (28.9 lb)	
	6" ASME 150 lb FEA	approximately 17.7 kg (39 lb)	
	DN50 PN10/16 FEA	approximately 7.1 kg (15.7 lb)	
	DN80 PN10/16 FEA	approximately 10.1 kg (22.3 lb)	
	DN100 PN10/16 FEA	approximately 11.1 kg (24.5 lb)	
	DN150 PN10/16 FEA	approximately 15.9 kg (35.1 lb)	
	50 A JIS 10K FEA	approximately 6.5 kg (14.3 lb)	
t	· ·	· · · · · · · · · · · · · · · · · · ·	

11.4 Mechanical

80 A JIS 10K FEA	approximately 9 kg (19.8 lb)
100 A JIS 10K FEA	approximately 10.1 kg (22.3 lb)
150 A JIS 10K	approximately 16.3 kg (35.9 lb)
2" ISO2852 HEA	approximately 4.7 kg (10.4 lb)
3" ISO2852 HEA	approximately 6.3 kg (13.9 lb)
4" ISO2852 HEA	approximately 6.8 kg (15 lb)
DN50 DIN 11864-1 HEA	approximately 4.8 kg (10.6 lb)
DN80 DIN 11864-1 HEA	approximately 6.7 kg (14.8 lb)
DN100 DIN 11864-1 HEA	approximately 7.1 kg (15.7 lb)
DN50 DIN 11864-2 HEA	approximately 5.0 kg (11 lb)
DN80 DIN 11864-2 HEA	approximately 7.2 kg (15.9 lb)
DN100 DIN 11864-2 HEA	approximately 7.9 kg (17.4 lb)
DN50 DIN 11864-3 HEA	approximately 4.8 kg (10.6 lb)
DN80 DIN 11864-3 HEA	approximately 6.6 kg (14.6 lb)
DN100 DIN 11864-3 HEA	approximately 7.2 kg (15.9 lb)
DN50 DIN 11851 HEA	approximately 4.8 kg (10.6 lb)
DN80 DIN 11851 HEA	approximately 6.8 kg (15 lb)
DN100 DIN 11851 HEA	approximately 7.2 kg (15.9 lb)
Tuchenhagen Type F HEA	approximately 4.8 kg (10.6 lb)
Tuchenhagen Type N HEA	approximately 4.9 kg (10.8 lb)

a) For use with 1.5" (40 mm) horn antennas only.

11.5 Environmental

Note

- For the specific configuration you are about to use or install, check transmitter nameplate and see Approvals (Page 200).
- Use appropriate conduit seals to maintain IP or NEMA rating.

Location	indoor/ outdoor
Altitude	5000 m (16,404 ft) max.
Ambient temperature	-40 to +80 °C (-40 to +176 °F)
Relative humidity	suitable for outdoor
	Type 4X/NEMA 4X, Type 6/NEMA 6, IP67, IP68 enclosure (see note above)
Installation category	1
Pollution degree	4

11.6 Process

Note

The maximum temperature is dependent on the process connection, antenna materials, and vessel pressure. For more detailed information see Maximum Process Temperature Chart (Page 260) and Process Pressure/Temperature derating curves (Page 261).

Temperature at process connection	Standard Horn antenna (Threaded	with FKM O- ring	-40 to +200 °C (-40 to +392 °F)	
	or Flanged):	with FFKM O- ring	-20 to +200 °C (-4 to +392 °F)	
	2" NPT / BSPT / G Thantenna:	readed PVDF	-40 to +80 °C (-40 to +176 °F)	
	Flanged encapsulated antenna (FEA)		-40 to +170 °C (-40 to +338 °F)	
	Hygienic encapsulated antenna (HEA)		-40 to +170 °C (-40 to +338 °F)	
			with FKM seals used on process connection: -20 to +170 °C (-4 to +338 °F)	
			with EPDM seals used on process connection: - 40 to +120 °C (-40 to +248 °F)	
Pressure (vessel)			Refer to process connection tag and Process Pressure/Temperature derating curves (Page 263).	

11.7 Approvals

11.7 Approvals

Note

The device nameplate lists the approvals that apply to your device.

Application type	LR250 version	Approval rating	Valid for:	
Non-hazardous	General purpose	CSAus/c, FM, CE, RCM	N. America, Europe	
	Radio	Europe (R&TTE), FCC, Industry Canada		
Hazardous	Intrinsically safe (Page 43)	ATEX II 1G, Ex ia IIC T4 Ga ATEX II 1D, Ex ia ta IIIC T100°C Da	Europe	
		IECEx SIR 05.0031X, Ex ia IIC T4 Ga Ex ia ta IIIC T100 °C Da	International	
		FM/CSA Class I, Div. 1, Groups A, B, C, D Class II, Div. 1, Groups E, F, G Class III T4	US/Canada	
		INMETRO: DNV 12.0087 X Ex ia IIC T4 Ga Ex ia ta IIIC T100 °C Da IP65/IP67 -40 °C ≤ Ta ≤ +80 °C DNV #OCP 0017 ABNT NBR IEC 60079-0:2008, ABNT NBR IEC 60079-11:2009, ABNT NBR IEC 60079-26:2008, ABNT NBR IEC 60079-31:2011	Brazil	
		NEPSI Ex ia IIC T4 Ga Ex iaD 20 T90 IP67 DIP A20 T _A 90 °C	China	
	Non-Sparking	ATEX II 3 G, Ex nA IIC T4 Gc	Europe	
	(Page 45)	NEPSI Ex nA IIC T4 Gc	China	
	Non-incendive (Page 45)	FM/CSA Class I, Div. 2, Groups A, B, C, D T5	US/Canada	
	Flameproof (Page 46)	ATEX II 1/2 GD, 1D, 2D IECEx SIR 08.0107X Ex d mb ia IIC T4 Ga/Gb Ex ia ta IIIC T100 °C Da	Europe and International	

Application type	LR250 version	Approval rating	Valid for:
		INMETRO: DNV 12.0088 X Ex d ia mb IIC T4 Ga/Gb Ex ia ta IIIC T100 °C Da IP67 -40 °C ≤ Ta ≤ +80 °C Um = 250 V DNV #OCP 0017 ABNT NBR IEC 60079-0:2008, ABNT NBR IEC 60079-1:2009, ABNT NBR IEC 60079-11:2009, ABNT NBR IEC 60079-18:2010, ABNT NBR IEC 60079-26:2008, ABNT NBR IEC 60079-31:2011	Brazil
	Increased safety (Page 47)	ATEX II 1/2 GD, 1D, 2D IECEx SIR 08.0107X Ex e mb ia IIC T4 Ga/Gb Ex ia ta IIIC T100 °C Da	Europe and International
		INMETRO: DNV 12.0088 X Ex e ia mb IIC T4 Ga/Gb Ex ia ta IIIC T100 °C Da IP67 -40 °C \leq Ta \leq +80 °C U _m = 250 V DNV #OCP 0017 ABNT NBR IEC 60079-0:2008, ABNT NBR IEC 60079-7:2008, ABNT NBR IEC 60079-11:2009, ABNT NBR IEC 60079-18:2010, ABNT NBR IEC 60079-26:2008, ABNT NBR IEC 60079-31:2011	Brazil
	Flameproof (Page 46)/ Increased safety (Page 47)	NEPSI Ex d ia mb IIC T4 Ga/Gb / Ex e ia mb IIC T4 Ga/Gb Ex iaD 20 T90 IP67 DIP A20 T _A 90 °C	China
	Explosion proof (Page 47)	FM/CSA Class I, Div. 1, Groups A, B, C, D Class II, Div. 1, Groups E, F, G Class III T4	US/Canada
	Marine	Lloyd's Register of Shipping ABS Type Approval BV Type Approval	
Hygienic/Sanitary		EHEDG EL Class I EHEDG EL Class I Aseptic 3-A Sanitary Standards	International

11.8 Programmer (infrared keypad)

Note

Battery is non-replaceable with a lifetime expectancy of 10 years in normal use. To estimate the lifetime expectancy, check the nameplate on the back for the serial number. The first six numbers show the production date (mmddyy), for example, serial number 032608101V was produced on March 26, 2008.

Siemens Milltronics Infrared IS (Intrinsically Safe) Handheld Programmer for hazardous and all other locations (battery is non-replaceable).

Approvals CE

FM/CSA Class I, II, III, Div. 1, Gr. A to G T6

ATEX II 1GD Ex ia IIC T4 Ga

Ex iaD 20 T135 °C IECEx Ex ia IIC T4 Ga Ex iaD 20 T135 °C INMETRO Ex ia IIC T4 Ga Ex ia IIIC T135 °C Da

Weight 150 g (0.3 lb)

Color black

Part number 7ML1930-1BK

Dimension drawings 12

12.1 Threaded horn antenna

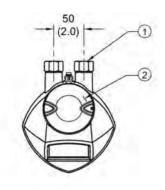
Note

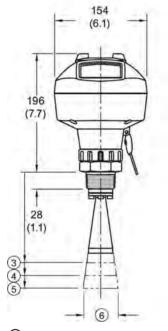
 Process temperature and pressure capabilities are dependent upon information on the process connection tag. Reference drawing listed on the tag is available for download from our website under Support/Installation drawings/Level Measurement/Continuous -Radar/LR250:

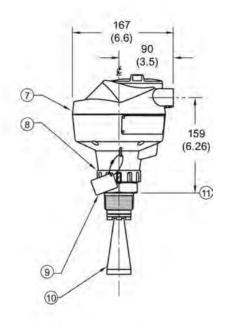
Product page (http://www.siemens.com/LR250)

- Process connection drawings are also available for download from the Installation Drawings page.
- Signal amplitude increases with horn diameter, so use the largest practical size.
- Optional extensions can be installed below the threads.

12.1 Threaded horn antenna







- ① 1/2" NPT cable entry, or M20 cable gland
- 2 threaded cover
- 3 2" horn
- 4 3" horn
- 5 4" horn
- 6 horn O.D.
- Dimensions in mm (inch)

- O enclosure/electronics
- 8 retaining collar
- 9 process connection tag
- 10 horn
- 1 sensor reference point

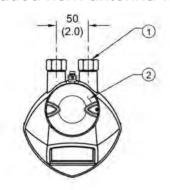
Threaded horn dimensions

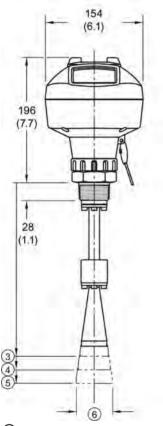
Antenna Antenna Type O.D. in mm (inch)	Height to sensor reference point, in mm (inch) a)			Beam Angle	Measurement	
	1-1/2" threaded connection	2" threaded connection	3" threaded connection	(°)b)	range, in m (ft)	
1.5"	39.8 (1.57)	135 (5.3)	N/A	N/A	19	10 (32.8)
2"	47.8 (1.88)	N/A	166 (6.55)	180 (7.09)	15	20 (65.6)
3"	74.8 (2.94)	N/A	199 (7.85)	213 (8.39)	10	20 (65.6)
4"	94.8 (3.73)	N/A	254 (10)	268 (10.55)	8	20 (65.6)

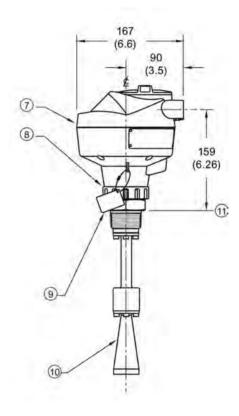
^{a)} Height from bottom of horn to sensor reference point as shown: see dimension drawing.

^{b)} -3dB in the direction of the polarization axis. For an illustration, see Polarization reference point (Page 31).

12.2 Threaded horn antenna with extension







- ① 1/2" NPT cable entry, or M20 cable gland
- 2 threaded cover
- 3 2" horn
- (4) 3" horn
- 5 4" horn
- 6 horn O.D.

Dimensions in mm (inch)

- 7 enclosure/electronics
- 8 retaining collar
- 9 process connection tag
- 10 horn
- sensor reference point

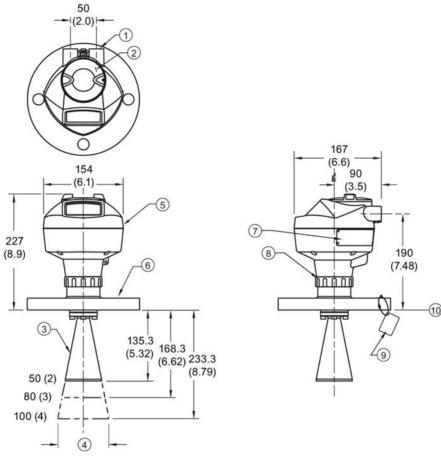
Threaded horn with extension dimensions

Antenna Antenna Type O.D. in mm (inch)	Height to sensor reference point, in mm (inch) a)			Beam Angle	Measurement	
	in mm	1-1/2" threaded connection	2" threaded connection	3" threaded connection	(°) b)	range in m (ft)
1.5"	39.8 (1.57)	235 (9.25)	N/A	N/A	19	10 (32.8)
2"	47.8 (1.88)	N/A	266 (10.47)	280 (11.02)	15	20 (65.6)
3"	74.8 (2.94)	N/A	299 (11.77)	313 (12.32)	10	20 (65.6)
4"	94.8 (3.73)	N/A	354 (13.94)	368 (14.49)	8	20 (65.6)

a) Height from bottom of horn to sensor reference point as shown: see dimension drawing.

^{b)} -3dB in the direction of the polarization axis. For an illustration, see Polarization reference point (Page 31).

Flanged horn antenna 12.3



- 1 1/2" NPT cable entry, or M20 cable gland
- 2 threaded cover
- 3 horn
- 4 horn O.D.
- (5) enclosure/electronics

Dimensions in mm (inch)

- 6 flange
- 7 name-plate 8
 - retaining collar
- 9 process connection tag
- 10 sensor reference point

Flanged Horn dimensions

Nominal horn size	Horn O.D. in mm (inch)	Height to sensor reference point, in mm (inch) ^{a)}		Beam angle (°) ^{b)}	Measurement range, in m (ft)	
in mm (inch)		Stainless steel flange: raised or flat-face	Optional alloy flange ^{c)}			
50 (2)	47.8 (1.88)	135.3 (5.32)	138.3 (5.44)	15		
80 (3)	74.8 (2.94)	168.3 (6.62)	171.3 (6. 74)	10	— 20 (4F 4)	
100 (4)	94.8 (3.73)	223.3 (8.79)	226.3 (8.90)	8	 20 (65.6)	

^{a)}Height from bottom of horn to sensor reference point as shown: see Flanged horn antenna with extension (Page 210). See also Raised-Face flange per EN 1092-1 for flanged horn antenna (Page 235), or Flat-Face flange (Page 240).

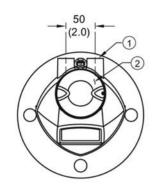
Note

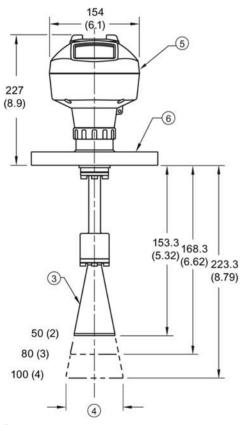
Heights to sensor reference point are for stainless steel flanges. For optional alloy N06022/2.4602 (Hastelloy® C-22 or equivalent) see Flanged Horn dimensions above.

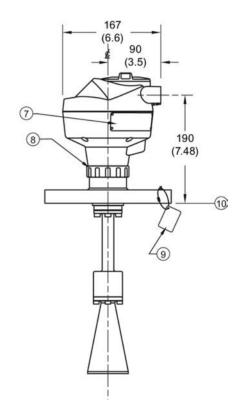
^{b)} -3dB in the direction of the polarization axis (see Polarization reference point (Page 31) for an illustration).

c) Optional alloy N06022/2.4602 (Hastelloy® C-22 or equivalent). See Raised-Face Flange Dimensions (Page 235).

12.4 Flanged horn antenna with extension







- ① ½" NPT cable entry, or M20 cable gland
- 2 threaded cover
- 3 horn
- 4 horn O.D.
- 6 enclosure/electronics

Dimensions in mm (inch)

- 6 flange
- name-plate
- 8 retaining collar
- 9 process connection tag
- sensor reference point

Flanged horn with extension dimensions

Nominal horn size	Horn O.D. in mm (inch)	Height to sensor reference point, in mm (inch) a)		Beam angle (°) ^{b)}	Measurement range, in m (ft)
in mm (inch)		Stainless steel flange: raised or flat-face	Optional alloy flange ^{c)}		
50 (2)	47.8 (1.88)	235.3 (9.26)	238.3 (9.38)	15	
80 (3)	74.8 (2.94)	268.3 (10.56)	271.3 (10.68)	10	— 20 (/F /)
100 (4)	94.8 (3.73)	323.3 (12.73)	326.3 (12.85)	8	

^{a)}Height from bottom of horn to sensor reference point as shown: See also Raised-Face flange per EN 1092-1 for flanged horn antenna (Page 235) or Flat-Face Flange. (Page 240)

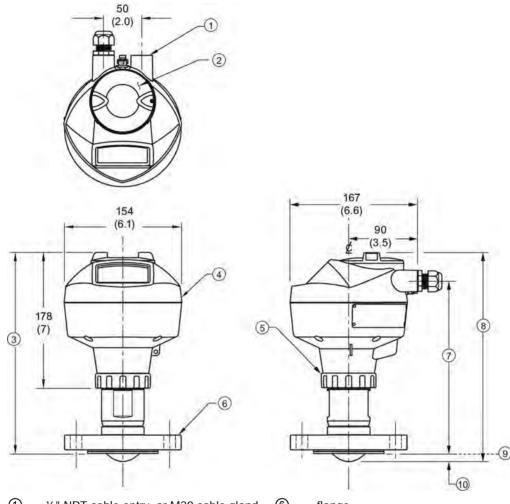
Note

Heights to sensor reference point are for stainless steel flanges. For optional alloy N06022/2.4602 (Hastelloy® C-22 or equivalent) see Flanged Horn dimensions above.

^{b)} -3dB in the direction of the polarization axis (see Polarization reference point (Page 31) for an illustration).

c) Optional alloy N06022/2.4602 (Hastelloy® C-22 or equivalent). See Raised-Face flange per EN 1092-1 for flanged horn antenna (Page 235).

12.5 Flanged encapsulated antenna (2"/DN50/50A sizes only)



- ① 1/2" NPT cable entry, or M20 cable gland
- 2 threaded cover
- 3 see table below
- 4 enclosure
- ⑤ retaining collar

Dimensions in mm (inch)

- 6 flange
- See table below
- 8 see table below
- 9 sensor reference point
- see table below

Flanged encapsulated antenna (2"/DN50/50A) dimensions

Flange size	3 mm (inch)	⑦ mm (inch)	8 mm (inch)	10 mm (inch)1)
2"/DN50/50A	263 (10.35)	223 (8.78)	274 (10.79)	11 (0.43)

¹⁾ Height from tip of lens to sensor reference point as shown.

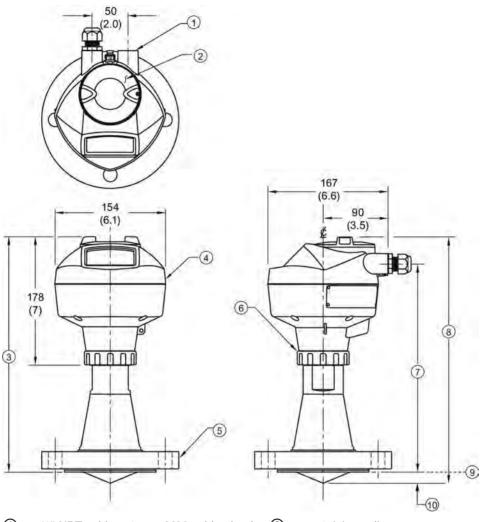
Flange size	Flange class	Flange O.D. [mm (inch)]	Antenna aperture size [mm (inch)]	Beam angle (°)1)	Measurement range [m (ft)]
2"	150 LB	152 (5.98)	50 (1.97)	12.8	10 (32.8)2)
DN50	PN10/16	165 (6.50)			
50A	10K	155 (6.10)			

^{1) -3} dB in the direction of the polarization axis.

See Raised-Face Flange per EN 1092-1, (Page 237) and Polarization reference point (Page 31).

^{2) 20}m if installed in stillpipe

12.6 Flanged encapsulated antenna (3"/DN80/80A sizes and larger)



- ① 1/2" NPT cable entry, or M20 cable gland
- 2 threaded cover
- 3 see table below
- 4 enclosure
- ⑤ flange

Dimensions in mm (inch)

- 6 retaining collar
- The see table below
 The see table below
- 8 see table below
- 9 sensor reference point
- see table below

Flanged encapsulated antenna (3"/DN80/80A and larger) dimensions

Flange size	3 mm (inch)	⑦ mm (inch)	® mm (inch)	10 mm (inch)1)
3"/DN80/80A	328 (12.91)	288 (11.34)	343 (13.50)	15 (0.59)
4"/DN100/100A	328 (12.91)	288 (11.34)	343 (13.50)	13 (0.51)
6"/DN150/150A	333 (13.11)	293 (11.54)	348 (13.70)	15 (0.59)

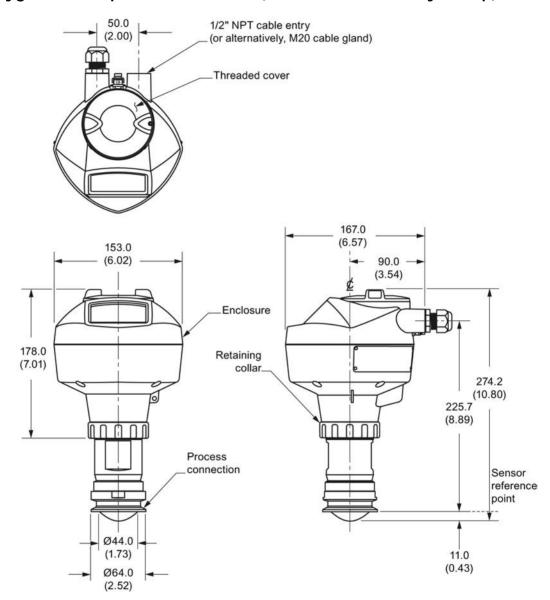
Height from tip of lens to sensor reference point as shown. See also Raised-Face Flange per EN 1092-1.

Flange size	Flange class	Flange O.D. [mm (inch)]	Antenna aperture size [mm (inch)]	Beam angle (°)1)	Measurement range [m (ft)]
3"	150 LB	190 (7.48)	75 (2.95)	9.6	20 (65.6)
DN80	PN10/16	200 (7.87)			
80A	10K	185 (7.28)			
4"	150 LB	230 (9.06)	75 (2.95)	9.6	20 (65.6)
DN100	PN10/16	220 (8.66)			
100A	10K	210 (8.27)			
6"	150 LB	280 (11.02)	75 (2.95)	9.6	20 (65.6)
DN150	PN10/16	285 (11.22)			
150A	10K	280 (11.02)			

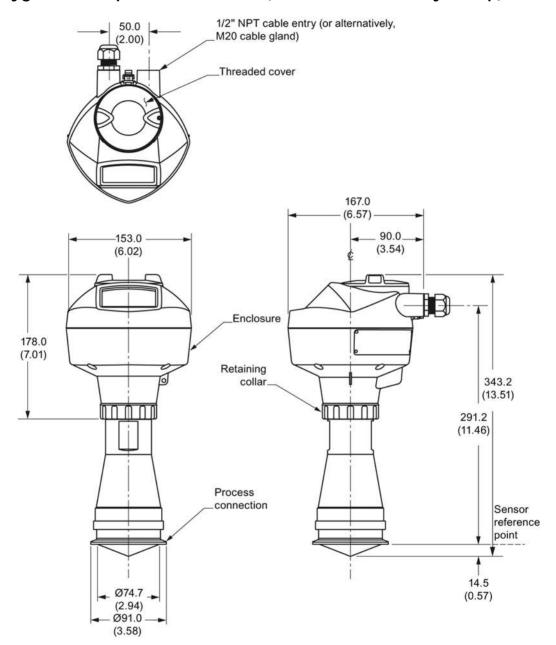
^{1) -3} dB in the direction of the polarization axis.

See Raised-Face Flange per EN 1092-1 (Page 237), and Polarization reference point (Page 31).

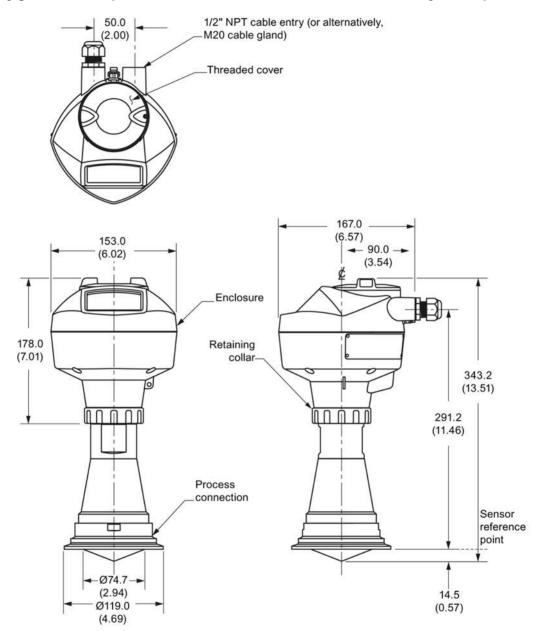
12.7 Hygienic encapsulated antenna (2" ISO 2852 sanitary clamp)



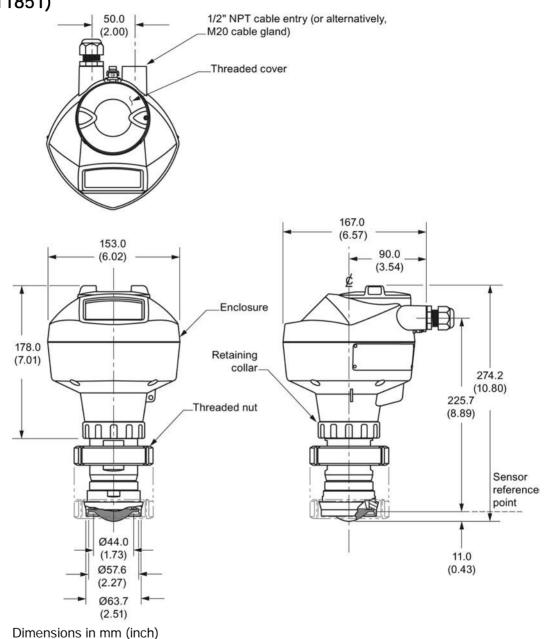
12.8 Hygienic encapsulated antenna (3" ISO 2852 sanitary clamp)



12.9 Hygienic encapsulated antenna (4" ISO 2852 sanitary clamp)

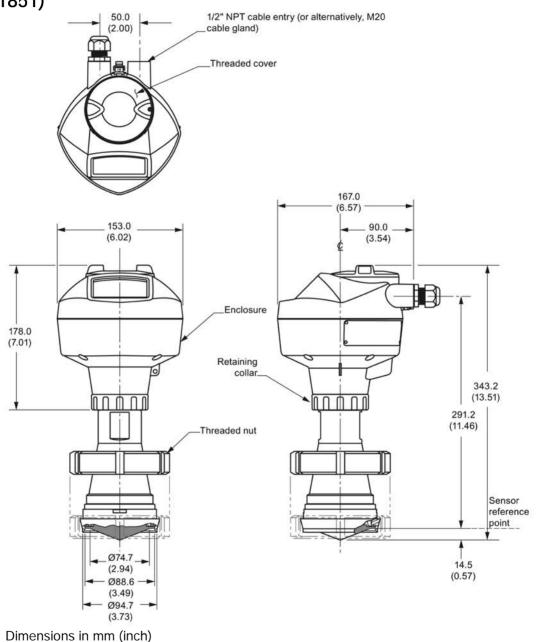


12.10 Hygienic encapsulated antenna (DN50 nozzle/slotted nut to DIN 11851)



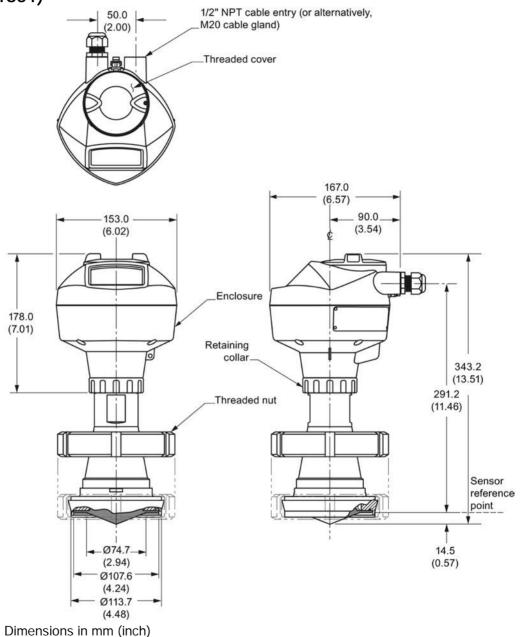
Note

12.11 Hygienic encapsulated antenna (DN80 nozzle/slotted nut to DIN 11851)



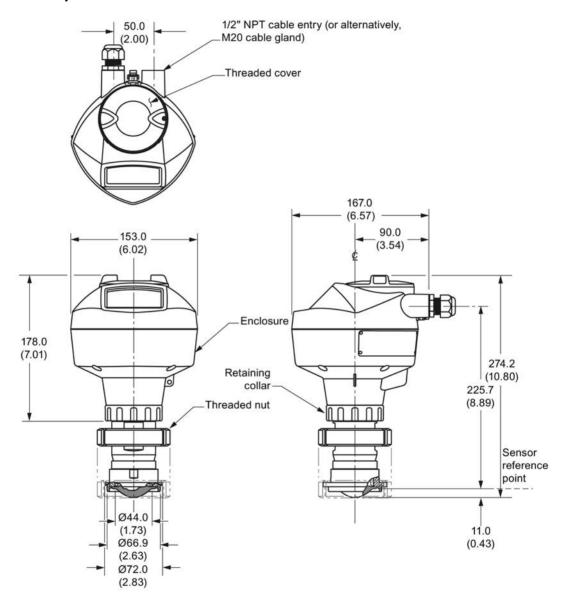
Note

12.12 Hygienic encapsulated antenna (DN100 nozzle/slotted nut to DIN 11851)



Note

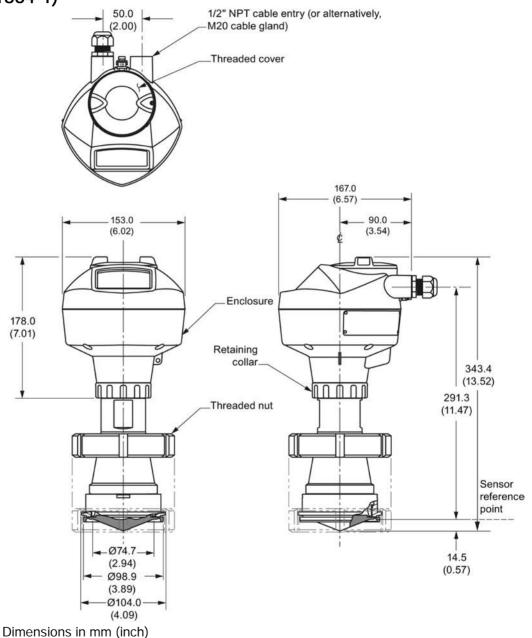
12.13 Hygienic encapsulated antenna (DN50 aseptic slotted nut to DIN 11864-1)



Dimensions in mm (inch)

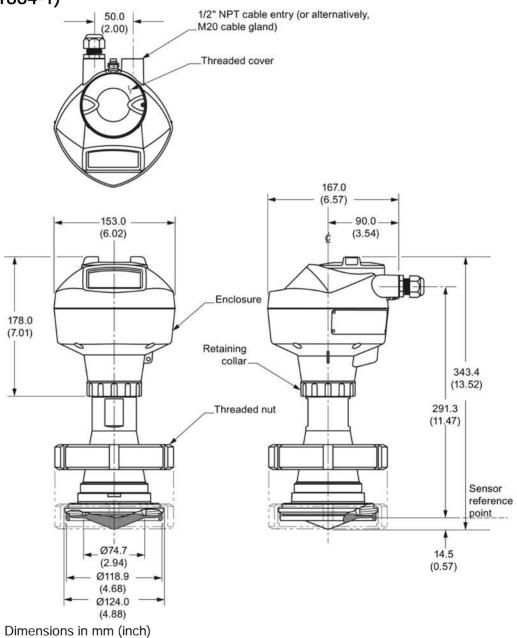
Note

12.14 Hygienic encapsulated antenna (DN80 aseptic slotted nut to DIN 11864-1)



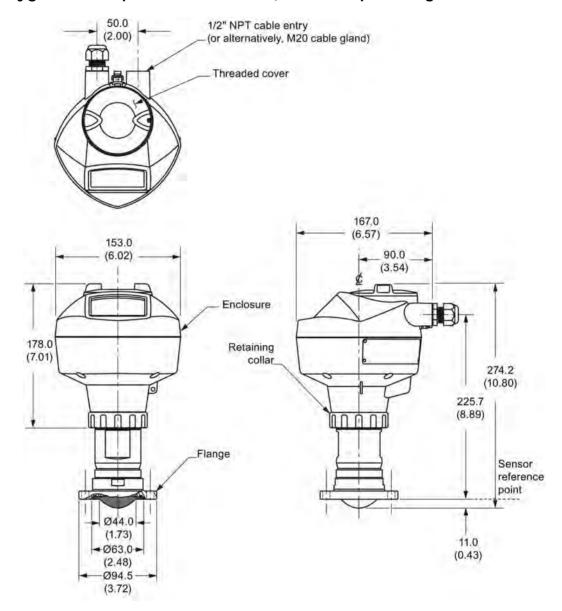
Note

12.15 Hygienic encapsulated antenna (DN100 aseptic slotted nut to DIN 11864-1)



Note

12.16 Hygienic encapsulated antenna (DN50 aseptic flange to DIN 11864-2)

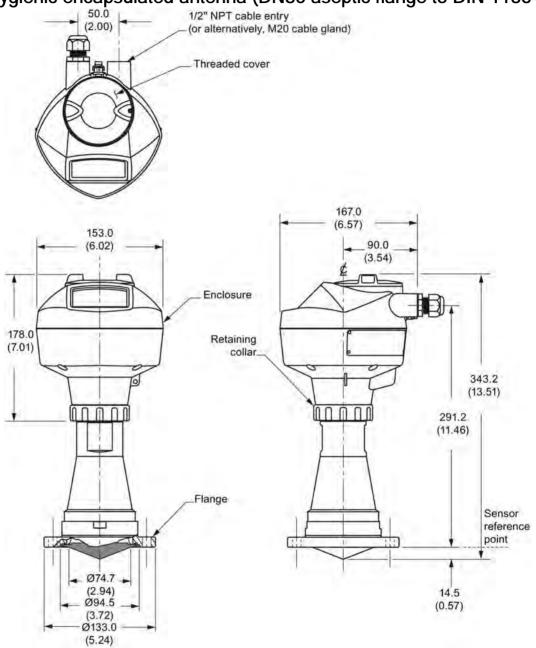


Dimensions in mm (inch)

Note

Cut out of process connection and flange are shown for illustration purposes only.

12.17 Hygienic encapsulated antenna (DN80 aseptic flange to DIN 11864-2)

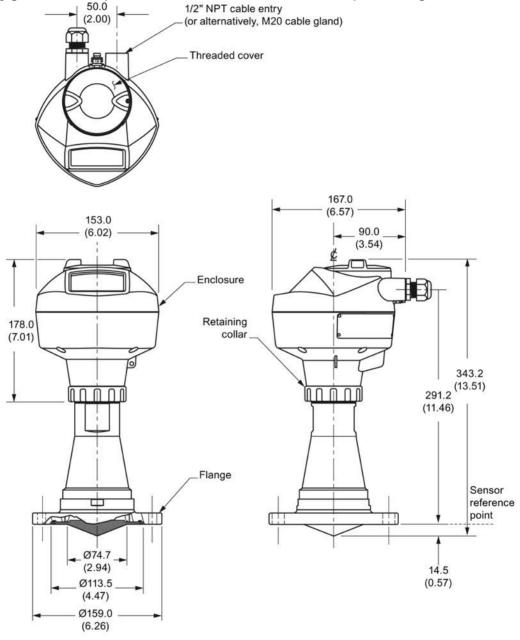


Dimensions in mm (inch)

Note

Cut out of process connection and flange are shown for illustration purposes only.

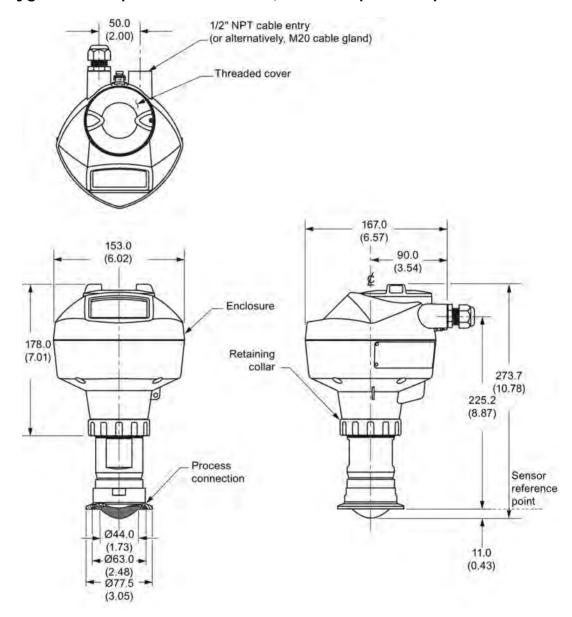
12.18 Hygienic encapsulated antenna (DN100 aseptic flange to DIN 11864-2)



<u>Dimensions in mm (inch)</u> **Note**

The cut out of the process connection and the flange are shown for illustration purposes only.

12.19 Hygienic encapsulated antenna (DN50 aseptic clamp to DIN 11864-3)

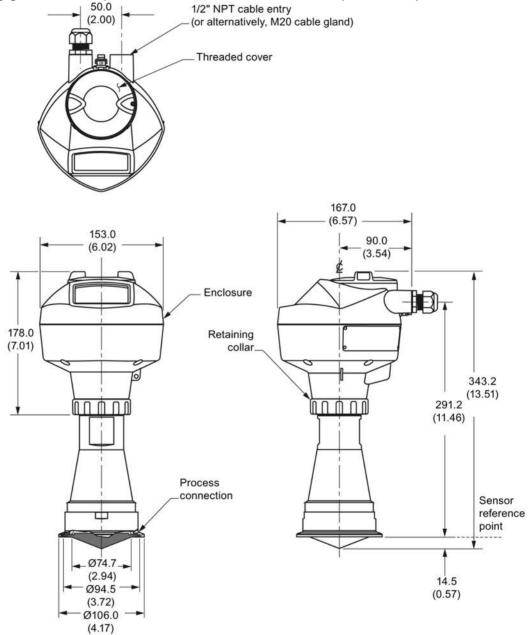


Dimensions in mm (inch)

Note

Cut out of process connection is shown for illustration purposes only.

12.20 Hygienic encapsulated antenna (DN80 aseptic clamp to DIN 11864-3)

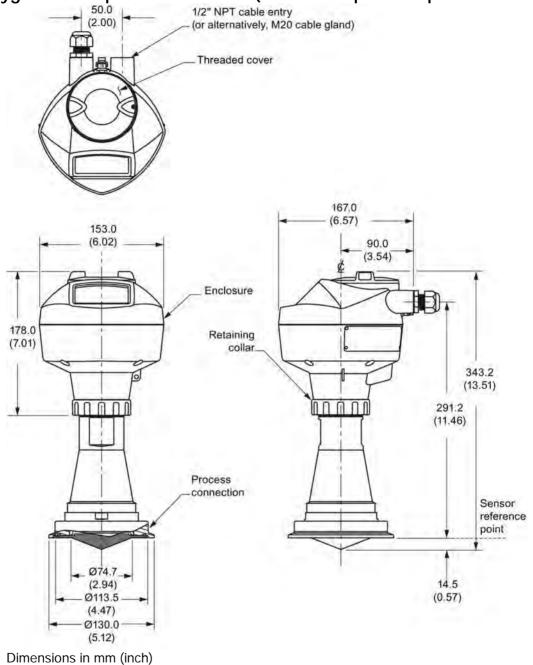


Dimensions in mm (inch)

Note

Cut out of process connection is shown for illustration purposes only.

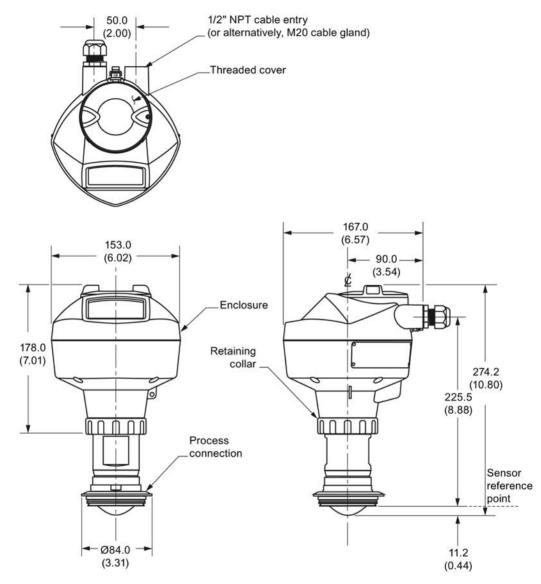
12.21 Hygienic encapsulated antenna (DN100 aseptic clamp to DIN 11864-3)



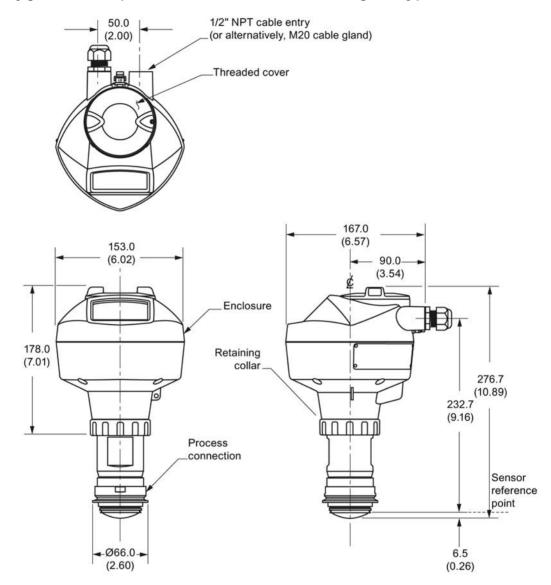
Note

Cut out of process connection is shown for illustration purposes only.

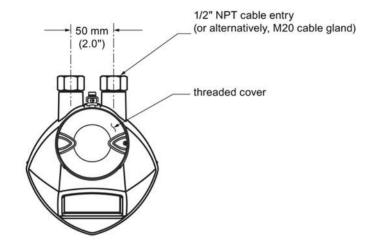
12.22 Hygienic encapsulated antenna (Tuchenhagen Type N)

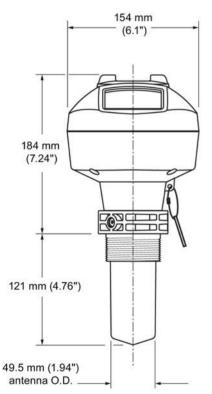


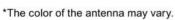
12.23 Hygienic encapsulated antenna (Tuchenhagen Type F)

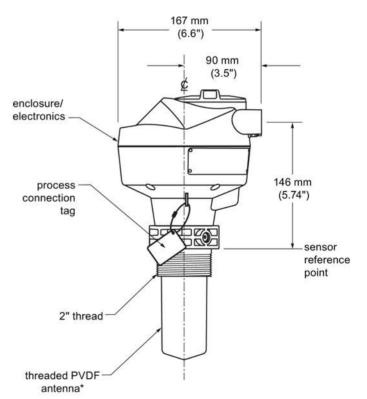


12.24 Threaded PVDF antenna









12.25 Threaded connection markings

Threaded PVDF antenna dimensions

Nominal antenna size	Antenna O.D.	Height to sensor reference point a)	Beam angle b)	Measurement range
50 mm (2")	49.5 mm (1.94")	121 mm (4.76")	19 degrees	10 m (32.8 ft) ^{c)}

a) Height from bottom of antenna to sensor reference point as shown: see dimension drawing.

12.25 Threaded connection markings

With the exception of the threaded PVDF antenna, threaded connection markings are found on the flat face/faces of the process connection.

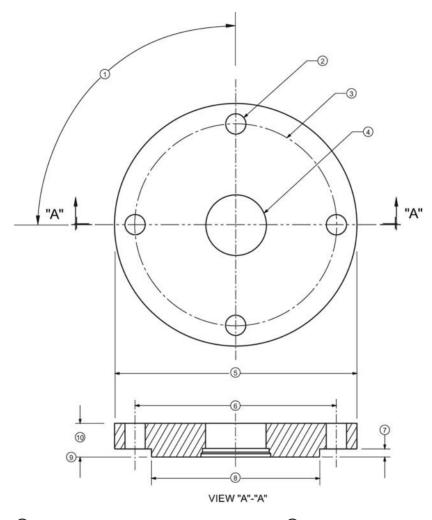
Serial number: a unique number allotted to each process connection, including the date of manufacture (MMDDYY) followed by a number from 001 to 999, (indicating the sequential unit produced).

^{b)} -3dB in the direction of the polarization axis. See Polarization reference point (Page 31) for an illustration.

c) 20m when installed in stillpipe.

12.26 Raised-Face flange per EN 1092-1 for flanged horn antenna

Stainless steel or optional alloy N06022/2.4602 (Hastelloy® C-22)



- 1 angle of adjacent bolt holes
- 2 bolt hole diameter
- 3 bolt hole circle diameter
- waveguide mounting hole
- 5 Flange O.D.

- 6 bolt hole circle diameter
 - facing height
- 8 facing diameter
- 9 sensor reference point
- 10 thickness

7

12.26 Raised-Face flange per EN 1092-1 for flanged horn antenna

Raised-Face flange dimensions

Pipe size	Flange bolt hole pattern	⑤ Flange O.D. (mm)	③ Bolt hole circle Ø (mm)	② Bolt hole Ø (mm)	No. of bolts	① Angle of adjacent bolt holes	⑧ Facing Ø (mm)	① Thickness (mm)
DN50	PN10/PN16	165	125	18	4	90	102	18
DN80	PN10/PN16	200	160	18	8	45	138	20
DN100	PN10/PN16	220	180	18	8	45	158	20
DN150	PN10/PN16	285	240	22	8	45	212	22
DN50	PN25/PN40	165	160	18	4	90	138	20
DN80	PN25/PN40	200	160	18	8	45	138	24
DN100	PN25/PN40	235	190	22	8	45	162	24
DN150	PN25/PN40	300	250	26	8	45	218	28

Raised-Face flange markings

Blind Flange Markings (Optional	Ма	chining Iden	tification	Welded A	Assembly Identi	fication a)
Manufacturer's Logo [optional]; Flange Standard; Nominal Size; Material; Heat Code)	Serial no.	Logo	Flange series	Flange series	Heat Code no.	Facing
Manufacturer's logo; EN 1092-1 05 'B1'; 'DN50' 'PN16' '1.4404 or 1.4435' A1B2C3	mmddyyx xx	*	xxxxx	xxxxx	A1B2C3	RF

^{a)} When flange material is alloy N06022/2.4602, additional material and heat code identification is provided.

The flange markings are located around the outside edge of the flange.

Serial number: a unique number allotted to each flange, including the date of manufacture

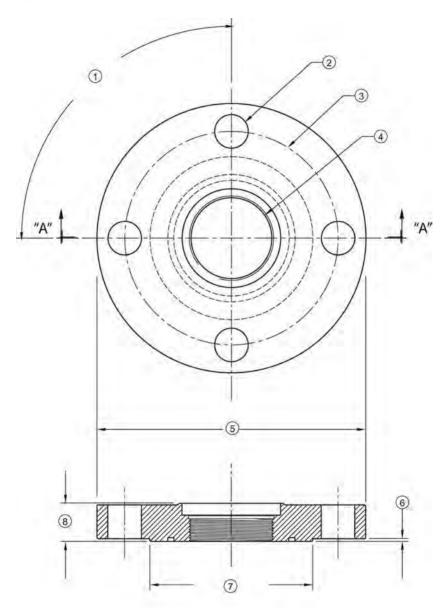
(MMDDYY) followed by a number from 001 to 999 (indicating the sequential

unit produced).

Flange series: the Siemens Milltronics drawing identification. Heat code: a flange material batch code identification.

12.27 Raised-Face flange per EN 1092-1 for flanged encapsulated antenna

Stainless steel



VIEW "A"-"A"

- 1 angle of adjacent bolt holes
- 2 bolt hole diameter
- 3 bolt hole circle diameter
- 4 antenna

- flange O.D.
- 6 facing height
- facing diameter
- 8 flange thickness

12.27 Raised-Face flange per EN 1092-1 for flanged encapsulated antenna

Raised-Face flange dimensions

Pipe size	Flange class	⑤ Flange O.D. [mm (inch)]	③ Bolt hole circle Ø [mm (inch)]	② Bolt hole Ø [mm (inch)]	No. of bolt holes	① Angle of adjacent bolt holes	⑦ Facing Ø [mm (inch)]	Flange thickness [mm (inch)]	⑥ Flange facing thickness [mm (inch)]
2"	150 LB	152 (5.98)	120.7 (4.75)	19 (0.75)	4	90	92.1 (3.63)	20.6 (0.81)	1.5 (0.06)
3"	_	190 (7.48)	152.4 (6.00)				127 (5.00)	25.9 (1.02)	2 (0.08)
4"	_	230 (9.06)	190.5 (7.50)		8	45	157.2 (6.19)		2 (0.08)
6"		280 (11.02)	241.3 (9.50)	22.2 (0.87)			215.9 (8.50)	26.9 (1.06)	1.5 (0.06)
DN50	PN10/16	155 (6.10)	125 (4.92)	18 (0.71)	4	90	102 (4.02)	18 (0.71)	2 (0.08)
DN80		200 (7.87)	160 (6.30)		8	45	138 (5.43)	20 (0.79)	2 (0.08)
DN100	_	220 (8.66)	180 (7.09)	_			158 (6.22)	_	2 (0.08)
DN150	-	285 (11.22)	240 (9.45)	22 (0.87)	_		212 (8.35)	22 (0.87)	2 (0.08)
50A	10K	155 (6.10)	120 (4.72)	19 (0.75)	4	90	96 (3.78)	16 (0.63)	2 (0.08)
80A	_	185 (7.28)	150 (5.91)	_	8	45	126 (4.96)	18 (0.71)	2 (0.08)
100A	_	210 (8.27)	175 (6.89)	_	_		151 (5.94)	_	2 (0.08)
150A	_	280 (11.02)	240 (9.45)	23 (0.91)	_		212 (8.35)	22 (0.87)	2 (0.08)

Raised-Face flange markings

Blind Flange Markings (Optional	Machining Identification			Welded Assembly Identification		
Manufacturer's Logo [optional]; Flange Standard; Nominal Size; Material; Heat Code)	Serial no.	Logo	Flange series	Flange series	Heat Code no.	Facing
Manufacturer's logo; EN 1092-1 05 'B1'; 'DN50' 'PN16' '1.4404 or 1.4435' A1B2C3	mmddyyx xx		XXXXX	XXXXX	A1B2C3	RF

The flange markings are located around the outside edge of the flange.

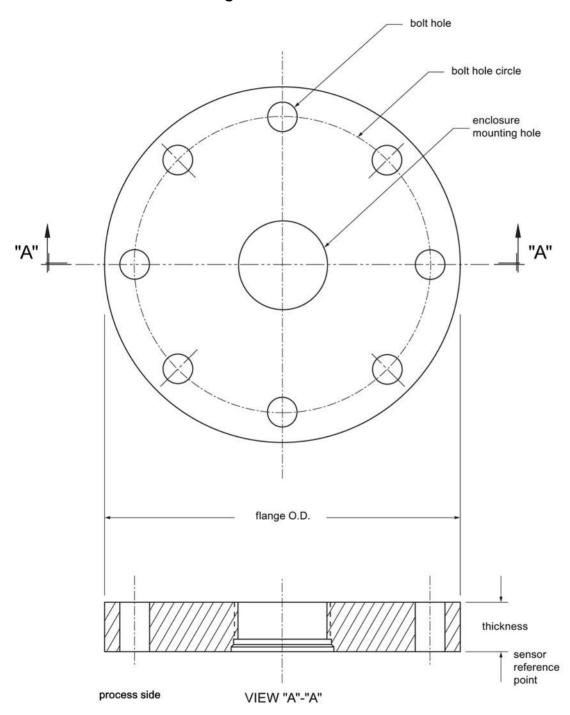
Serial number: a unique number allotted to each flange, including the date of manufacture

(MMDDYY) followed by a number from 001 to 999 (indicating the sequential

unit produced).

Flange series: the Siemens Milltronics drawing identification. Heat code: a flange material batch code identification.

12.28 Flat-Face flange



Flat-Face flange dimensions

Flange size ^{a)}	Flange class	Flange O.D.	Bolt hole circle Ø	Bolt hole Ø	No. of bolt holes	Thickness
2"	ASME 150 lb	6.0"	4.75"	0.75"	4	0.88"
3"	ASME 150 lb	7.5"	6.0"	0.75"	4	0.96"
4"	ASME 150 lb	9.0"	7.50"	0.75"	8	1.25"
2"	ASME 300 lb	6.50"	5.00"	0.75"	8	1.12"
3"	ASME 300 lb	8.25"	6.62"	0.88"	8	1.38"
4"	ASME 300 lb	10.00"	7.88"	0.88"	8	1.50"
DN50	EN PN16	165 mm	125 mm	18 mm	4	24.4 mm
DN80	EN PN16	200 mm	160 mm	18 mm	8	31.8 mm
DN100	EN PN16	220 mm	180 mm	18 mm	8	31.8 mm
DN50	EN PN40	165 mm	125 mm	18 mm	4	25.4 mm
DN80	EN PN40	200 mm	160 mm	18 mm	8	31.8 mm
DN100	EN PN40	235 mm	190 mm	22 mm	8	38.1 mm
50A	JIS 10K	155 mm	120 mm	19 mm	4	23.8 mm
80A	JIS 10K	185 mm	150 mm	19 mm	8	24.4 mm
100A	JIS 10K	210 mm	175 mm	19 mm	8	28.5 mm

^{a)} A 2" flange is designed to fit a 2" pipe: for actual flange dimensions see Flange O.D. Flange markings located around the outside edge of the flat faced flange identify the flange assembly on which the device is mounted.

12.28 Flat-Face flange

Flat-Face flange markings

Flat Face Flange Identification							Welded A	•
Serial No.	Logo	Flange series			Material	Heat	Flange	Heat code
		Series	Nominal	size		code	series	no.
MMDDYYXXX	**	25556	2	150	316L/ 1.4404 or	A1B2C3	25546	A1B2C3
			DN80	PN16	316L/ 1.4435			

Serial number: A unique number allotted to each flange, including the date of manufacture

(MMDDYY) followed by a number from 001 to 999 (indicating the sequential $\,$

unit produced).

Flange series: The Siemens Milltronics drawing identification.

Nominal size: The flange size followed by the hole pattern for a particular flange class. For

example:

• A 2 inch ASME B16.5 150 lb class flange (North America)

A DN80 EN 1092-1 PN16 class flange (Europe)

Material: The basic flange material (AISI or EU material designation). North American

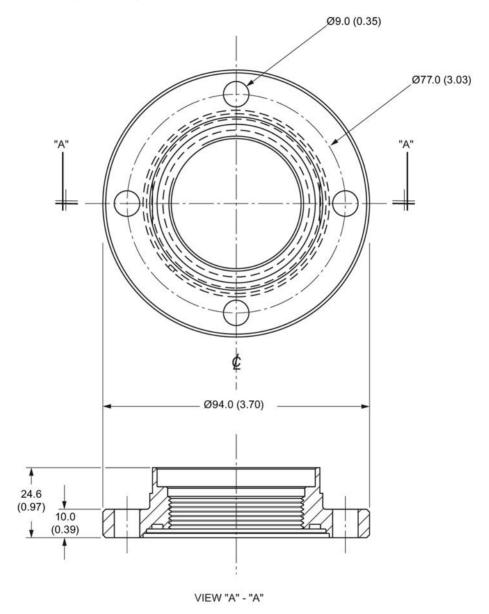
material codes are followed by European ones. For example, material

designation 316L/1.4404.

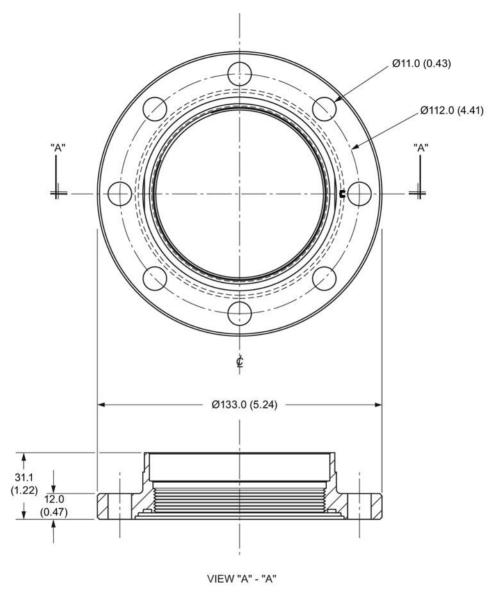
Heat code: A flange material batch code identification.

12.29 Aseptic/hygienic flange DN50, DN80, DN100 for DIN 11864-2

Aseptic/hygienic flange DN50

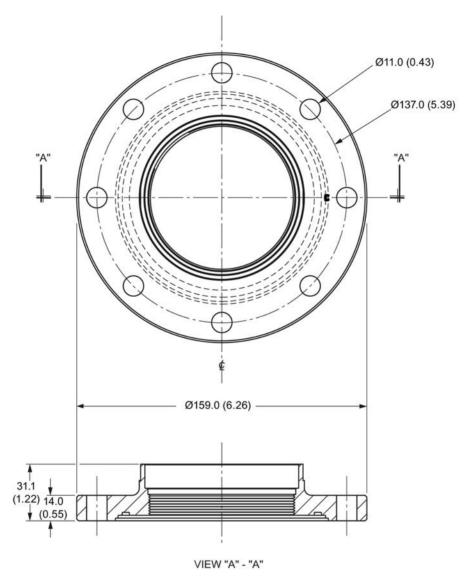


Aseptic/hygienic flange DN80



Dimensions in mm (inch)

Aseptic/hygienic flange DN100



12.30 Process connection tag (pressure rated versions)

12.30 Process connection tag (pressure rated versions)

For pressure-rated versions only, the process connection label lists the following information:

Process connection tag (pressure rated versions)

Item	Sample Text	Comments/Explanation
SERIAL#	GYZ / 00000000	Pressure Boundary Assembly
NOMINAL PIPE SIZE (DN)	4 INCH / 100mm	Nominal Pipe Size
INSTRUMENT MAWP (PS)	11.0 BAR	Maximum Allowable Working Pressure at Design Temperature for the device
DESIGN TEMP. (TS)	200 ℃	Maximum Allowable Working Temperature
MINIMUM PROCESS	15.9 BAR AT 40 °C	Minimum Wetted Process Conditions
TEST PRESSURE (PT)	22.7 BAR	Production Test Pressure
TEST DATE	10/11/11	Date of Pressure Test (Year/Month/Day)
CONNECTION SERIES	ASME B16.5	Flange Series: dimensional pattern based on ASME B16.5 flange standards
PROCESS SERIES	25546	Pressure Tag Family Series
WETTED NON-METALLICS	TFM	Antenna Emitter
WETTED METALLICS	316L	Process Connection Material(s)
WETTED SEALS	FKM	Seal Material(s)

- Minimum Wetted Process Conditions: the minimum pressure and temperature to which the
 device assembly may be exposed in the process, and continue to provide a pressureretaining function.
- Pressure Tag Family Series: the identification number used to indicate specific process connection information relating to operating conditions.
- For Flanged encapsulated antenna: this information is laser-etched on antenna body

BACK FACE		
Sample Text	Comments/Explanation	
CRN 0Fxxxxx.5	Canadian Registration Number (CRN)	

Appendix A: Technical reference



Note

Where a number follows the parameter name [for example, **Master Reset (4.1.)**] this is the parameter access number via the handheld programmer. See Parameter Reference (Page 123) for a complete list of parameters.

A.1 Principles of operation

SITRANS LR250 is a 2-wire 25 GHz pulse radar level transmitter for continuous monitoring of liquids and slurries. (The microwave output level is significantly less than that emitted from cellular phones.) Radar level measurement uses the time of flight principle to determine distance to a material surface. The device transmits a signal and waits for the return echo. The transit time is directly proportional to the distance from the material.

Pulse radar uses polarized electromagnetic waves. Microwave pulses are emitted from the antenna at a fixed repetition rate, and reflect off the interface between two materials with different dielectric constants (the atmosphere and the material being monitored).

Electromagnetic wave propagation is virtually unaffected by temperature or pressure changes, or by changes in the vapor levels inside a vessel. Electromagnetic waves are not attenuated by dust.

SITRANS LR250 consists of an enclosed electronic circuit coupled to an antenna and process connection. The electronic circuit generates a radar signal (25 GHz) that is directed to the antenna.

The signal is emitted from the antenna, and the reflected echoes are digitally converted to an echo profile. The profile is analyzed to determine the distance from the material surface to the sensor reference point. See Dimension drawings (Page 203). This distance is used as a basis for the display of material level and mA output.

A.2 Echo Processing

A.2.1 Process Intelligence

The signal processing technology embedded in Siemens radar level devices is known as **Process Intelligence**.

Process intelligence provides high measurement reliability regardless of the dynamically changing conditions within the vessel being monitored. The embedded Process Intelligence dynamically adjusts to the constantly changing material surfaces within these vessels.

Process Intelligence is able to differentiate between the true microwave reflections from the surface of the material and unwanted reflections being returned from obstructions such as seam welds or supports within a vessel. The result is repeatable, fast and reliable measurement. This technology was developed as result of field data gained over some twenty years from more than 1,000,000 installations in many industries around the world.

Higher order mathematical techniques and algorithms are used to provide intelligent processing of microwave reflection profiles. This "knowledge based" technique produces superior performance and reliability.

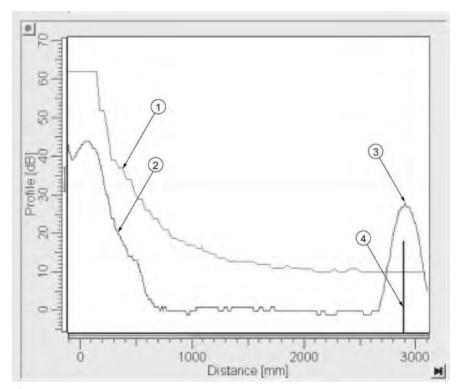
A.2.2 Echo Selection

Time Varying Threshold (TVT)

A Time Varying Threshold (TVT) hovers above the echo profile to screen out unwanted reflections (false echoes).

In most cases the material echo is the only one which rises above the default TVT.

In a vessel with obstructions, a false echo may occur. See Auto False Echo Suppression (Page 253) for more details.



- default TVT
- 2 echo profile
- (3) material level
- 4 echo marker

The device characterizes all echoes that rise above the TVT as potential good echoes. Each peak is assigned a rating based on its strength, area, height above the TVT, and reliability, amongst other characteristics.

Algorithm (2.8.4.1.)

The true echo is selected based on the setting for the Echo selection algorithm. Options are true First Echo, Largest Echo, or **b**est of First and Largest.

A.2 Echo Processing

Position Detect (2.8.4.2.)

The echo position detection algorithm determines which point on the echo will be used to calculate the precise time of flight, and calculates the range using the calibrated propagation velocity (see **Propagation Factor (2.8.3.)** for values). There are three options:

- Center
- Hybrid
- CLEF (Constrained Leading Edge Fit)

Center

Uses center of the echo.

Hybrid

Uses the Center algorithm for the top part of the vessel, and the CLEF algorithm for the part nearest the vessel bottom, according to the setting for **CLEF range**.

CLEF (Constrained Leading Edge Fit)

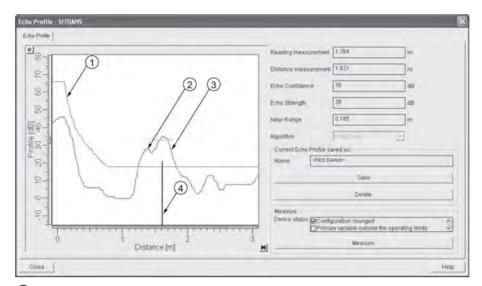
- Uses the leading edge of the echo.
- Is used mainly to process the echo from materials with a low dK value.

In an almost empty flat-bottomed vessel, a low dK material may reflect an echo weaker than the echo from the vessel bottom. The echo profile shows these echoes merging. The device may then report a material level equal to or lower than empty.

The CLEF algorithm enables the device to report the level correctly.

Example: CLEF off: Position set to Hybrid

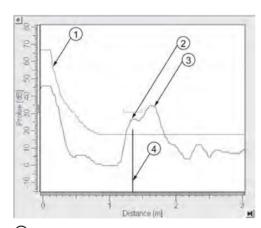
Vessel height: 1.5 m; CLEF range set to 0 (Center algorithm gives the same result.)



- default TVT
- 2 material echo
- 3 vessel bottom echo selected
- 4 echo marker

Example: CLEF enabled

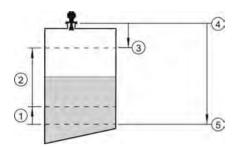
Vessel height: 1.5 m; CLEF range set to 0.5 m



- default TVT
- 2 material echo selected
- 3 vessel bottom echo
- 4 echo marker

A.2.3 CLEF Range

CLEF Range (2.8.4.4.) is referenced from Low Calibration Point (process empty level). When the **Hybrid** algorithm is selected in **Position Detect (2.8.4.2.)**, the CLEF algorithm will be applied up to the limit of CLEF Range. Above this limit the Center algorithm will be applied.



- ① CLEF Range
- ② (Center algorithm applied)
- 3 High Calibration Point (process full level)
- Sensor reference point
- 5 Low Calibration Point (process empty level)

A.2.4 Echo Threshold

Confidence (2.8.6.1.) describes the quality of an echo. Higher values represent higher quality. **Echo Threshold (2.8.4.3.)** defines the minimum confidence value required for an echo to be accepted as valid and evaluated.

A.2.5 Echo Lock

If the echo selected by **Algorithm** is within the Echo Lock window, the window is centered about the echo, which is used to derive the measurement. In radar applications, two measurement verification options are used with **Echo Lock (2.8.5.1.)**:

Lock Off

SITRANS LR250 responds immediately to a new selected echo (within the restrictions set by the Maximum Fill / Empty Rate), but measurement reliability is affected.

Material Agitator

A new measurement outside the Echo Lock Window must meet the sampling criteria before the window will move to include it.

The other available options, **Maximum Verification** and **Total Lock** are not recommended for radar.

A.2.6 Auto False Echo Suppression

Note

- For detailed instructions on using this feature via PDM see Auto False Echo Suppression (Page 89).
- For detailed instructions on using this feature via the handheld programmer see **Auto** False Echo Suppression (2.8.7.1.).

Auto False Echo Suppression is designed to learn a specific environment (for example, a particular vessel with known obstructions), and in conjunction with Auto False Echo Suppression Range to remove false echoes appearing in front of the material echo.

The material level should be below all known obstructions at the moment when Auto False Echo Suppression learns the echo profile. Ideally the vessel should be empty or almost empty, and if an agitator is present, it should be running.

The device learns the echo profile over the whole measurement range and the TVT is shaped around all echoes present at that moment.

Auto False Echo Suppression Range (2.8.7.2.)

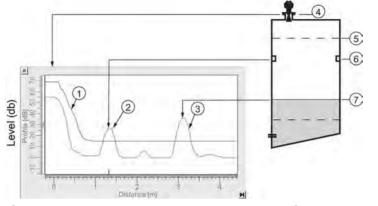
Auto False Echo Suppression Range specifies the range within which the learned TVT is applied. Default TVT is applied over the remainder of the range.

The learned TVT screens out the false echoes caused by obstructions. The default TVT allows the material echo to rise above it.

Auto False Echo Suppression Range must be set to a distance shorter than the distance to the material level when the environment was learned, to avoid the material echo being screened out.

A.2 Echo Processing

Example before Auto False Echo Suppression



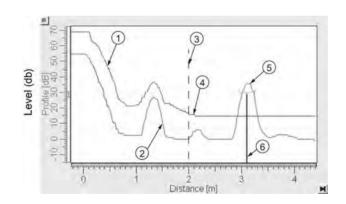
- default TVT
- 2 false echo
- 3 material echo
- 4 sensor reference point

- 6 high calibration point = 0
- 6 obstruction at 1.3. m

(7)

material level at 3.2 m

Example after Auto False Echo Suppression



Auto False Echo Suppression Range set to 2 m

- ① learned TVT
- ② false echo
- 3 Auto False Echo Suppression Range
- 4 default TVT
- ⑤ material echo
- 6 echo marker

A.2.7 Measurement Range

Near Range (2.8.1.)

Near Range programs SITRANS LR250 to ignore the zone in front of the antenna. The default blanking distance is 50 mm (1.97") from the end of the antenna.

Near Range allows you to increase the blanking value from its factory default. But **Auto False Echo Suppression (2.8.7.1.)** is generally recommended in preference to extending the blanking distance from factory values.

Far Range (2.8.2.)

Far Range can be used in applications where the base of the vessel is conical or parabolic. A reliable echo may be available below the vessel empty distance, due to an indirect reflection path.

Increasing Far Range to 30% or 40% can provide stable empty vessel readings.

A.2.8 Measurement Response

Note

Units are defined in Units (2.2.1.) and are in meters by default.

Response Rate (2.4.1.) limits the maximum rate at which the display and output respond to changes in the measurement. There are three preset options: slow, medium, and fast.

Once the real process fill/empty rate (m/s by default) is established, a response rate can be selected that is slightly higher than the application rate. Response Rate automatically adjusts the filters that affect the output response rate.

Res	ponse Rate (2.4.1.)	Fill Rate per Minute (2.4.2.)/Empty Rate per Minute (2.4.3.)	Damping Filter (2.2.4.)
*	Slow	0.1 m/min (0.32 ft/min)	10 s
	Medium	1.0 m/min (3.28 ft.min)	10 s
	Fast	10.0 m/min (32.8 ft/min)	0 s

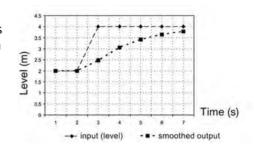
A.2.9 Damping

Damping Filter (2.2.4.) smooths out the response to a sudden change in level. This is an exponential filter and the engineering unit is always in seconds.

In 5 time constants the output rises exponentially: from 63.2% of the change in the first time constant, to almost 100% of the change by the end of the 5th time constant.

Damping example

time constant = 2 seconds input (level) change = 2 m



A.3 Analog Output

The mA Output (current output) is proportional to material level in the range 4 to 20 mA. 0% and 100% are percentages of the full-scale reading (m, cm, mm, ft, in). Typically mA output is set so that 4 mA equals 0% and 20 mA equals 100%.

When SITRANS LR250 is put into **PROGRAM** mode (for example, by navigating through the menu) it stops updating the output of the device (local user interface and mA Output). It stores the most recent measurement, and holds the associated readings and mA signal output. The device reverts to the parameter last addressed during the previous program session.

When the device is returned to **Measurement** mode, the transceiver resumes operation. The reading and mA output default to the last measurement taken. The reading and associated outputs migrate to the current process level at a rate controlled by **Response Rate (2.4.1.)**.

If the device is left in **PROGRAM** mode for 10 minutes without input, it automatically reverts to **Measurement** mode.

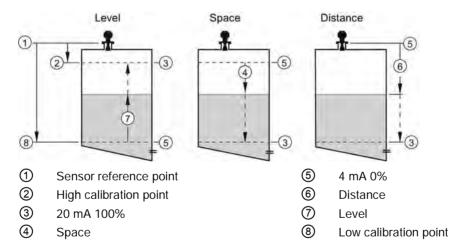
A.3.1 Sensor Mode

This parameter controls the input. Depending on the reference point used, the measurement reports either Level, Space, or Distance. By default Sensor Mode is set to **Level**.

Operation	Description	Reference point
NO SERVICE	Measurement and associated loop current not being updated. Device defaults to Failsafe mode ^{a)} .	
LEVEL	Distance to material surface	Low Calibration Point (process empty level)
SPACE	Distance to material surface	High Calibration Point (process full level)
DISTANCE	Distance to material surface	Sensor reference point

a) See Fail-safe Mode (Page 259).

You also have the option to put the device out of service, in which case the device defaults to Fail-safe mode, and the reported level depends on the device type. A standard device reports the last valid reading, and a NAMUR NE 43-compliant device reports the user-defined value for Material Level (3.58 mA by default).



A.3 Analog Output

A.3.2 Current Output Function

Current Output Function (2.6.1.) controls the mA output and applies any relevant scaling. By default it is set to **Level**. Other options are Space, Distance, and Volume. (The device can carry out a volume calculation only after a vessel shape has been specified.)

When a volume application type is chosen, Sensor Mode remains as **Level** and the mA Output is automatically converted to **Volume**.

To view the mA reading in the secondary region of the LCD, press on the handheld programmer.

A.3.3 Loss of Echo (LOE)

A loss of echo (LOE) occurs when the calculated measurement is judged to be unreliable because the echo confidence value has dropped below the echo confidence threshold.

Confidence (2.8.6.1.) describes the quality of an echo. Higher values represent higher quality.

Echo Threshold (2.8.4.3.) defines the minimum confidence value required for an echo to be accepted as valid and evaluated.

If the LOE condition persists beyond the time limit set in LOE Timer (2.5.2.) the LCD displays the Service Required icon, and the text region displays the fault code S: 0 and the text LOE.

If two faults are present at the same time, the fault code, error text, and error icon for each fault are displayed alternately. For example, Loss of Echo and Fail-safe.





A.3.4 Fail-safe Mode

The purpose of the Fail-safe setting is to put the process into a safe mode of operation in the event of a fault or failure. The value to be reported in the event of a fault is selected so that a loss of power or loss of signal triggers the same response as an unsafe level.

LOE Timer (2.5.2.) determines the length of time a **Loss of Echo (LOE)** condition will persist before a Fail-safe state is activated. The default setting is 100 seconds.

Material Level (2.5.1.) determines the material level to be reported when LOE Timer (2.5.2.) expires, depending on the device type (standard or NAMUR NE 43-compliant.)

STANDARD DEVICE					
Options HI 20.5 mA (max. mA Limit)					
		LO	3.8 mA (min. mA Limit)		
	*	HOLD	Last valid reading		
		VALUE	User-selected value defined in Fail-Safe mA Value (2.5.3.)		

NAMUR NE 43-COMPLIANT DEVICE				
Options HI 20.5 mA (max. mA Limit)				
		LO	3.8 mA (min. mA Limit)	
		HOLD	Last valid reading	
	*	VALUE	User-selected value Fail-Safe mA Value (2.5.3.), default 3.58 mA	

Upon receiving a reliable echo, the loss of echo condition is aborted, the Service Required icon and error message are cleared, and the reading and mA output return to the current material level.

A.4 Maximum Process Temperature Chart



Exceeded maximum internal and process temperatures

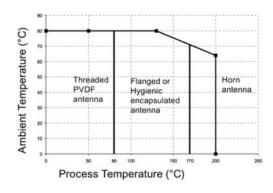
Danger of device malfunction

- Internal temperature must not exceed +80 ° C (+176 °F).
- Process temperature must not exceed limits specified by the antenna type.

Note

- The chart below is for guidance only.
- The chart does not represent every possible process connection arrangement. For example, it will NOT apply if you are mounting SITRANS LR250 directly on a metallic vessel surface.
- The chart does not take into consideration heating from direct sunlight exposure.

Maximum Process Temperatures versus allowable ambient





- Internal enclosure temperature
- 2 Ambient temperature
- ③ Process temperature (at process connection)

Where the chart does not apply, please use your own judgement regarding the use of SITRANS LR250.

If the internal temperature exceeds the maximum allowable limit, a sun shield or a longer nozzle may be required.

See Current Internal Temperature (3.2.1.) to monitor the Internal Temperature.

A.5 Process Pressure/Temperature derating curves



Exceeded maximum permissible operating pressure

Danger of injury or poisoning.

The maximum permissible operating pressure depends on the device version. The device can be damaged if the operating pressure is exceeded. Hot, toxic and corrosive process media could be released.

 Make sure that the device is suitable for the maximum permissible operating pressure of your system.



Pressure applications

Danger to personnel, system and environment will result from improper disassembly.

 Never attempt to loosen, remove, or disassemble process connection while vessel contents are under pressure.



Pressure applications

Danger to personnel, system and environment can result from improper installation.

• Improper installation may result in loss of process pressure.



Unsuitable connecting parts

Danger of injury or poisoning.

In case of improper mounting hot, toxic and corrosive process media could be released at the connections.

 Ensure that connecting parts (such as flange gaskets and bolts) are suitable for connection and process media.

Note

Material compatibility

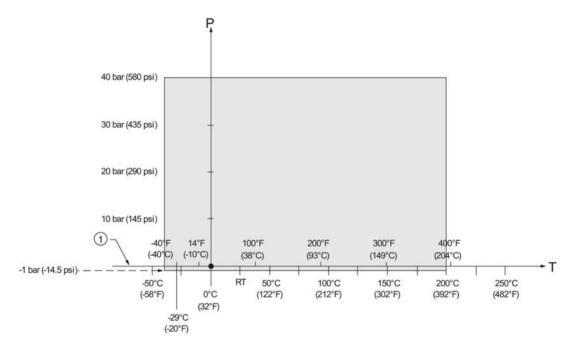
Siemens can provide you with support concerning selection of sensor components wetted by process media. However, you are responsible for the selection of components. Siemens accepts no liability for faults or failures resulting from incompatible materials.

A.5.1 Pressure Equipment Directive, PED, 97/23/EC

Siemens Level Transmitters with flanged, threaded, or sanitary clamp type process mounts have no pressure-bearing housing of their own and, therefore, do not come under the Pressure Equipment Directive as pressure or safety accessories (see EU Commission Guideline 1/8 and 1/20).

A.5.2 Horn antenna

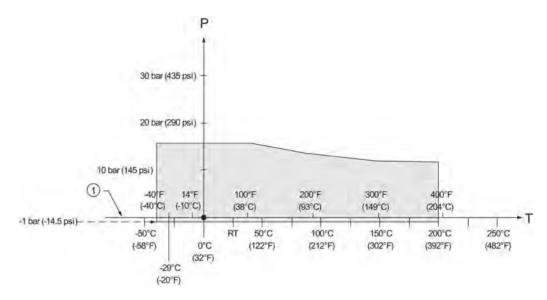
1.5", 2" and 3" [NPT, G (BSPP), R (BSPT)] Threaded Versions



- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

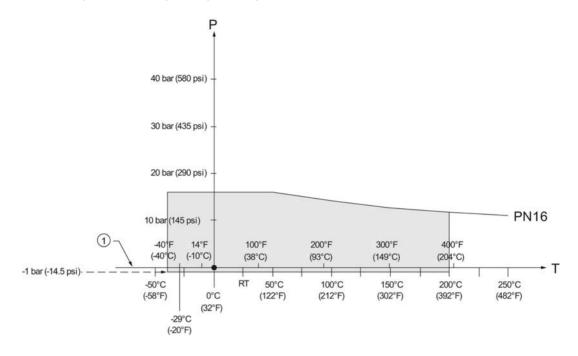
A.5.3 Flanged horn antenna

JIS B 2220, 10K: 50A, 80A, and 100A

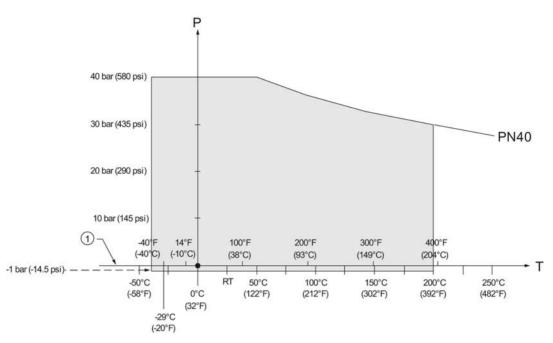


- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

EN1092-1, PN16: DN50, DN80, DN100, and DN150



- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

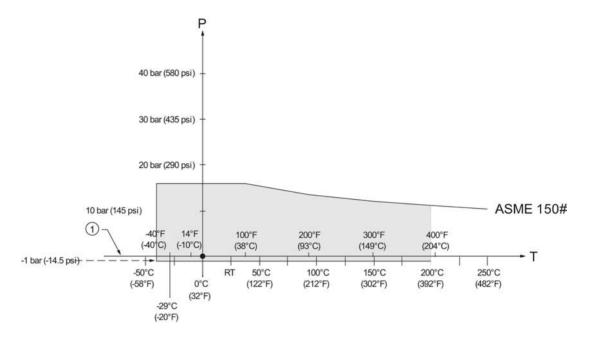


EN1092-1, PN40: DN50, DN80, DN100, and DN150

- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

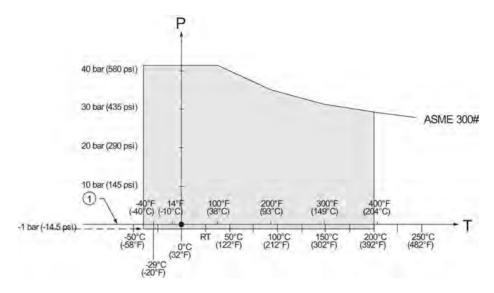
A.5 Process Pressure/Temperature derating curves

ASME B16.5, Class 150: 2", 3", and 4" NPS



- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

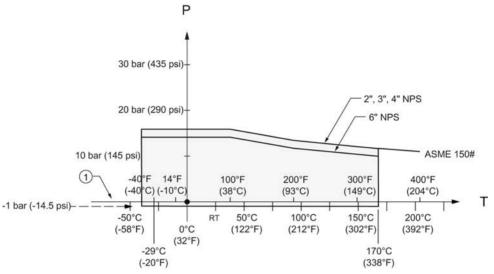




- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

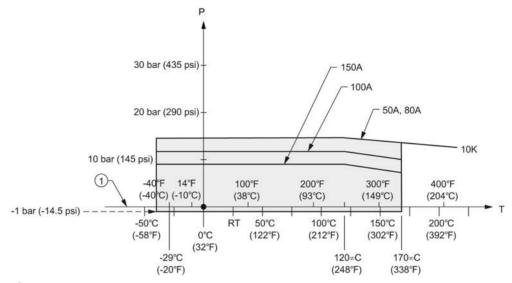
A.5.4 Flanged encapsulated antenna

ASME B16.5, Class 150: 2", 3", 4", and 6" NPS



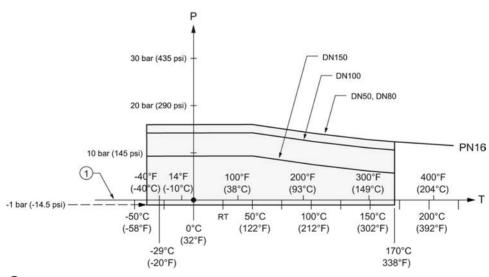
- 1 Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

JIS B 2220, 10K: 50A, 80A, 100A, and 150A



- 1 Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

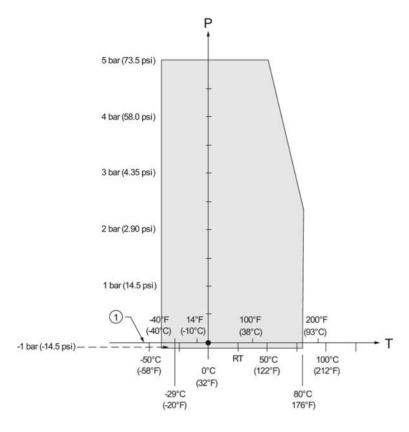
EN1092-1, PN10/16: DN50, DN80, DN100, and DN150



- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

A.5.5 PVDF antenna

ASME B1.20.1 2" NPT, EN ISO 228-1 2" G (BSPP), EN 10226-1 2" R (BSPT)

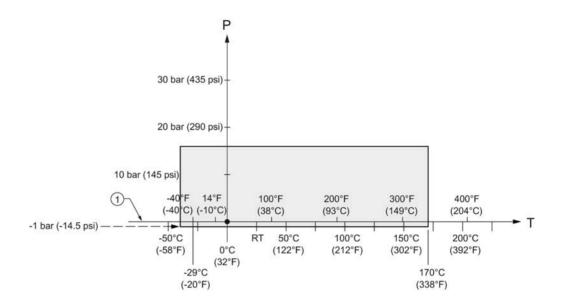


- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

A.5.6 Hygienic encapsulated antenna

DIN 11851 Sanitary/Hygienic nozzle/slotted nut: DN50, DN80, and DN100

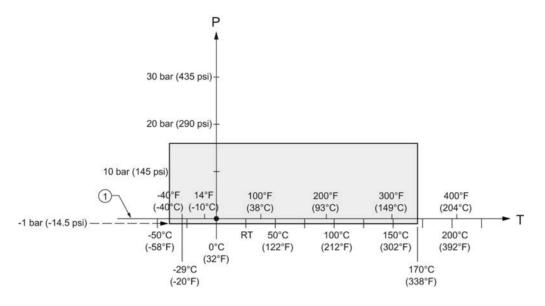
DIN 11864-1 Aseptic/Hygienic nozzle/slotted nut: DN50, DN80, and DN100



- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

A.5 Process Pressure/Temperature derating curves

DIN 11864-2 Aseptic/Hygienic flanged: DN50, DN80, and DN100



- Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

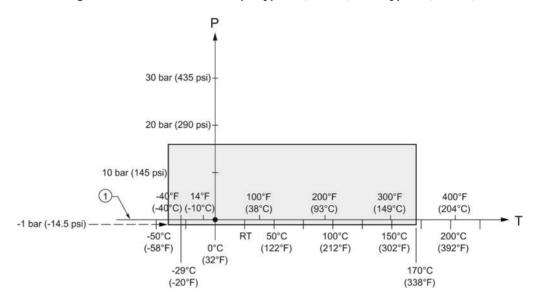
Note

For pressure applications, all attachment hardware must be suitably rated.

DIN 11864-3 Aseptic/Hygienic clamp: DN50, DN80, and DN100

ISO 2852 Sanitary/Hygienic clamp: 2", 3", and 4"

Tuchenhagen Varivent face seal clamp: Type N (68 mm) and Type F (50 mm)



- (1) Atmospheric
- P Allowable operating pressures
- T Allowable operating temperatures

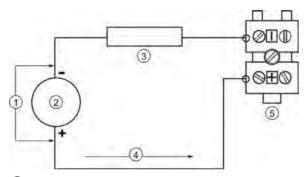
Note

For pressure applications, all clamps must be rated accordingly.

A.6 Loop power

Note

Loop voltage is the voltage at the terminals of the power supply (not the voltage at the terminals of the device).



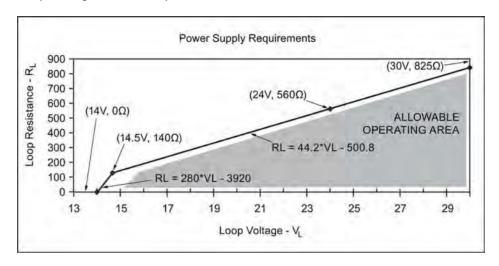
- 1 Loop voltage VL
- 2 Power supply
- 3 Loop resistance RL
- 4 Loop current IL
- ⑤ LR250

A.6.1 Allowable operating area of SITRANS LR250

Note

The curves below apply to a standalone device, configured via the Siemens handheld programmer.

A.6.2 Curve 1 (General Purpose, Intrinsically Safe, Non-Sparking, Non-incendive) Loop Voltage versus Loop Resistance

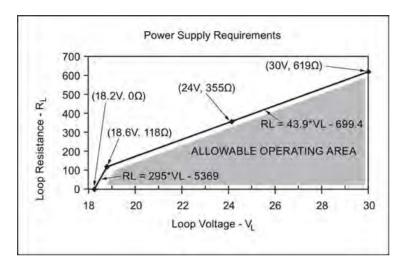


Note

When using HART communications, the minimum voltage with 220 Ohms (RL) is 16.3 V DC.

A.6.3 Curve 2 (Flameproof, Increased Safety, Explosion-proof)

Loop Voltage versus Loop Resistance



Note

When using HART communications, the minimum voltage with 220 Ohms (RL) is $20.94\ V$ DC.

A.7 Startup behavior

- The device draws less than 3.6 mA at startup.
- Time to first measurement is less than 50 seconds.

Appendix B: HART communications

B

Highway Addressable Remote Transducer, HART, is an industrial protocol that is superimposed on the 4-20 mA signal. It is an open standard, and full details about HART can be obtained from the HART Communication Foundation website:

HART Communication Foundation (http://www.hartcomm.org/)

The radar device can be configured over the HART network using either the HART Communicator 375 by Fisher-Rosemount, or a software package. The recommended software package is the SIMATIC Process Device Manager (PDM) by Siemens.

B.1 SIMATIC PDM

This software package is designed to permit easy configuration, monitoring, and troubleshooting of HART devices. The HART EDD for this device was written with SIMATIC PDM in mind and has been extensively tested with this software. For more information, see Operating via SIMATIC PDM (Page 75).

B.2 HART Electronic Device Description (EDD)

In order to configure a HART device, the configuration software requires the HART Electronic Device Description for the instrument in question.

You can download the HART EDD for this device from our website:

Product page (http://www.siemens.com/LR250)

Click on **Support>Software Downloads**. Older versions of the library will have to be updated in order to use all the features of this device.

B.3 HART Handheld 375/475

If the SITRANS LR250 HART device revision is higher than revision 2, the FC375 will report that the Device Description is not installed and will ask whether you wish to proceed in forward compatibility mode. It is recommended to choose YES in order to use revision 3 with the FC375.

B.4 HART Communicator 375 menu structure

Note

HART Communicator 375 is supported by SITRANS LR250 HART.

LEVEL METER

```
IDENTIFICATION
```

- 1. TAG
- 2. DESCRIPTION
- 3. MESSAGE
- 4. INSTALLATION DATE
- 5. DEVICE ORDER NUMBER

SETUP

- 1. DEVICE
 - 1. FIRMWARE REVISION
 - 2. LOADER REVISION
 - 3. HARDWARE REVISION

2. INPUT

- 1. SENSOR CALIBRATION
 - 1. MATERIAL
 - 2. SENSOR UNITS
 - 3. OPERATION
 - 4. LOW CALIBRATION PT.
 - 5. HIGH CALIBRATION PT.
 - 6. NEAR RANGE
 - 7. FAR RANGE
 - 8. PROPAG. FACTOR
 - 9. SENSOR OFFSET
- 2. VOLUME CONVERSION
 - 1. VESSEL SHAPE 2. MAXIMUM VOLUME
 - 3. DIMENSION A
 - 4. DIMENSION L
- VOLUME BREAKPOINT
 - 1. TABLE 1 8 (Lev./Vol. Breakpoints 1-8)

 - TABLE 9 16 (Lev./Vol. Breakpoints 9-16)
 TABLE 17 24 (Lev./Vol. Breakpoints 17-24)
 - 4. TABLE 25 32 (Lev./Vol. Breakpoints 25-32)
- ECHO PROCESSING
 - 1. ECHO SELECT
 - 1. ALGORITHM
 - 2. POSITION DETECT
 - 3. ECHO THRESHOLD
 - 2. SAMPLING
- 1. ECHO LOCK
- 2. SAMPLING UP 3. SAMPLING DOWN
- 3. FILTERING
- 1. DAMPING FILTER
- 4. TANK BOTTOM ALGORITHM
 - 1. CLEF RANGE
- 5. NOISE
- 1. ECHO CONFIDENCE
- 2. ECHO STRENGTH
- 3. NOISE AVERAGE

- 5. TVT SETUP
 - 1. TVT HOVER LEVEL
 - 2. AUTO FALSE ECHO SUPPRESSION
 - 3. AUTO SUPPRESSION RANGE
 - 4. SHAPER MODE
- 6. TVT SHAPER
 - 1. SHAPER 1-9 (Shaper points 1-9)
 - SHAPER 19-9 (Shaper points 19-18)
 SHAPER 10-18 (Shaper points 10-18)
 SHAPER 19-27 (Shaper points 19-27)

 - SHAPER 28-36 (Shaper points 28-36)
 SHAPER 37-40 (Shaper points 37-40)
- 7. RATE
- 1. RESPONSE RATE
- 2. FILL RATE PER MINUTE
- 3. EMPTY RATE PER MINUTE
- 3. OUTPUT
 - MA OUTPUT
 - 1. MA OUTPUT FUNCTION
 - 2. 4 MA SETPOINT
 - 3. 20 MA SETPOINT
 - 4. MINIMUM MA LIMIT
 - 5. MAXIMUM MA LIMIT
- 4. FAIL-SAFE
 - **FAILSAFE TIMER**
 - FAILSAFE MATERIAL LEVEL
 - FAILSAFE LEVEL 3

3. DIAGNOSTICS

- 1. MEASURED VALUES
 - CURRENT INTERNAL TEMP. 1.
 - MAX. INTERNAL TEMP. 2.
 - 3. MIN. INTERNAL TEMP.

4. SERVICE

- 1. REMAINING DEVICE LIFETIME
 - TOTAL EXPECTED DEVICE LIFE
 - TOTAL DEVICE OPERATING TIME
 - REMAINING DEVICE LIFETIME
 - MAINTENANCE REQUIRED LIFETIME
 - MAINTENANCE DEMANDED LIFETIME MAINTENANCE ALERT ACTIVATION
 - DEVICE LIFETIME MAINTENANCE ACKNOWLEDGE
- 2. REMAINING SENSOR LIFETIME
 - TOTAL EXPECTED SENSOR LIFE
 - TOTAL SENSOR OPERATING TIME
 - REMAINING SENSOR LIFETIME 3.
 - MAINTENANCE REQUIRED LIMIT MAINTENANCE DEMANDED LIMIT
 - MAINTENANCE ALERT ACTIVATION
 - SENSOR LIFETIME MAINTENANCE ACKOWLEDGE

B.5 HART version

- 3. SERVICE INTERVAL
 - TOTAL SERVICE INTERVAL
 - TIME ELAPSED SINCE LAST SERVICE
 - REMAINING LIFETIME

 - MAINTENANCE REQUIRED LIMIT MAINTENANCE DEMANDED LIMIT
 - MAINTENANCE ALERT ACTIVATION
 - SERVICE ACKNOWLEDGE
- 4. CALIBRATION INTERVAL

 - TOTAL CALIBRATION INTERVAL
 TIME ELAPSED SINCE LAST CALIBRATION
 - 3. REMAINING LIFETIME
 - 4. MAINTENANCE REQUIRED LIMIT
 - 5. MAINTENANCE DEMANDED LIMIT
 - 6. MAINTENANCE ALERT ACTIVATION
 - 7. CALIBRATION ACKNOWLEDGE
- 5. POWERED DAYS
- 6. POWER ON RESETS
 7. LCD FAST MODE
 8. LCD CONTRAST

5. COMMUNICATION

1. COMMUNICATION CONTROL

6. SECURITY

- 1. WRITE PROTECT
- 2. PIN TO UNLOCK

7. LANGUAGE

1. LANGUAGE

B.5 HART version

SITRANS LR250 conforms to HART rev. 5.

B.5.1 **Burst Mode**

SITRANS LR250 does not support burst mode.

B.5.2 **HART Multidrop Mode**

We do not recommend the use of HART Multidrop Mode.

Appendix C: Certificates and support

C

C.1 Certificates

Certificates can be downloaded from our website at:

Product page (http://www.siemens.com/LR250).

C.2 Technical support

If you have any technical questions about the device described in these Operating Instructions and do not find the right answers, you can contact Customer Support:

- Via the Internet using the Support Request: Support request (http://www.siemens.com/automation/support-request)
- Via Phone:

- Europe: +49 (0)911 895 7222

- America: +1 423 262 5710

- Asia-Pacific: +86 10 6475 7575

Further information about our technical support is available on the Internet at Technical support (http://support.automation.siemens.com/WW/view/en/16604318)

Service & Support on the Internet

In addition to our documentation, we offer a comprehensive knowledge base online on the Internet at:

Service & Support (http://www.siemens.com/automation/service&support)

There you will find:

- The latest product information, FAQs, downloads, tips and tricks.
- Our newsletter, providing you with the latest information about your products.
- Our bulletin board, where users and specialists share their knowledge worldwide.
- You can find your local contact partner for Industry Automation and Drives Technologies in our partner database.
- Information about field service, repairs, spare parts and lots more under "Services."

C.2 Technical support

Additional Support

Please contact your local Siemens representative and offices if you have additional questions about the device

Find your contact partner at:

Local contact person (http://www.siemens.com/automation/partner)

List of abbreviations 13

Short form	Long form	Description	Units
3-A	3-A Sanitary Standards, Inc.		
CE / FM / CSA	Conformité Européene / Factory Mutual / Canadian Standards Association	safety approval	
Ci	Internal capacitance		F
D/A	Dialog to analog		
DCS	Distributed Control System	control room apparatus	
dK	dielectric constant		
EDD	Electronic Device Description		
EHEDG	European Hygienic Engineering Design Group		
FEA	Flanged encapsulated antenna		
FDA	Food and Drug Administration		
HEA	Hygienic Encapsulated Antenna		
HART	Highway Addressable Remote Transducer		
li	Input current		mA
Io	Output current		mA
IS	Intrinsically Safe	safety approval	
Li	Internal inductance		mH
mH	milliHenry	10 ⁻³	Н
μF	microFarad	10 ⁻⁶	F
μs	microsecond	10-6	S
NPS	Nominal Pipe Size		
PED	Pressure Equipment Directive	safety approval	
pF	pico Farads	10-12	F
ppm	parts per million		
PV	Primary Variable	measured value	
PVDF	Polyvinylidene fluoride		
SV	Secondary Variable	equivalent value	
ТВ	Transducer Block		
TVT	Time Varying Threshold	sensitivity threshold	
TFM1600 PTFE	Modified PTFE	polytetrafluoroethylene with perfluoropropyl vinyl ether (PPVE) modifier	
Ui	Input voltage		V
U₀	Output voltage		V

12.30 Process connection tag (pressure rated versions)

14.1 LCD menu structure

LCD menu structure

14

14.1 LCD menu structure

Note

• In Navigation mode, **ARROW keys** (• • •) navigate the menu in the direction of the arrow. See Parameter Reference (Page 123) for detailed information and instructions.

14.1 LCD menu structure

LEVEL METER

```
- 1. QUICK START WIZ
        1.1 QUICK START
                   MATERIAL
                   RESPONSE RATE
                   UNITS
                   OPERATION
LOW CALIB. PT.
                   HIGH CALIB. PT.
                   WIZARD COMPLETE
-1. SETUP
        2.1 DEVICE
                   2.1.1 HARDWARE REV
2.1.2 FIRMWARE REV
                          HARDWARE REV
                   2.1.3 LOADER REV
                   2.1.4 ORDER OPTION
        2.2 SENSOR
                   2.2.1
                           UNITS
                           SENSOR MODE
                   2.2.3 MATERIAL
                   2.2.4 DAMPING FILTER
        2.3 CALIBRATION
                   2.3.1 LOW CALIB. PT.
2.3.2 HIGH CALIB. PT.
                   2.3.3 SENSOR OFFSET
        2.4 RATE
                   2.4.1 RESPONSE RATE
2.4.2 FILL RATE PER MINUTE
                   2.4.3 EMPTY RATE PER MINUTE
         2.5 FAIL-SAFE
                    2.5.1 MAT. LEV.
2.5.2 LOE TIMER
                    2.5.3 FAIL-SAFE MA VALUE
        2.6 ANALOG OUT. SCAL.
2.6.1 CURR. OUT. FUNC.
2.6.2 4 MA SETPOINT
                   2.6.5 20 MA SELFC...
2.6.4 MIN. MA LIMIT
2.6.5 MAX. MA LIMIT
                           20 MA SETPOINT
                   2.6.5 MAX. MA LIMIT
2.6.6 MA OUTPUT VALUE
         2.7 LINEARIZATION
                    2.7.1 VOLUME
                                     2.7.1.1 VESSEL SHAPE
2.7.1.2 MAX. VOLUME
2.7.1.3 DIMENS. A
                                     2.7.1.4 DIMENS. L
                           TABLE 1 - 8
TABLE 9 - 16
TABLE 17 - 24
                   2.7.2
                   2.7.3
2.7.4
                            TABLE 25-32
                    2.7.5
```

```
-2. SETUP (cont'd)
       2.8 SIGNAL PROC.
                 2.8.1
2.8.2
2.8.3
2.8.4
                           NEAR RANGE
                           FAR RANGE
PROPAG. FACTOR
                           ECHO SELECT
                                      2.8.4.1
                                                ALGORITHM
                                       2.8.4.2
                                                POS. DETECT
                                       2.8.4.3
                                                ECHO THRESHOLD
                                       2.8.4.4
                                                CLEF RANGE
                  2.8.5
                           SAMPLING
                                      2.8.5.1
                                               ECHO LOCK
UP SAMP.
DOWN SAMP.
                                      2.8.5.2
2.8.5.3
                  2.8.6
                           ECHO QUALITY
                                       2.8.6.1
                                                CONFIDENCE
                                       2.8.6.2
                                                ECHO STRENGTH
                                       2.8.6.3
                                                NOISE AVERAGE
                           TVT SETUP
                  2.8.7
                                       2.8.7.1
2.8.7.2
2.8.7.3
                                                AUTO FALSE ECHO
AUTO SUPP RANGE
HOVER LEVEL
                                       2.8.7.4
                                                SHAPER MODE
                  2.8.8
                           TVT SHAPER
                                                BRKPT. 1-9
BRKPT. 10-18
BRKPT. 19-27
BRKPT. 28-36
                                      2.8.8.1
                                      2.8.8.2
                                       2.8.8.3
                                      2.8.8.4
                                       2.8.8.5 BRKPT. 37-40
                  2.8.9
                           MEAS. VALUES
                                      2.8.9.1
2.8.9.2
2.8.9.3
                                                LEVEL MEAS
                                                SPACE MEAS.
DISTANCE MEAS.
                                      2.8.9.4
                                                VOLUME MEAS.
3. DIAGNOSTICS
        3.1 ECHO PROFILE
       3.2 ELECT. TEMP.
                  3.2.1
                           CURR. INTERN. TEMP...
                   3.2.2
                           HIGHEST VALUE.
                  3.2.3
                           LOWEST VALUE.
4. SERVICE
        4.1 MASTER RESET
        4.2 REMAIN. DEV. LIFE
                  4.2.1
                           LIFETIME EXPECTE..
                  4.2.2
                          TIME IN OPER.
                          REMAIN. LIFETIM..
REMINDER ACTIV.
REMIND. 1 (REQ)
REMIND. 2 (DEM)
                  4.2.3
4.2.4
                  4.2.5
                  4.2.6
                          MAINT STAT
                  4.2.8
                         ACK STATUS
                  4.2.9 ACK
        4.3 REMAIN. SENS. LIFE
                   4.3.1
                           LIFETIME EXPECTE..
                   4.3.2
                           TIME IN OPER.
                   4.3.3
4.3.4
                           REMAIN. LIFETIM.
                           REMINDER ACTIV.
                           REMIND. 1 (REQ)
REMIND. 2 (DEM)
                   4.3.5
                   4.3.6
4.3.7
                           MAINT STAT
                   4.3.8
                           ACK STATUS
                   4.3.9
                           ACK
```

14.1 LCD menu structure

```
4. SERVICE (cont'd)
       4.4 SERVICE SCHED.
                 4.4.1
4.4.2
                         SERV. INTERVAL
                         TIME LAST SERV.
TIME NEXT SERV.
REMINDER ACTIV.
                 4.4.3
4.4.4
                         REMIND. 1 (REQ)
REMIND. 2 (DEM)
                 4.4.5
                 4.4.6
                 4.4.7
                         MAINT STAT
                         ACK STATUS
                 4.4.8
                 4.4.9
                         ACK
             CALIB SCHED.
                 4.5.1
                         CALIB. INTERNAL
                         TIME LAST CALIB.
TIME NEXT CALIB.
REMINDER ACTIV.
                 4.5.2
                 4.5.3
4.5.4
                         REMIND. 1 (REQ)
REMIND. 2 (DEM)
                 4.5.5
                 4.5.6
                         MAINT STAT
                 4.5.7
                         ACK STATUS
                 4.5.8
                 4.5.9
                         ACK
       4.6 MANUF. DATE
            POWERED HOURS
       4.7
       4.8 POWERON RESETS
       4.9 LCD FAST MODE
       4.10 LCD CONTRAST
       4.11 SECONDARY VALUE
       4.12 MEM. TEST
- 5. COMMUNICATION
       5.1 DEVICE ADDRESS
6. SECURITY
       6.1 REMOTE ACCESS
                 6.1.1 ACCESS CONTROL
       6.2 LOCAL ACCESS
                 6.2.1
                         WRITE PROTECT
                 6.2.2
                         PIN TO UNLOCK
7. LANGUAGE
```

Glossary

accuracy

degree of conformity of a measure to a standard or a true value.

algorithm

a prescribed set of well-defined rules or processes for the solution of a problem in a finite number of steps.

ambient temperature

the temperature of the surrounding air that comes in contact with the enclosure of the device.

antenna

an aerial which sends out and receives a signal in a specific direction. There are four basic types of antenna in radar level measurement, horn, parabolic, rod, and waveguide.

attenuation

a term used to denote a decrease in signal magnitude in transmission from one point to another. Attenuation may be expressed as a scalar ratio of the input magnitude to the output magnitude or in decibels.

Auto False-Echo Suppression

a technique used to adjust the level of a TVT to avoid the reading of false echoes. (See TVT.)

Auto-False Echo Suppression Distance

defines the endpoint of the TVT distance. (See TVT.) This is used in conjunction with auto false echo suppression.

beam spreading

the divergence of a beam as it travels through a medium.

beam width

the angle diametrically subtended by the one-half power limits (-3 dB) of the microwave beam.

blanking

a blind zone extending away from the reference point plus any additional shield length. The device is programmed to ignore this zone.

capacitance

the property of a system of conductors and dielectrics that permits the storage of electricity when potential differences exist between the conductors. Its value is expressed as the ratio of a quantity of electricity to a potential difference, and the unit is a Farad.

confidence

see Echo Confidence.

damping

term applied to the performance of a device to denote the manner in which the measurement settles to its steady indication after a change in the value of the level.

dB (decibel)

a unit used to measure the amplitude of signals.

derating

to decrease a rating suitable for normal conditions according to guidelines specified for different conditions.

dielectric

a nonconductor of direct electric current. Many conductive liquids/electrolytes exhibit dielectric properties; the relative dielectric constant of water is 80.

dielectric constant (dK)

the ability of a dielectric to store electrical potential energy under the influence of an electric field. Also known as Relative Permittivity. An increase in the

dielectric constant is directly proportional to an increase in signal amplitude. The value is usually given relative to a vacuum /dry air: the dielectric constant of air is 1.

echo

a signal that has been reflected with sufficient magnitude and delay to be perceived in some manner as a signal distinct from that directly transmitted. Echoes are frequently measured in decibels relative to the directly transmitted signal.

Echo Confidence

describes the quality of an echo. Higher values represent higher quality. Echo Threshold defines the minimum value required for an echo to be accepted as valid and evaluated.

Echo Lock Window

a window centered on an echo in order to locate and display the echo's position and true reading. Echoes outside the window are not immediately processed.

Echo Marker

a marker that points to the processed echo.

Echo Processing

the process by which the radar unit determines echoes.

Echo Profile

a graphical display of a processed echo.

Echo Strength

describes the strength of the selected echo in dB referred to 1 μV rms.

false Echo

any echo which is not the echo from the desired target. Generally, false echoes are created by vessel obstructions.

frequency

the number of periods occurring per unit time. Frequency may be stated in cycles per second.

HART

Highway Addressable Remote Transducer. An open communication protocol used to address field instruments.

Hertz (Hz):

unit of frequency, one cycle per second. 1 Gigahertz (GHz) is equal to 109 Hz.

horn antenna

a conical, horn-shaped antenna which focuses microwave signals. The larger the horn diameter, the more focused the radar beam.

inductance

the property of an electric circuit by virtue of which a varying current induces an electromotive force in that circuit or in a neighboring circuit. The unit is a Henry.

microwaves

the term for the electromagnetic frequencies occupying the portion of the radio frequency spectrum from 1 GHz to 300 GHz.

multiple echoes

secondary echoes that appear as double, triple, or quadruple echoes in the distance from the target echo.

Near Blanking

see Blanking.

nozzle

a length of pipe mounted onto a vessel that supports the flange.

parameters

in programming, variables that are given constant values for specific purposes or processes.

polarization

the property of a radiated electromagnetic wave describing the time-varying direction and amplitude of the electric field vector.

polarization error

the error arising from the transmission or reception of an electromagnetic wave having a polarization other than that intended for the system.

propagation factor (pf)

where the maximum velocity is 1.0, pf is a value that represents a reduction in propagation velocity as a result of the wave travelling through a pipe or medium.

pulse radar

a radar type that directly measures distance using short microwave pulses. Distance is determined by the return transit time.

radar

radar is an acronym for **RA**dio **D**etection **A**nd **R**anging. A device that radiates electromagnetic waves and utilizes the reflection of such waves from distant objects to determine their existence or position.

range

distance between a transmitter and a target.

range extension

the distance below the zero percent or empty point in a vessel.

relative humidity

the ratio of the actual amount of moisture in the atmosphere to the maximum amount of moisture the atmosphere could hold (which varies depending on the air temperature).

relative permittivity

see dielectric constant.

repeatability

the closeness of agreement among repeated measurements of the same variable under the same conditions.

sensor value

the value produced by the echo processing which represents the distance from sensor reference point to the target. (see **Sensor Mode (2.2.2.)** for an illustration).

shot

one transmit pulse or measurement.

speed of light

the speed of electromagnetic waves (including microwave and light) in free space. Light speed is a constant 299, 792, 458 meters per second.

stilling-well

see stillpipe.

stillpipe

a pipe that is mounted inside a vessel parallel to the vessel wall, and is open to the vessel at the bottom.

TVT (Time Varying Threshold)

a time-varying curve that determines the threshold level above which echoes are determined to be valid.

two wire radar

a low-energy radar. Can be loop powered, analog, intrinsically safe 4 to 20 mA, or a digital (BUS) transmitter.

waveguide antenna

a hollow, metallic tube that transmits a microwave signal to the product target.

Index

A	C
Abbreviations and identifications list, 283	cables
access control	requirements, 40
remote access, 170	Calibration Interval, 165
activating, 52	calibration schedules via PDM, 92
agitator blade detection	cleaning
avoiding, 143	instructions, 177
AMS Device Manager	CLEF (Constrained Leading Edge Fit)
features, 101	explanation, 250
analog output	CLEF range
explanation, 256	setup, 142
fail signal, 195	communication
select, 94	load, 195
signal range, 195	maximum line length, 195
simulate via PDM, 94	conduits
analog output scale	requirements, 40
setup, 131	configuration
antenna	new device via AMS, 101
replacement, 179	Quick Start via LUI, 62
antenna types	configuration flag reset, 94
flanged encapsulated antenna, 213, 215	Correct usage, (see Improper device modifications)
flanged horn antenna, 209	
flanged horn antenna with extension, 211	
threaded horn, 203	D
threaded PVDF antenna, 234	Damping
Auto False Echo Suppression	explanation, 256
explanation, 253	Damping filter
setup, 145	setup, 126
TVT Shaper adjustment, 88	data logging
via PDM, 86, 89	time-based echo profile storage, 87
_	Device Address, 169
В	Device Description (DD)
beam angle	see EDD, 78
flanged encapsulated antenna, 213, 215	Device Reset
flanged horn, 209, 211	see Master Reset, 152
threaded horn, 205	device status
threaded PVDF antenna, 234	view via PDM, 98
blanking (see Near Range), 255	Diagnostics, 151
bolting instructions, 36	dimensions
bypass pipe	flanged encapsulated antenna, 213, 215
see stillpipe, 32	flanged horn, 209, 211
333 3111pipo, 02	nangou nom, 207, 211

flat face flange, 241	false echo		
raised face flange, 236, 238	see Auto False Echo Suppression, 253		
threaded horn with extension, 205	Far Range		
threaded PVDF antenna, 234	explanation, 255		
	setup, 139		
	flange		
E	bolting instructions, 36		
coho confidence	flange markings		
echo confidence	flat face, 241		
parameter setup, 144	raised face, 236, 239		
echo processing	flange sizes		
Process Intelligence, 248	flat face, 241		
Echo Profile	raised face, 236, 238		
data logging, 87	flanged encapsulated antenna		
view via LUI, 66	dimensions, 215		
view via PDM, 86	flanged horn		
Echo Profile Utilities	dimensions, 209, 211		
Auto False Echo Suppression, 86	•		
Echo Profile, 86			
TVT Shaper, 86	Н		
echo selection			
Algorithm, 249	handheld programmer		
CLEF (Constrained Leading Edge Fit), 250	edit mode, 59		
Position algorithm, 250	navigation, 58		
time varying threshold (TVT), 249	HART		
Echo Setup	multidrop mode, 280		
quick access via PDM, 92	HART Communication		
EDD	set preambles, 95		
updating, 78	HART Communications		
edit mode	details, 277		
handheld programmer, 58	HART version, 280		
key functions, 61	hazardous area installations		
Electronic Device Description (EDD), 76	wiring requirements, 43		
required for PROFIBUS PA, 78			
updating, 78			
enclosure	I		
opening, 41	Identifications and abbreviations		
	list, 283		
_	Improper device modifications, 16		
F	installation		
factory defaults	hazardous area requirements, 43		
Master Reset, 152	requirements, 34		
Fail-safe	warnings and notes, 34		
settings, 129	internal temperature		
Fail-safe Mode	monitoring, 260		
explanation, 259	mornioring, 200		
Fail-safe Timer			
explanation, 259			

K	Master Reset		
key functions	factory defaults, 152		
edit mode, 61	factory defaults via AMS, 102		
navigation mode, 58	measurement range		
navigation mode, 30	blanking via Near Range, 255		
	extension via Far Range, 255		
L	Measurement Response		
-	explanation, 255		
Language, 171	mounting		
LCD display	bypass requirements, 32		
contrast adjustment, 168	handheld programmer access, 30		
echo profile viewing, 66	housing construction, 24, 31		
fast mode, 168	nozzle design, 27		
measurement mode, 53	nozzle location, 28		
lens	on vessel with obstructions, 31		
replacement, 179	sunshield recommended, 31		
lid-lock set screw, 41	multidrop mode, 280		
linearization via AMS, 106			
Lithium batteries			
Safety, 51	N		
Local User Interface (LUI), 53	Namur NE 42 120 250		
LOE	Namur NE43, 129, 259		
Fail-safe Mode, 259	Near Range		
loop test	explanation, 255		
simulate analog output, 94	setup, 139		
loop voltage vs. loop resistance			
power supply requirements, 43	0		
loss of echo (LOE)	O		
explanation, 258	operating principles		
LUI (Local User Interface)	cleaning, 247		
contrast adjustment, 53	overview, 19		
-			
M	P		
mA output	password protection		
select analog output, 94	via AMS, 115		
maintenance	via PDM, 99		
calibration schedules, 93	PDM		
repairs, 177	see SIMATIC PDM, 75		
replacing antenna, 179	PED (Pressure Equipment Directive), 23, 262		
replacing lens, 179	performance		
service schedules, 93	specifications, 193		
Maintenance, 178	PIN to unlock		
maintenance settings, 151	local access, 170		
Calibration Interval, 165	pipe sizes		
see Remaining Sensor Lifetime, 158	flange mounting, 236, 238		
Service Interval, 161	polarization reference point, 31		
Solvido intolval, 101	polarization rotoronoo politi, o i		

power, 193	security
power source	local access, 170
requirements, 40	local access control via AMS, 113
power supply requirements	local access unlock value, 171
loop voltage vs. loop resistance, 43	password protection via AMS, 115
pressure applications, 23	remote access control, 170
Pressure Equipment Directive, 23, 262	remote access control via AMS, 113
Process Intelligence, 248	self-test
process temperature	device self-test via PDM, 94
maximum, 260	sensor reference point
programmer	flanged encapsulated antenna, 213, 215
handheld, 55	flanged horn, 209, 211
programming	flat faced flange, 241
	· · · · · · · · · · · · · · · · · · ·
adjust parameters via PDM, 84	raised face flange, 235, 237
via the handheld programmer, 57	threaded DVDF have 224
propogation factor	threaded PVDF horn, 234
values, 140	service schedules via PDM, 92
	settings
	adjust parameters via PDM, 84
Q	sidepipe
Qualified personnel, 17	see bypass pipe, 32
Quick Start Wizard	SIMATIC PDM
via LUI, 62	functions and features, 75
via SIMATIC PDM, 79	Rev 5.2, SP1 features, 76
VIA SIIVIATIC PDIVI, 79	Rev 6.0, SP4 features, 76
	simulate analog output
П	loop test, 94
R	SITRANS LR250
raised face flange markings, 235, 237	operating principles, 247
reading erratic	startup
troubleshooting, 191	transition screen, 52
reading incorrect	stillpipe
troubleshooting, 191	mounting requirements, 32
repair	Support Support
cautions, 178	contact information, 281
excluded liability, 179	synchronize parameters
	•
reset	scan device via AMS, 103
see Master Reset, 152	
Response Rate	т
explanation, 255	Т
	technical data, 193
	ambient temperature, 199
S	antenna, 197
Scan device	enclosure, 197
synchronize parameters via AMS, 103	environmental, 199
Scope of delivery, 11	performance, 193
Scope of delivery, 11	power, 193
	power, 175

```
pressure, 199
   process connections, 196
   process temperature, 199
   weight, 197
technical support
   contact information, 281
test
   loop test, 94
threaded connection markings, 234
threaded horn antenna
   dimensions, 205
threaded PVDF antenna
   dimensions, 234
trend
   view trend line, 97
troubleshooting
   communication, 183
   operation, 190
TVT (time varying threshold)
   explanation, 249
TVT Shaper
   manual adjustment via PDM, 88
   via PDM, 86
U
unlock value
   local access, 170
V
vessel shape
   selection, 134
W
Wear
   powered hours, 95
   poweron resets, 95
   view via PDM, 95
wiring
   cables, 40
   connecting HART, 42
   hazardous areas, 43
write protect
   local access, 170
```

For more information

www.siemens.com/level www.siemens.com/weighing

Siemens Canada Limited
Siemens Milltronics Process Instruments
1954 Technology Drive
P.O. Box 4225
Peterborough, ON
Canada K9J 7B1
email: techpubs.smpi@siemens.com

Subject to change without prior notice A5E32220602 Rev. AC © Siemens AG 2014 * A 5 E 32220602*

Printed in Canada